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# **PRECAUTIONS**

- 1. Chip cannot enter Stop Mode if INTn pin is low and wakeup is enabled. (INTn=0 and EXn=1, n=0~2)
- 2. Use MOVC to read flash, MOVX read flash is forbidden.

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# **AMENDMENT HISTORY**

Version	Date	Description
V0.90	Oct, 2019	New release.
V0.91	Dec,2019	Modify Family Members Features (p.6) Add new package type. Remove ADC Vtemp description. Modify ADC electrical characteristics table.
V0.92	Jan, 2020	Update package type.
V0.93	Feb, 2020	Modify the Flash write endurance Add introduce about ICE setting
V0.94	Mar, 2020	Fix typos (p.10)
V0.95	Apr,2020	Add LVRPD SFR.  Modify flash IAP example code  Modify the Flash write endurance and explanation  Modify Min operating voltage graph
V0.96	Jun,2020	Add SOP-16 package Corrected the use of ADC reference voltage source
V0.97	Jun,2020	Adjust the internal reference voltage (VBG) error range. Add current description when LVRPD=0x37.
V0.98	Sep,2020	Add IAP flow chart, IAP example code
V0.99	Nov,2020	Added SSOP-28 package Unified format of LVR/LVD voltage. Unified format of "Characteristic Graphs" chapter.
V1.0	Feb, 2021	Added full temperature VBG characteristic curve.  The minimum working voltage of fast clock divided by two and divided by four is adjusted to 2.15v.
V1.1	May,2021	Added QFN20 (L=0.25mm) package
V1.2	Aug, 2021	Added voltage requirements for PWM using FRCx2 clock source (p.69, p.98)  LVR Errata (p.28)  Added IAP usage requirements (p.22)  Added description of ADC internal capacitance value (p.77)



V1.3	Nov, 2022	IAP programming voltage must be greater than 4V (p.23) Modify CLRPWM1 description (p.75, p.106)
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# TM52 F8xxx FAMILY

# **Common Feature**

CPU	Flash Program memory	RAM bytes	Operation Mode	Timer0 Timer1 Timer2	UART	Real-time Timer3
Fast 8051 (2T)	4K~32K with IAP, ISP, ICP	256~2048	Fast/Slow/ Idle/Stop	8051 Standard	8051 Standard	15-bit

# **Family Members Features**

P/N	Program Memory	Data Memory	RAM Bytes	IO Pin	PWM	SAR ADC	Touch Key	LCD	LED	Interface
TM52-F8368	Flash 8K Bytes	IAP share with main rom	512	26	16-bit x7	12-bit 16-ch	_	4com	-	UART*1 MI <sup>2</sup> C*1
TM52-F8274	Flash	EEPROM	1024	26	(8+2)-bit	12-bit	_	8com	4Cx6S	SPI*1 UART*1
TM52-F8278	8K Bytes	128 Bytes	1024	20	x3	16-ch	16-ch	ocom		UART2*1
TM52-F8273	Flash	EEPROM	1024	26	(8+2)-bit	12-bit	_	0.000	4Cx6S	SPI*1 UART*1
TM52-F8276	16K Bytes	128 Bytes	1024	20	х3	16-ch	16-ch	8com	4CX05	UART2*1

P/N	Operation		Operation	n Current		Max. System Clock (Hz)					
	Voltage	Fast FRC	Slow SRC	Idle SRC	Stop mode	SXT	SRC	FXT	FRC		
TM52-F8368	2.3~5.5V	9.7mA	2.8mA	24uA	0.1uA	_	80K	_	16.588M		
TM52-F8274	2.3~5.5V	5.3mA	1.3mA	20µA	0.1μΑ	32K	68K	12M	12.902M		
TM52-F8278	2.5~5.5 V	J.SIIIA	1.3IIIA	20μΑ	0.1μΑ	32 <b>K</b>	Non	1 Z IVI	12.902IVI		
TM52-F8273	2.3~5.5V	5.3mA	1.3mA	20μA	0.1µA	32K	68K	12M	12.902M		
TM52-F8276	2.3 3.3 4	J.JIII/4	1.511174	20μΑ	0.1μΑ	J2IX	JUL	12111	12.702111		

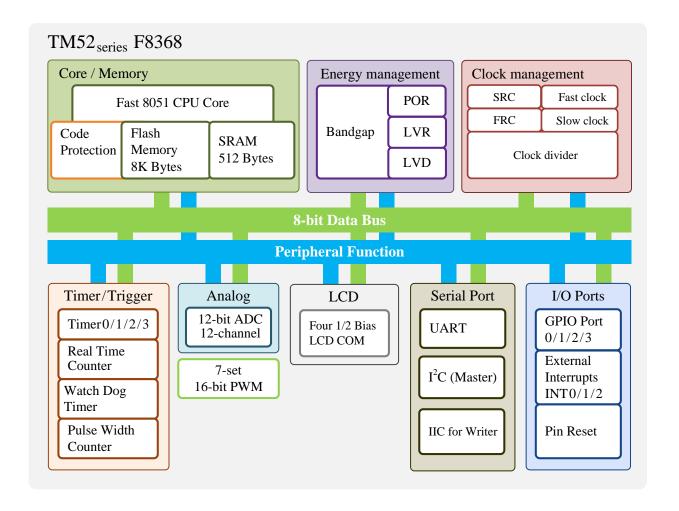
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# GENERAL DESCRIPTION

**TM52** series **F8368** are versions of a new, fast 8051 architecture for an 8-bit microcontroller single chip with an instruction set fully compatible with industry standard 8051, and retains most 8051 peripheral's functional block. Typically, the **TM52** executes instructions six times faster than the standard 8051 architecture.

The **TM52-F8368** provides improved performance, lower cost and fast time-to-market by integrating features on the chip, including 8K Bytes Flash program memory, 512 Bytes SRAM, Low Voltage Reset (LVR), Low Voltage Detector (LVD), dual clock power saving operation mode, 8051 standard UART and Timer0/1/2, real time clock Timer3, 7 set 16-bit PWMs, 12 channels 12-bit A/D Convertor, master I<sup>2</sup>C interface and Watch Dog Timer. It's a high reliability and low power consumption feature can be widely applied in consumer and home appliance products.



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# **FEATURES**

### 1. Standard 8051 Instruction set, fast machine cycle

• Executes instructions six times faster than the standard 8051.

# 2. MTP Program Memory

- 8K Bytes
- Support "In Application Programming" (IAP)"
- Code Protection Capability
- 10K erase times at least
- 10 years data retention at least

\*Each IAP address can be programmed more than 10000 times (typical value) .If the customer needs more programming times, a ROM area can be planned to disperse the address written by IAP data. Our company can provide the source code of this usage method.

#### 3. Total 512 Bytes SRAM (IRAM + XRAM)

- 256 Bytes IRAM in the 8051 internal data memory area
- 256 Bytes XRAM in the 8051 external data memory area (accessed by MOVX Instruction)

## 4. Two System Clock type selections

- Fast clock from Internal RC (FRC, 16.588 MHz)
- Slow clock from Internal RC (SRC, 80 KHz)
- System Clock can be divided by 1/2/4/16 option

# 5. 8051 Standard Timer – Timer 0/1/2

- 16-bit Timer0, also supports T0O clock output for Buzzer application
- 16-bit Timer1, also supports T1O clock output for Buzzer application
- 16-bit Timer2, also supports T2O clock output for Buzzer application

#### 6. 15-bit Timer3

- Clock source is Slow clock
- Interrupt period can be clock divided by 32768/16384/8192/128 option

#### 7. One UART

• 8051 standard UART, One Wire UART option can be used for ISP or other application

\*Support one UART, pin select to P30/P31 or P02/P16 by TXRXSEL (SFR 93h.7)

# 8. Seven "16" bits PWMs with prescaler/ period-adjustment

# 9. One Master I<sup>2</sup>C interface (MIIC)

\*Support one MIIC, pin select to P35/P16 by MSDASEL (SFR B7h.7), pin select to P13/P02 by MSCLSEL (SFR B7h.6)

# 10. 12-bit ADC with 12 channels External Pin Input and 3 channels Internal Reference Voltage

• Internal Reference Voltage (VBG): 1.22V±1.5% @V<sub>CC</sub>=5.5V~2.5V, 25°C



- Internal Reference Voltage: V<sub>SS</sub> (0V)
- Internal Reference Voltage: V<sub>CC</sub>/4

#### 11. LCD Driver

- Software controlled COM0~3
- 1/2 LCD Bias

## 12. 13 Sources, 4-level priority Interrupt

- Timer0/Timer1/Timer2/Timer3 Interrupt
- INT0/INT1 pin Falling-Edge/Low-Level Interrupt
- INT2 pin Interrupt
- Port0/1/2/3 Pin Change Interrupt
- UART TX/RX Interrupt
- ADC Interrupt
- Master I<sup>2</sup>C (MIIC) interrupt
- LVD Interrupt
- PWM0/PWM1 interrupt

# 13. Pin Interrupt can Wake up CPU from Power-Down (Stop) mode

- P3.2/P3.3 (INT0/INT1) Interrupt & Wake-up
- P3.7 (INT2) Interrupt & Wake-up
- Each Port0/1/2/3 pin can be defined as Interrupt & Wake-up pin (by pin change)

# 14. Max. 26 Programmable I/O pins

- CMOS Output
- Pseudo-Open-Drain, or Open-Drain Output
- Schmitt Trigger Input
- Pin Pull-up can be Enabled or Disabled

# 15. Independent RC Oscillating Watch Dog Timer

• 400ms/200ms/100ms/50ms selectable WDT timeout options

#### 16. Five types Reset

- Power on Reset
- Selectable External Pin Reset
- Selectable Watch Dog Reset
- Software Command Reset
- Selectable Low Voltage Reset

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## 17. 16-level Low Voltage Reset

2.15V / 2.30V / 2.45V / 2.60V / 2.70V / 2.85V / 3.00V / 3.15V / 3.30V / 3.45V / 3.60V / 3.75V / 3.90V / 4.05V / 4.20V / 4.35V

#### 18. 15-level Low Voltage Detect

• 2.30V / 2.45V / 2.60V / 2.70V / 2.85V / 3.00V / 3.15V / 3.30V / 3.45V / 3.60V / 3.75V / 3.90V / 4.05V / 4.20V / 4.35V

# 19. Four Power Operation Modes

• Fast/Slow/Idle/Stop mode

# 20. Integrated 16-bit Cyclic Redundancy Check function

# 21. Multiplication and division

- 8 bits Multiplier & Divider (standard 8051)
- 16 bits Multiplier & Divider
- 32 bits ÷ 16 bits Divider

# 22. On-chip Debug/ICE interface

- Use P3.0/P3.1 pin or P2.0/P2.1 pin
- Share with ICP programming pin

### 23. Operating Voltage and Current

- $V_{CC} = LVR3.0V \sim 5.5V @F_{SYSCLK} = 16.588 MHz$
- $V_{CC} = LVR2.15V \sim 5.5V @F_{SYSCLK} = 8.294MHz$
- $V_{CC} = LVR2.15V \sim 5.5V @F_{SYSCLK} = 4.147MHz$
- $I_{CC} = 0.1 \mu A$  @Stop mode, PWRSAV=1,  $V_{CC} = 3V$
- $I_{CC} = 10 \mu A$  @Idle mode, PWRSAV=1,  $V_{CC} = 3V$

#### 24. Operating Temperature Range

•  $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ 

# 25. Package Types

- 16-pin SOP (150mil)
- 20-pin TSSOP (173 mil)
- 20-pin SOP (300 mil)
- 20-pin QFN (3x3x0.75-0.4mm)
- 20-pin QFN (3x3x0.75-0.4mm) (L=0.25mm)
- 24-pin SSOP (150mil)
- 28-pin SOP (300 mil)
- 28-pin SSOP (150mil)
- 28-pin QFN (4x4x0.75-0.4mm)

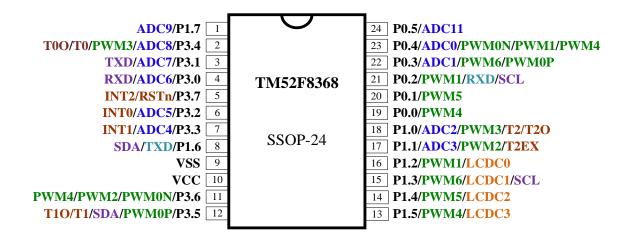
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# PIN ASSIGNMENT

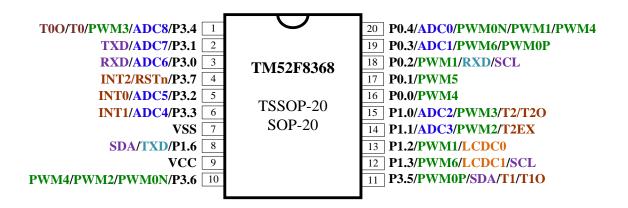
- \*UART default pin is P30, P31, user can set P02, P16 instead by TXRXSEL (SFR 93h.7)
- \*Master I<sup>2</sup>C SDA default pin is P35, user can set P16 instead by MSDASEL (SFR B7h.7)
- \*Master I<sup>2</sup>C SCL default pin is P13, user can set P02 instead by MSCLSEL (SFR B7h.6)

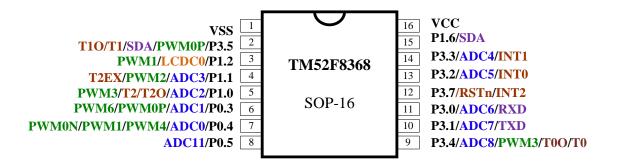
-		
PWM6/ADC10/P0.7 1		28 <b>P0.6/PWM1/PWM5</b>
<b>ADC9/P1.7</b> 2		27 <b>P0.5/ADC11</b>
<b>T0O/T0/PWM3/ADC8/P3.4</b> 3		26 P0.4/ADC0/PWM0N/PWM1/PWM4
TXD/ADC7/P3.1 4	<b></b>	25 <b>P0.3/ADC1/PWM6/PWM0P</b>
<b>RXD/ADC6/P3.0</b> 5	TM52F8368	24 <b>P0.2/PWM1/RXD/SCL</b>
INT2/RSTn/P3.7 6		23 <b>P0.1/PWM5</b>
INT0/ADC5/P3.2 7		22 <b>P0.0/PWM4</b>
INT1/ADC4/P3.3 8	SOP-28	21 <b>P1.0/ADC2/PWM3/T2/T2O</b>
VSS 9	SSOP-28	20 <b>P1.1/ADC3/PWM2/T2EX</b>
<b>SDA/TXD/P1.6</b> 10	2201 20	19 P1.2/PWM1/LCDC0
<b>VCC</b> 11		18 <b>P1.3/PWM6/LCDC1/SCL</b>
PWM4/PWM2/PWM0N/P3.6 12		17 <b>P1.4/PWM5/LCDC2</b>
T1O/T1/SDA/PWM0P/P3.5 13		16 <b>P1.5/PWM4/LCDC3</b>
<b>P2.1</b> 14		15 <b>P2.0</b>



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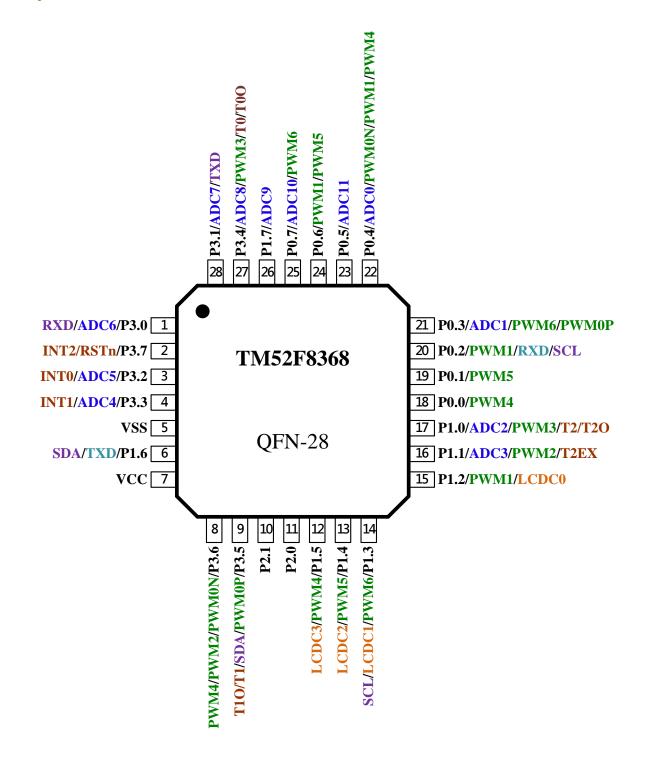




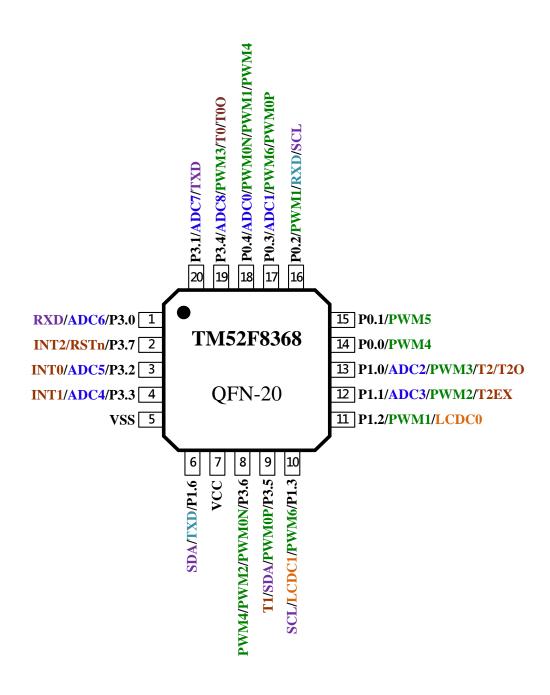


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# PIN DESCRIPTION

Name	In/O ut	Pin Description
P0.0~P0.7	I/O	Bit-programmable I/O port for Schmitt-trigger input or CMOS push-pull output. Pull-up resistors are assignable by software.
P1.0~P1.7	I/O	Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or "open-drain" output. Pull-up resistors are assignable by software. These pin's level change can interrupt/wake up CPU from Idle/Stop mode.
P2.0~P2.1	I/O	Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or "open-drain" output. Pull-up resistors are assignable by software.
P3.0~P3.2	I/O	Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or "pseudo open drain" output. Pull-up resistors are assignable by software.
P3.3~P3.7	I/O	Bit-programmable I/O port for Schmitt-trigger input, CMOS push-pull output or "open-drain" output. Pull-up resistors are assignable by software.
INT0, INT1	I	External low level or falling edge Interrupt input, Idle/Stop mode wake up input.
INT2	I	External falling edge Interrupt input, Idle/Stop mode wake up input.
RXD	I/O	UART Mode0 transmit & receive data, Mode1/2/3 receive data
TXD	I/O	UART Mode0 transmit clock, Mode1/2/3 transmit data. In One Wire UART mode, this pin transmits and receives serial data.
T0, T1, T2	I	Timer0, Timer1, Timer2 event count pin input.
T2EX	I	Timer2 external trigger input.
T0O	О	Timer0 overflow divided by 64 output
T10	О	Timer1 overflow divided by 2 output
T2O	О	Timer2 overflow divided by 2 output
PWM1~PWM6 PWM0P/PWM0N	О	16 bit PWM output
AD0~AD11	I	ADC input
LCDC0~LCDC3	О	LCD 1/2 bias output
SCL	I/O	Master I <sup>2</sup> C (MIIC) SCL
SDA	I/O	Master I <sup>2</sup> C (MIIC) SDA
RSTn	I	External active low reset input, Pull-up resistor is fixed enable.
VCC, VSS	P	Power input pin and ground



# **PIN SUMMERY**

Pin Number			]	npu	ıt	О	utp	ut				nati ctio			MISC
QFN-28	Pin Name	Type	Pull-up Control	Wake up	Ext. Interrupt	CMOS P.P.	P.O.D.	0.D.	TCD	ADC	UART	PWM	Timer	MIIC	
1	RXD/ADC6/P3.0	I/O	0	•		•	•	•		•	•				
2	INT2/RSTn/P3.7	I/O	0	•	•	•		•							Reset
3	INTO/ADC5/P3.2	I/O	0	•	•	•	•	•		•					
4	INT1/ADC4/P3.3	I/O	0	•	•	•		•		•					
5	VSS	P													
6	SDA/TXD/P1.6	I/O	0	•		•		•			•			•	
7	VCC	P													
8	PWM4/PWM2/PWM0N/P3.6	I/O	0	•		•		•				•			
9	T1/SDA/PWM0P/P3.5	I/O	0	•		•		•				•	•	•	T1O
10	P2.1	I/O	0	•		•		•							
11	P2.0	I/O	0	•		•		•							
12	LCDC3/PWM4/P1.5	I/O	0	•		•		•	•			•			
13	LCDC2/PWM5/P1.4	I/O	0	•		•		•	•			•			
14	SCL/LCDC1/PWM6/P1.3	I/O	0	•		•		•	•			•		•	
15	LCDC0/PWM1/P1.2	I/O	0	•		•		•	•			•			
16	T2EX/PWM2/ADC3/P1.1	I/O	0	•		•		•		•		•	•		
17	T2O/T2/PWM3/ADC2/P1.0	I/O	0	•		•		•		•		•	•		T2O
18	PWM4/P0.0	I/O	•	•		•						•			
19	PWM5/P0.1	I/O	•	•		•						•			
20	SCL/RXD/PWM1/P0.2	I/O	•	•		•					•	•		•	
21	PWM0P/PWM6/ADC1/P0.3		•	•		•				•		•			
22	PWM4/PWM1/PWM0N/ADC0/P0.4	I/O	•	•		•				•		•			
23	ADC11/P0.5	I/O	•	•		•				•					
24	PWM5/PWM1/P0.6	I/O	•	•		•						•			
25	PWM6/ADC10/P0.7	I/O	•	•		•				•		•			
26	ADC9/P1.7		0	•		•		•		•					
27	/T0O /T0/PWM3/ADC8/P3.4	I/O	0	•		•		•		•		•	•		T0O
28	TXD /ADC7/P3.1	I/O	0	•		•	•	•		•	•				

# Symbol:

P.P. = Push-Pull O.D. = Open Drain

P.O.D. = Pseudo Open Drain

# PS:

- 1. Port1, P2.0, P2.1, Port3 these pins control Pull up resistor by operation modes
- 2. Port0 control Pull up resistor while P0OE.n=0 and P0.n=1

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# **FUNCTIONAL DESCRIPTION**

# 1. CPU Core

In the 8051 architecture, the C programming language is used as a development platform. The TM52 device features a fast 8051 core in a highly integrated microcontroller, allowing designers to be able to achieve improved performance compared to a classic 8051 device. TM52 series microcontrollers provide a complete binary code with standard 8051 instruction set compatibility, ensuring an easy migration path to accelerate the development speed of system products. The CPU core includes an ALU, a program status word (PSW), an accumulator (ACC), a B register, a stack point (SP), DPTRs, a program counter, an instruction decoder, and core special function registers (SFRs).

#### Accumulator (ACC)

This register provides one of the operands for most ALU operations. Accumulators are generally referred to as A or Acc and sometimes referred to as Register A. In this document, the accumulator is represented as "A" or "ACC" including the instruction table. The accumulator, as its name suggests, is used as a general register to accumulate the intermediate results of a large number of instructions. The accumulator is the most important and frequently used register to complete arithmetic and logical operations. It holds the intermediate results of most arithmetic and logic operations and assists in data transportation.

SFR E0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ACC	ACC.7	ACC.6	ACC.5	ACC.4	ACC.3	ACC.2	ACC.1	ACC.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

E0h.7~0 **ACC:** Accumulator

#### B Register (B)

The "B" register is very similar to the ACC and may hold a 1 Byte value. This register provides the second operand for multiply or divide instructions. Otherwise, it may be used as a scratch pad register. The B register is only used by two 8051 instructions, MUL and DIV. When A is to be multiplied or divided by another number, the other number is stored in B. For MUL and DIV instructions, it is necessary that the two operands are in A and B.

ex: DIV AB

When this instruction is executed, data inside A and B are divided, and the answer is stored in A.

SFR F0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
В	B.7	B.6	B.5	B.4	B.3	B.2	B.1	B.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

F0h.7~0 **B:** B register

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# Stack Pointer (SP)

The SP register contains the Stack Pointer. The Stack Pointer is used to load the program counter into memory during LCALL and ACALL instructions and is used to retrieve the program counter from memory in RET and RETI instructions. The stack may also be saved or loaded using PUSH and POP instructions, which also increment and decrement the Stack Pointer.

SFR 81h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
SP		SP								
R/W		R/W								
Reset	0	0	0	0	0	1	1	1		

81h.7~0 **SP:** Stack Point

#### **Dual Data Pointer (DPTRs)**

TM52 device has two DPTRs, which share the same SFR address. Each DPTR is 16 bits in size and consists of two registers: the DPTR high byte (DPH) and the DPTR low byte (DPL). The DPTR is used for 16-bit-address external memory accesses, for offset code byte fetches, and for offset program jumps. Setting the DPSEL control bit allows the program code to switch between the two physical DPTRs.

SFR 82h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
DPL		DPL							
R/W				R/	W				
Reset	0	0	0	0	0	0	0	0	

82h.7~0 **DPL:** Data Point low byte

SFR 83h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
DPH		DPH								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

83h.7~0 **DPH:** Data Point high byte

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	VBGEN	ADSOC	CLRPWM0	CLRPWM1	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	R/W
Reset	0	0	0	0	1	1	_	0

F8h.0 **DPSEL:** Active DPTR Select

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# **Program Status Word (PSW)**

This register contains status information resulting from CPU and ALU operations. The instructions that affect the PSW are listed below.

Instruction		Flag	
instruction	C	OV	AC
ADD	X	X	X
ADDC	X	X	X
SUBB	X	X	X
MUL	0	X	
DIV	0	X	
DA	X		
RRC	X		
RLC	X		
SETB C	1		

Instruction		Flag	
Instruction	C	ov	AC
CLR C	0		
CPL C	X		
ANL C, bit	X		
ANL C, /bit	X		
ORL C, bit	X		
ORL C, /bit	X		
MOV C, bit	X		
CJNE	X		

A "0" means the flag is always cleared, a "1" means the flag is always set and an "X" means that the state of the flag depends on the result of the operation.

SFR <b>D0h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PSW	CY	AC	F0	RS1	RS0	OV	F1	P
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

D0h.7 **CY:** ALU carry flag

D0h.6 **AC:** ALU auxiliary carry flag

D0h.5 **F0:** General purpose user-definable flag

D0h.4~3 **RS1, RS0:** The contents of (RS1, RS0) enable the working register banks as:

00: Bank 0 (00h~07h)

01: Bank 1 (08h~0Fh)

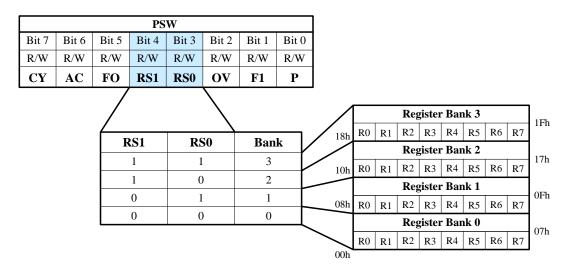
10: Bank 2 (10h~17h)

11: Bank 3 (18h~1Fh)

D0h.2 **OV:** ALU overflow flag

D0h.1 **F1:** General purpose user-definable flag

D0h.0 **P:** Parity flag. Set/cleared by hardware each instruction cycle to indicate odd/even number of "one" bits in the accumulator.





### 2. Memory

# 2.1 Program memory (with IAP)

The Chip has an 8K Bytes Flash program memory which can support In Circuit Programming (ICP), In Application Programming (IAP) and In System Programming (ISP) function modes. The program memory address continuous space (0000h~1FFFh) is partitioned to several sectors for device operation.

#### 2.1.1 Functional Partition

The last 16 bytes (1FF0h~1FFFh) of program memory is defined as chip Configuration Word (CFGW), which is loaded into the device control registers upon power on reset (POR). The 0000h~007Fh is occupied by Reset/Interrupt vectors as standard 8051 definition. For **TM52F8368**, the address space 1F00h~1FEFh is defined as the IAP area. In the in-circuit emulation (ICE) mode, user also needs to reserve the address space 0D00h~0FFFh for ICE System communication.CRC16H/L is the reserved area of the checksum. Tenx can provide a CRC verification subroutine. The user can calculate the checksum by the CRC verification subroutine to compare with CRC16H/L and check the validity of the ROM code.

_	8K Bytes Program Memory
0000h	
	Reset/Interrupt Vector
007Fh	
0080h	
	User Code area
o CEET	
0CFFh	
0D00h	ICE 1
0FFFh	ICE mode reserve area
1000h	
100011	
	User Code area
1EFFh	
1F00h	
	IAP-Free area
1FEFh	
1FF0h	CRC16L
1FF1h	CRC16H
1FF2h	
	tenx reserve area
1FFAh	
1FFBh	CFGBG
1FFDh	CFGWL (FRC)
1FFFh	CFGWH

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#### 2.1.2 Flash ICP Mode

The Flash memory can be programmed by the tenx proprietary writer (**TWR98/TWR99**), which needs at least four wires (VCC, VSS, P3.0 and P3.1) to connect to this chip. If user wants to program the Flash memory on the target circuit board (In Circuit Program, ICP), these pins must be reserved sufficient freedom to be connected to the Writer. The P3.0 and P3.1 pin's can be replaced by P2.0 and P2.1.

Writer wire number	Pin connection
4 Wine	VCC, VSS, P3.0, P3.1
4-Wire	VCC, VSS, P2.0, P2.1

#### 2.1.3 Flash IAP Mode

The chip has "In Application Program" (IAP) capability, which allows software to read/write data from/to the Flash memory during CPU run time as conveniently as data EEPROM access. The IAP function is byte writable, meaning that the chip does not need to erase one Flash page before write. The available IAP data space is 240 Bytes after chip reset, and can be re-defined by the "IAPALL" control register as shown below.

_	8K Bytes Flash Program memory		Flash memory	IAPALL	MOVC Accessible	MOVX (IAP) Accessible
0000h	IAP-All area	0000h~1EFFh		0	Yes	No
1EFFh	IAP-AII area		0000li~1EFFII	1	Yes	Yes
1F00h 1FEFh	IAP-Free area		1F00h~1FEFh	X	Yes	Yes
1FF0h			1CC01 1CCC1	0	Yes	No
	CFGW area		1FF0h~1FFEh	1	Yes	Yes
1FFFh			1FFFh	X	Yes	No

In IAP mode, the program Flash memory is separated into three sectors: IAP-All area, IAP-Free area, and CFGW area. These four sectors are regulated differently.

The **IAP-All area** is protected by the IAPALL register to prevent IAP mode from writing application data to the program area, resulting in a program code error that cannot be repaired. The size of this area is 7936 Bytes. Enabling IAPALL requires writing 65h to SFR SWCMD 97h to set the IAPALL control flag. Then, software can use MOVX instructions to write application data to flash memory from 0000h to 1EFFh. If user wants to disable IAPALL function, user can write other values to SFR SWCMD 97h to clear the IAPALL control flag. User must be careful not to overwrite program code which is already resided on the same Flash memory area.

The **IAP-Free area** has no control bit to protect. It can be used to reliably store system application data that needs to be programmed once or periodically during system operation. Other areas of Flash memory can be used to store data, but this area is usually better. The size of this area is 240 Bytes, equivalent to an EEPROM, and Flash memory can provide byte access to read and write commands.

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The CFGW area has 16 data bytes, which is located at the last 16 addresses of Flash memory. The CFGWH is not accessible to IAP, while the CFGWL and CFGBG can be read or written by IAP in case the IAPALL flag is set. CFGWL is copied to the SFR F6h and CFGBG is copied to the SFR F5h after power on reset, software then take over CFGWL's and CFGBG's control capability by modifying the SFR F6h and F5h.

#### 2.1.4 IAP Mode Access Routines

Flash IAP Write is simply achieved by a "MOVX @DPTR, A" instruction while the DPTR contains the target Flash address (0000h~1FFEh), and the ACC contains the data being written. The chip accepts IAP write command only when IAPWE=1. Flash IAP writing one byte requires approximately 0.5 ms. Meanwhile the CPU stays in a waiting state, but all peripheral modules continue running during the writing time. The software must handle the pending interrupts after an IAP write. The chip has a build-in IAP Time-out function for escaping write fail state.

Flash IAP writing needs higher  $V_{CC}$  voltage,  $V_{CC}>4.0V$ , LVR setting needs to be greater than 4.0V,  $V_{CC}$  capacitance greater than 220uF, user must close LVR during IAP write.

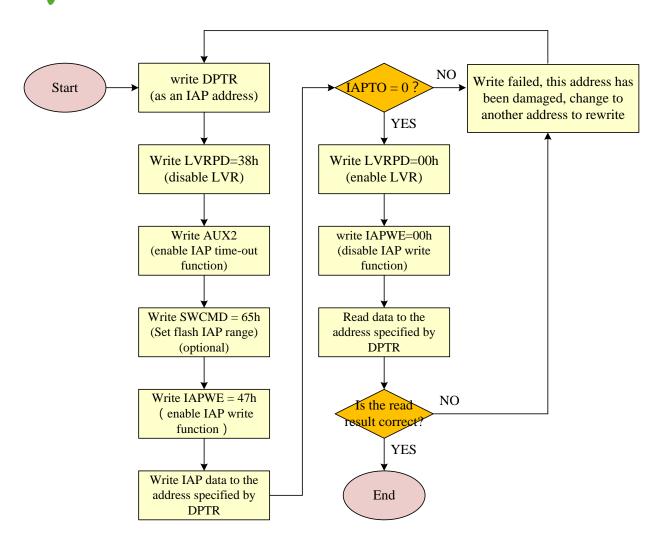
Because the Program memory and the IAP data space share the same entity, **Flash IAP Read** can be performed by the "MOVC" instruction as long as the target address points to the 0000h~1FFEh area. A Flash IAP read does not require extra CPU wait time.

#### IAP example:

```
; need 4.0V < V_{CC} < 5.5V
MOV
         DPTR, #1F00h
                              ; DPTR=1F00h=target IAP address
MOV
                              ; A=5Ah=target IAP write data
          A, #5Ah
MOV
         LVRPD, #38h
                              ;LVR disable, POR enable
MOV
                              ; IAP Time-Out function enable
          AUX2, #04h
MOV
                              ; Set flash IAP range (optional)
          SWCMD, #65h
MOV
          IAPWE, #47h
                              ; IAP write enable
MOVX
          @DPTR, A
                              ; Flash[1F00h] =5Ah, after IAP write
                              ; 1ms~2ms H/W writing time, CPU wait
MOV
         LVRPD, #00h
                              ;LVR enable, POR enable
MOV
         IAPWE, #00h
                              ; IAP write disable, immediately after IAP write
CLR
                              : A=0
MOVC
          A, @A+DPTR
                              ; Read. A=5Ah
```

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IAP Flow chart

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SFR <b>97h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CWCMD				IAPALL	/SWRST			
SWCMD			_	_			WDTO	IAPALL
R/W			R	R				
Reset			-	_			0	0

#### 97h.7~0 **IAPALL (W):**

Write 65h, the available range of flash memory IAP is 0000h~1FEFh (IAPALL read back value is 1) Write 00h, the available range of flash memory IAP is 1F00h~1EFFh (IAPALL read back value is 0)

#### 97h.0 **IAPALL** (**R**):

0: Flash memory 0000h~1EFFh cannot use IAP, only 1F00h~1EFFh can use IAP

1: Flash memory 0000h~1EFFh and 1F00h~1EFFh can use IAP.

SFR C9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
I A DXX/E		IAPWE								
IAPWE	IAPWE	IAPTO	_							
R/W	R	R		W						
Reset	0	0								

C9h.7~0 **IAPWE** (**W**): Write 47h to set IAPWE control flag; Write other value to clear IAPWE and EEPWE flag. It is recommended to clear it immediately after IAP or EEPROM write.

C9h.7 **IAPWE (R):** Flag indicates Flash memory can be written by IAP or not, 1=IAP Write enable.

C9h.6 **IAPTO** (**R**): IAP watchdog Time-Out flag, Set by H/W when IAP Time-out occurs. Cleared by H/W when IAPWE=0.

SFR E5h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LVRPD				LVI	RPD			
W		W						
Reset	0							

E5h.7~0 LVRPD: LVR and POR power down option

Write 0x37 to force LVR disable, POR disable Write 0x38 to force LVR disable, POR enable

SFR F7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX2	WI	)TE	PWRSAV	VBGOUT	DIV32	IAI	PΤΕ	MULDIV16
R/W	R/W	R/W	R/W	R/W	R/W	R/	W	R/W
Reset	0	0	0	0	0	1	1	0

F7h.2~1 **IAPTE:** IAP write watchdog timer enable

00: Disable

01: wait 0.9mS trigger watchdog time-out flag, and escape the write fail state

10: wait 3.6mS trigger watchdog time-out flag, and escape the write fail state

11: wait 7.2mS trigger watchdog time-out flag, and escape the write fail state

# 2.1.5 Flash ISP Mode

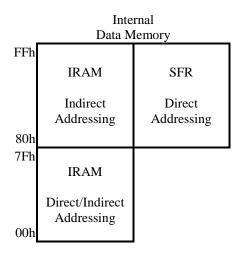
The "In System Programming" (ISP) usage is similar to IAP, except the purpose is to refresh the Program code. User can use UART or other method to get new Program code from external host, then writes code as the same way as IAP. ISP operation is complicated; basically it needs to assign a Boot code area to the Flash which does not change during the ISP process.

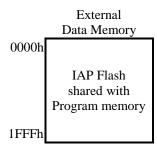
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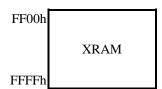


#### **2.2 RAM**

As the standard 8051, the Chip has both Internal and External Data Memory space. The Internal Data Memory space consists of 256 Bytes IRAM and SFRs, which are accessible through a rich instruction set. The External Data Memory space consists of 256 Bytes XRAM, which can be only accessed by MOVX instruction.







#### **IRAM**

IRAM is located in the 8051 internal data memory space. The whole 256 Bytes IRAM are accessible using indirect addressing but only the lower 128 Bytes are accessible using direct addressing. There are four directly addressable register banks (switching by PSW), which occupy IRAM space from 00h to 1Fh. The address 20h to 2Fh 16 Bytes IRAM space is bit-addressable. IRAM can be used as scratch pad registers or program stack.

## **XRAM**

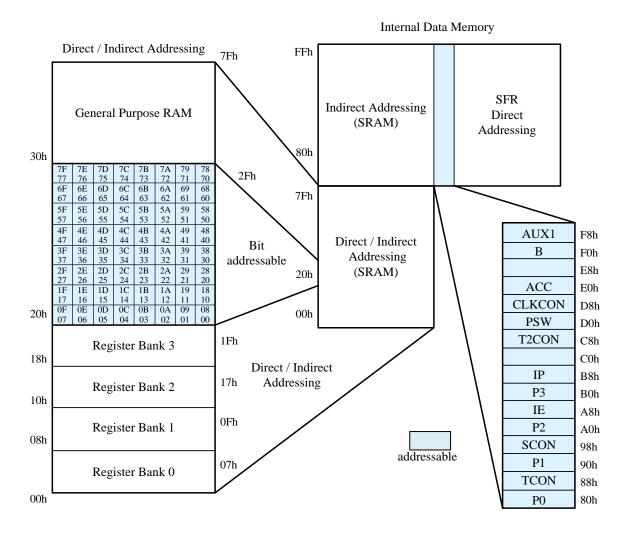
XRAM is located in the 8051 external data memory space (address from FF00h to FFFFh). The 256Bytes XRAM can be only accessed by "MOVX" instruction.

#### 2.3 Special Function Register (SFR)

All peripheral functional modules such as I/O ports, Timers and UART operations for the chip are accessed via Special Function Registers (SFRs). These registers occupy upper 128 Bytes of direct Data Memory space locations in the range 80h to FFh. There are 14 bit-addressable SFRs (which means that eight individual bits inside a single byte are addressable), such as ACC, B register, PSW, TCON, SCON, and others. The remaining SFRs are only byte addressable. SFRs provide control and data exchange with the resources and peripherals of the Chip. The TM52 series of microcontrollers provides complete binary code with standard 8051 instruction set compatibility. Beside the standard 8051 SFRs, the Chip implements additional SFRs used to configure and access subsystems such as the ADC/LCD, which are unique to the Chip.

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	8/0	9/1	A/2	B/3	C/4	D/5	E/6	F/7
F8h	AUX1							
F0h	В	CRCDL	CRCDH	CRCIN		CFGBG	CFGWL	AUX2
E8h		PWM4DH	PWM4DL	PWM5DH	PWM5DL	PWM6DH	PWM6DL	
E0h	ACC	MICON	MIDAT		LVDCON		EXA	EXB
D8h	CLKCON	PWM0PRDH	PWM0PRDL	PWM1PRDH	PWM1PRDL	PWM3DH	PWM3DL	
D0h	PSW	PWM0DH	PWM0DL	PWM1DH	PWM1DL	PWM2DH	PWM2DL	
C8h	T2CON	IAPWE	RCP2L	RCP2H	TL2	TH2	EXA2	EXA3
C0h						P0WKUP	P2WKUP	P3WKUP
B8h	IP	IPH	IP1	IP1H				
B0h	Р3						PWMOE1	PWMOE2
A8h	IE	INTE1	ADCDL	ADCDH			CHSEL	P0DIE
A0h	P2	PWMCON	P1MODL	P1MODH	P3MODL	P3MODH	PWMOE0	PWMCON2
98h	SCON	SBUF						
90h	P1	P0OE	P1LOE	PINMOD	OPTION	INTFLG	P1WKUP	SWCMD
88h	TCON	TMOD	TL0	TL1	TH0	TH1		
80h	P0	SP	DPL	DPH	INTE2	INTFLG2		PCON



#### 3. Reset

The Chip has five types of reset methods. Resets can be caused by Power on Reset (POR), External Pin Reset (XRST), Software Command Reset (SWRST), Watchdog Timer Reset (WDTR), or Low Voltage Reset (LVR). The CFGWH controls the Reset functionality. The SFRs are returned to their default value after Reset.

# 3.1 Power on Reset (POR)

After Power on Reset, the device stays on Reset state for 40 ms as chip warm up time, The Power on Reset needs VCC pin's voltage first discharge to near VSS level, then rise beyond 2.5V.

#### 3.2 External Pin Reset (XRST)

External Pin Reset is active low. It needs to keep at least 2 SRC clock cycle long to be seen by the Chip. External Pin Reset can be disabled or enabled by CFGWH.

#### 3.3 Software Command Reset

Software Reset is activated by writing the SFR 97h with data 56h.

#### 3.4 Watchdog Timer Reset

WDT overflow Reset is disabled or enabled by SFR F7h. The WDT uses SRC as its counting time base. It runs in Fast/Slow mode and runs or stops in Idle/Stop mode. WDT overflow speed can be defined by WDTPSC SFR. WDT is cleared by device Reset or CLRWDT SFR bit.

## 3.5 Low Voltage Reset (LVR)

The Chip provides LVR and Low Voltage Detection (LVD) functions. There are 16-level LVR can be selected by CFGWH and 15-level LVD can be selected by SFR LVDSEL.

Note: refer to AP-TM52XXXXX\_02S for LVR setting information

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	Description
POR	Auto closed in STOP mode
LVR	16-level LVR can be selected by CFGWH. When PWRSAV=1, LVR will be automatically closed when entering IDLE/STOP mode

Operation	PWRSAV	LVRE	LVR	Eunation	Note					
Mode	(SFR F7.5)	(CFGWH.5~2)	LVK	Function	Note					
		0000	ON	LVR 2.15V						
		0001	ON	LVR 2.30V						
		0010	ON	LVR 2.45V						
		0011	ON	LVR 2.55V						
		0100	ON	LVR 2.70V						
		0101	ON	LVR 2.85V						
		0110	ON	LVR 3.00V						
Fast or Slow	X	0111	ON	LVR 3.15V						
rast of Slow	Λ	1000	ON	LVR 3.30V						
		1001	ON	LVR 3.45V						
		1010	ON	LVR 3.60V						
		1011	ON	LVR 3.75V						
		1100	ON	LVR 3.90V						
		1101	ON	LVR 4.05V						
		1110	ON	LVR 4.20V						
		1111	ON	LVR 4.35V						
		0000	ON	LVR 2.15V						
		0001	ON	LVR 2.30V						
			0010	ON	LVR 2.45V					
					0011	ON	LVR 2.55V			
		0100	ON	LVR 2.70V						
		0101	ON	LVR 2.85V						
		0110	ON	LVR 3.00V						
Idle	0	0111	ON	LVR 3.15V	Current consumption					
lale	U	1000	ON	LVR 3.30V	about 70uA					
							1001	ON	LVR 3.45V	
		1010	ON	LVR 3.60V						
		1011	ON	LVR 3.75V						
		1100	ON	LVR 3.90V						
		1101	ON	LVR 4.05V						
		1110	ON	LVR 4.20V						
		1111	ON	LVR 4.35V						
Idle	1	xxxx	OFF	LVR disable	Current consumption					
				POR enable	about 24uA					
Stop	1	xxxx	OFF	LVR disable POR disable	Minimum current consumption About 0.1uA					

LVR table

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SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	_	WDTPSC		ADCKS		TM3PSC	
R/W	R/W	_	R/W		R/W		R/W	
Reset	0	_	0	0	0	0	0	0

94h.5~4 **WDTPSC:** Watchdog Timer pre-scalar time select

00: 400ms WDT overflow rate 01: 200ms WDT overflow rate 10: 100ms WDT overflow rate 11: 50ms WDT overflow rate

SFR <b>97h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SWCMD		IAPALL/SWRST						
R/W		W						R/W
Reset			-	_			_	0

97h.7~0 **SWRST:** Write 56h to generate S/W Reset

SFR E5h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LVRPD		LVRPD						
W		W						
Reset				(	)			

FE5.7~0 **LVRPD:** LVR and POR power down option

Write 0x37 to force LVR disable, POR disable Write 0x38 to force LVR disable, POR enable

SFR F7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX2	WI	DTE	PWRSAV	VBGOUT	DIV32	IAI	PTE	MULDIV16
R/W	R/W	R/W	R/W	R/W	R/W	R/	W	R/W
Reset	0	0	0	0	0	1	1	0

F7h.7~6 **WDTE:** Watchdog Timer Reset control

0x: Watchdog Timer Reset disable

10: Watchdog Timer Reset enable in Fast/Slow mode, disable in Idle/Stop mode

11: Watchdog Timer Reset always enable

F7h.5 **PWRSAV:** chip power-saving option

Set 1 to reduce the chip's power consumption at Idle and Stop Mode

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	VBGEN	ADSOC	CLRPWM0	CLRPWM1	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	R/W
Reset	0	0	0	0	1	1	_	0

F8h.7 **CLRWDT:** Set to clear WDT, H/W auto clear it at next clock cycle

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Flash 1FFFh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CFGWH	PROT	XRSTE	LVRE				PREAD	FRCPSC

1FFFh.6 **XRSTE:** External Pin Reset control

0: Disable External Pin Reset

1: Enable External Pin Reset

1FFFh.5~2 LVRE: Low Voltage Reset function select

0000: Set LVR at 2.15V

0001: Set LVR at 2.30V

0010: Set LVR at 2.45V

0011: Set LVR at 2.55V

0100: Set LVR at 2.70V

0101: Set LVR at 2.85V

0110: Set LVR at 3.00V

0111: Set LVR at 3.15V

1000: Set LVR at 3.30V

1001: Set LVR at 3.45V

1010: Set LVR at 3.60V

1011: Set LVR at 3.75V

1100: Set LVR at 3.90V 1101: Set LVR at 4.05V

1110: Set LVR at 4.20V

1111: Set LVR at 4.35V



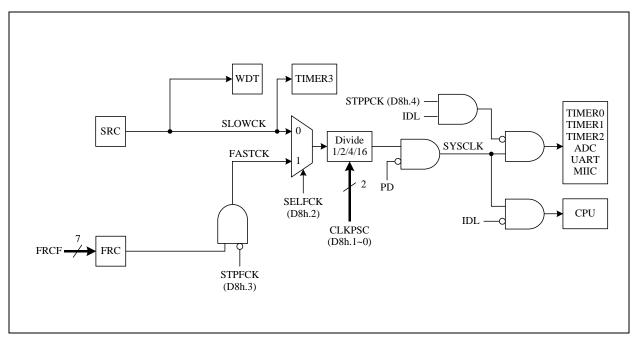
# 4. Clock Circuitry & Operation Mode

## 4.1 System Clock

The Chip is designed with dual-clock system. During runtime, user can directly switch the System clock from fast to slow or from slow to fast. It also can directly select a clock divider of 1, 2, 4 or 16. The Fast clock can be selected as FRC (Fast Internal RC, 16.588 MHz). The Slow clock can be selected as SRC (Slow Internal RC, 80 KHz). Fast mode and Slow mode are defined as the CPU running at Fast and Slow clock speeds.

After Reset, the device is running at Slow mode with 80 KHz SRC. S/W should select the proper clock rate for chip operation safety. The higher  $V_{\rm CC}$  allows the chip to run at a higher System clock frequency. In a typical condition, a 16 MHz System clock rate requires  $V_{\rm CC} > 3.1 V$ .

The **CLKCON** SFR controls the System clock operating. H/W automatically blocks the S/W abnormally setting for this register. S/W can only change the Slow clock type in Fast mode and change the Fast clock type in Slow mode. Never to write both STPFCK=1 & SELFCK=1. It is recommended to write this SFR bit by bit.



**Clock Structure** 

**Note:** Because of the CLKPSC delay, it needs to wait for 16 clock cycles (max.) before switching Slow clock to Fast clock. Also refer to AP-TM52XXXXX\_01S and AP-TM52XXXXX\_02S about System Clock Application Note.

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	CLKCO	N (D8h)
SYSCLK	bit3	bit2
	STPFCK	SELFCK
Fast FRC	0	1
Slow SRC	0/1	0
Stop FRC	0 <b>→</b> 1	0
Switch to FRC	0	0 <b>→</b> 1
Switch to SRC	0	1 <b>→</b> 0

Flash <b>1FFDh</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CFGWL	_		FRCF					

1FFDh.6~0 **FRCF:** FRC frequency adjustment.

FRC is trimmed to 16.588 MHz in chip manufacturing. FRCF records the adjustment data.

SFR F6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CFGWL	_		FRCF					
R/W	_		R/W					
Reset	_	_	_	_	_	_	_	_

F6h.6~0 **FRCF:** FRC frequency adjustment

00h= lowest frequency, 7Fh=highest frequency.

SFR D8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CLKCON	_	_	_	STPPCK	STPFCK	SELFCK	CLK	PSC
R/W	_	_	_	R/W	R/W	R/W	R/	W
Reset	_	_	_	0	0	0	1	1

- D8h.4 **STPPCK:** Set 1 to stop UARTs/Timer0/Timer1/Timer2/ADC clock in Idle mode for current reducing. If set, only Timer3 and pin interrupts are alive in Idle Mode.
- D8h.3 **STPFCK:** Set 1 to stop Fast clock for power saving in Slow/Idle mode. This bit can be changed only in Slow mode.
- D8h.2 **SELFCK:** System clock source selection. This bit can be changed only when STPFCK=0.
  - 0: Slow clock
  - 1: Fast clock
- D8h.1~0 **CLKPSC:** System clock prescaler. Effective after 16 clock cycles (Max.) delay.
  - 00: System clock is Fast/Slow clock divided by 16
  - 01: System clock is Fast/Slow clock divided by 4
  - 10: System clock is Fast/Slow clock divided by 2
  - 11: System clock is Fast/Slow clock divided by 1

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# 4.2 Operation Modes

There are four operation modes for this device.

#### **Fast Mode:**

Fast Mode is defined as the CPU running at Fast clock speed.

#### **Slow Mode:**

Slow Mode is defined as the CPU running at Slow clock speed. When the System clock speed is lower, the power consumption is lower.

#### **Idle Mode:**

Idle Mode is entered by setting the IDL bit in PCON SFR. Both Fast and Slow clock can be set as the System clock source in Idle Mode, but Slow clock is better for power saving. In Idle mode, the CPU puts itself to sleep while the on-chip peripherals stay active. The "STPPCK" bit in CLKCON SFR can be set to furthermore reduce Idle mode current. If STPPCK is set, only Timer3 and pin interrupts are alive in Idle Mode, others peripherals such as Timer0/1/2, UARTs and ADC are stop. The slower System clock rate also helps current saving. It can be achieved by setup the CLKPSC SFR to divide System clock frequency. Idle mode is terminated by Reset or enabled Interrupts wake up.

## **Stop Mode:**

Stop Mode is entered by setting the PD bit in PCON SFR. This mode is the so-called "Power Down" mode in standard 8051. In Stop mode, all clocks stop except the WDT could be alive if it is enabled. Stop Mode is terminated by Reset or pin wake up.

*Note:* Chip cannot enter Stop Mode if INTn pin is low and wakeup is enable. (INTn=0 and EXn=1, n=0,1,2)

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SFR <b>87h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PCON	SMOD	_	_	_	GF1	GF0	PD	IDL
R/W	R/W	_	_	_	R/W	R/W	R/W	R/W
Reset	0	_	_	_	0	0	0	0

87h.1 **PD:** Power down control bit, set 1 to enter STOP mode.

87h.0 **IDL:** Idle mode control bit, set 1 to enter IDLE mode.

SFR F7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX2	WI	TE	PWRSAV	VBGOUT	DIV32	IAI	PTE	MULDIV16
R/W	R/W	R/W	R/W	R/W	R/W	R/	W	R/W
Reset	0	0	0	0	0	1	1	0

F7h.4 **VBGOUT:** VBG voltage output to P3.2

0: Disable 1: Enable

SFR D8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CLKCON	_	_		STPPCK	STPFCK	SELFCK	CLK	PSC
R/W	_	_	_	R/W	R/W	R/W	R/	W
Reset	_	_	_	0	0	0	1	1

D8h.4 **STPPCK:** Set 1 to stop UART/Timer0/Timer1/Timer2/ADC clock in Idle mode for current reducing. If set, only Timer3 and pin interrupts are alive in Idle Mode.

D8h.3 **STPFCK:** Set 1 to stop Fast clock for power saving in Slow/Idle mode. This bit can be changed only in Slow mode.

D8h.2 **SELFCK:** System clock source selection. This bit can be changed only when STPFCK=0.

0: Slow clock 1: Fast clock

D8h.1~0 **CLKPSC:** System clock prescaler. Effective after 16 clock cycles (Max.) delay.

00: System clock is Fast/Slow clock divided by 16

01: System clock is Fast/Slow clock divided by 4

10: System clock is Fast/Slow clock divided by 2

11: System clock is Fast/Slow clock divided by 1

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# 5. Interrupt & Wake-up

This Chip has a 13-source four-level priority interrupt structure. All enabled Interrupts can wake up CPU from Idle mode, but only the Pin Interrupts can wake up CPU from Stop mode. Each interrupt source has its own enable control bit. An interrupt event will set its individual Interrupt Flag, no matter whether its interrupt enable control bit is 0 or 1. The Interrupt vectors and flags are list below.

Vector	Flag	Description			
0003	IE0	INTO external pin Interrupt (can wake up Stop mode)			
000B	TF0	Timer0 Interrupt			
0013	IE1	INT1 external pin Interrupt (can wake up Stop mode)			
001B	TF1	Timer1 Interrupt			
0023	RI+TI	Serial Port (UART) Interrupt			
002B	TF2+EXF2	Timer2 Interrupt			
0033	_	Reserved for ICE mode use			
003B	TF3	Timer3 Interrupt			
0043	PXIF	Port0~Port3 external pin change Interrupt (can wake up Stop mode)			
004B	IE2	INT2 external pin Interrupt (can wake up Stop mode)			
0053	ADIF	ADC Interrupt			
005B	MIIF	Master I <sup>2</sup> C (MIIC) Interrupt			
0063	LVDIF	LVD Interrupt			
006B	_	Reserved			
0073	PWM0IF+PWM1IF	PWM0~1 Interrupt			

**Interrupt Vector & Flag** 

# 5.1 Interrupt Enable and Priority Control

The IE and INTE1 SFRs decide whether the pending interrupt is serviced by CPU. The IP, IPH, IP1 and IP1H SFRs decide the interrupt priority. An interrupt will be serviced as long as an interrupt of equal or higher priority is not already being serviced. If an interrupt of equal or higher level priority is being serviced, the new interrupt will wait until it is finished before being serviced. If a lower priority level interrupt is being serviced, it will be stopped and the new interrupt serviced. When the new interrupt is finished, the lower priority level interrupt that was stopped will be completed.

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FR <b>84h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTE2	_	PWM1IE	PWM0IE	_			_	_
R/W	_	R/W	R/W	_			_	_
Reset	_	0	0	_	_	_	_	_

84h.6 **PWM1IE:** PWM1~PWM6 interrupt enable

0: Disable PWM1~PWM6 interrupt

1: Enable PWM1~PWM6 interrupt

84h.5 **PWM0IE:** PWM0 interrupt enable

0: Disable PWM0 interrupt
1: Enable PWM0 interrupt

SFR <b>96h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
P1WKUP		P1WKUP								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

96h.7~0 **P1WKUP:** P1.7~P1.0 pin individual Wake-up / Interrupt enable control

0: Disable1: Enable

SFR C5h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
P0WKUP		POWKUP								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

C5h.7~0 **P0WKUP:** P0.7~P0.0 pin individual Wake-up / Interrupt enable control

0: Disable1: Enable

SFR C6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
P2WKUP		P2WKUP								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

C6h.7~0 **P2WKUP:** P2.7~P2.0 pin individual Wake-up / Interrupt enable control

0: Disable 1: Enable

SFR C7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
P3WKUP		P3WKUP								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

C7h.7~0 **P3WKUP:** P3.7~P3.0 pin individual Wake-up / Interrupt enable control

0: Disable1: Enable

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SFR A8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IE	EA	_	ET2	ES	ET1	EX1	ET0	EX0
R/W	R/W	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	_	0	0	0	0	0	0

A8h.7 **EA:** Global interrupt enable control.

0: Disable all Interrupts.

1: Each interrupt is enabled or disabled by its individual interrupt control bit

A8h.5 **ET2:** Timer2 interrupt enable

0: Disable Timer2 interrupt

1: Enable Timer2 interrupt

A8h.4 **ES:** Serial Port (UART) interrupt enable

0: Disable Serial Port (UART) interrupt

1: Enable Serial Port (UART) interrupt

A8h.3 **ET1:** Timer1 interrupt enable

0: Disable Timer1 interrupt

1: Enable Timer1 interrupt

A8h.2 **EX1:** External INT1 pin Interrupt enable and Stop mode wake up enable

0: Disable INT1 pin Interrupt and Stop mode wake up

1: Enable INT1 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.

A8h.1 **ET0:** Timer0 interrupt enable

0: Disable Timer0 interrupt

1: Enable Timer0 interrupt

A8h.0 **EX0:** External INTO pin Interrupt enable and Stop mode wake up enable

0: Disable INT0 pin Interrupt and Stop mode wake up

1: Enable INT0 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.

SFR A9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTE1	PWMIE	_	LVDIE	I2CE	ADIE	EX2	PXIE	TM3IE
R/W	R/W	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	_	0	0	0	0	0	0

A9h.7 **PWMIE:** PWM0/PWM1~PWM6 interrupt enable

0: Disable PWM0/PWM1~PWM6 interrupt 1: Enable PWM0/PWM1~PWM6 interrupt

A9h.5 **LVDIE:** LVD interrupt enable

0: Disable LVD interrupt 1: Enable LVD interrupt

A9h.4 **I2CE:** I\*C interrupt enable

0: Disable I℃ interrupt 1: Enable I℃ interrupt

A9h.3 **ADIE:** ADC interrupt enable

0: Disable ADC interrupt 1: Enable ADC interrupt

A9h.2 **EX2:** External INT2 pin Interrupt enable and Stop mode wake up enable

0: Disable INT2 pin Interrupt and Stop mode wake up

1: Enable INT2 pin Interrupt and Stop mode wake up, it can wake up CPU from Stop mode no matter EA is 0 or 1.

A9h.1 **PXIE:** Port0~Port3 pin change interrupt enable. This bit does not affect the Port0~Port3 pin's Stop mode wake up capability.

0: Disable Port0~Port3 pin change interrupt

1: Enable Port0~Port3 pin change interrupt

A9h.0 **TM3IE:** Timer3 interrupt enable

0: Disable Timer3 interrupt

1: Enable Timer3 interrupt



SFR <b>B9h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IPH		_	PT2H	PSH	PT1H	PX1H	PT0H	PX0H
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	_	_	0	0	0	0	0	0

SFR B8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IP	_	_	PT2	PS	PT1	PX1	PT0	PX0
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	_	_	0	0	0	0	0	0

B9h.5, B8h.5 **PT2H, PT2 :** Timer2 Interrupt Priority control. (PT2H, PT2) =

11: Level 3 (highest priority)

10: Level 2 01: Level 1

00: Level 0 (lowest priority)

B9h.4, B8h.4 **PSH**, **PS**: Serial Port (UART) Interrupt Priority control. Definition as above.

B9h.3, B8h.3 **PT1H, PT1 :** Timer1 Interrupt Priority control. Definition as above.

B9h.2, B8h.2 **PX1H, PX1 :** External INT1 pin Interrupt Priority control. Definition as above.

B9h.1, B8h.1 **PT0H, PT0 :** Timer0 Interrupt Priority control. Definition as above.

B9h.0, B8h.0 **PX0H**, **PX0**: External INT0 pin Interrupt Priority control. Definition as above.

SFR BBh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IP1H	PPWMH	_	PLVDH	PI2CH	PADIH	PX2H	PPXH	РТ3Н
R/W	R/W		R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	_	0	0	0	0	0	0

SFR BAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IP1	PPWM	_	PLVD	PI2C	PADI	PX2	PPX	PT3
R/W	R/W	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	_	0	0	0	0	0	0

BBh.7, BAh.7 **PPWMH, PPWM:** PWM0/PWM1 Interrupt Priority control. Definition as above.

BBh.5, BAh.5 **PLVDH, PLVD:** LVD Interrupt Priority control. Definition as above.

BBh.4, BAh.4 **PI2CH, PI2C**: I<sup>2</sup>C Interrupt Priority control. Definition as above.

BBh.3, BAh.3 **PADIH, PADI:** ADC Interrupt Priority control. Definition as above.

BBh.2, BAh.2 **PX2H, PX2:** External INT2 pin Interrupt Priority control. Definition as above.

BBh.1, BAh.1 **PPXH, PPX:** Port0~Port3 Pin Change Interrupt Priority control. Definition as above.

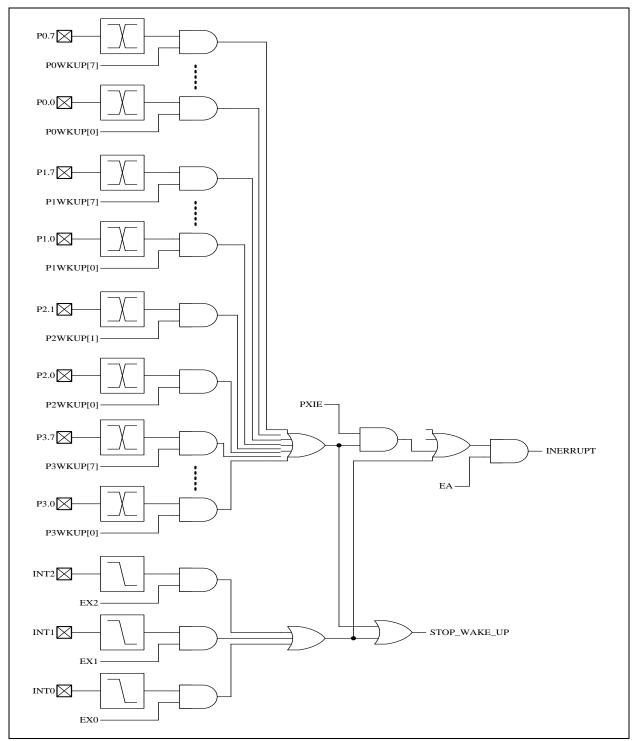
BBh.0, BAh.0 **PT3H, PT3:** Timer3 Interrupt Priority control. Definition as above.

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# 5.2 Pin Interrupt

Pin Interrupts include Change Interrupt. These pins also have the Stop mode wake up capability. INTO and INT1 are falling edge or low level triggered as the 8051 standard. INT2 is falling edge triggered and Port1 Change Interrupt is triggered by any Port1 pin state change.



Pin Interrupt & Wake up

*Note:* Chip cannot enter Stop Mode if INTn pin is low and wakeup is enabled. (INTn=0 and EXn=1, n=0~2)

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SFR 88h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TCON	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

88h.3 **IE1:** External Interrupt 1 (INT1 pin) edge flag.

Set by H/W when an INT1 pin falling edge is detected, no matter the EX1 is 0 or 1.

It is cleared automatically when the program performs the interrupt service routine.

88h.2 **IT1:** External Interrupt 1 control bit

0: Low level active (level triggered) for INT1 pin

1: Falling edge active (edge triggered) for INT1 pin

88h.1 **IE0:** External Interrupt 0 (INT0 pin) edge flag

Set by H/W when an INT0 pin falling edge is detected, no matter the EX0 is 0 or 1.

It is cleared automatically when the program performs the interrupt service routine.

88h.0 **IT0:** External Interrupt 0 control bit

0: Low level active (level triggered) for INT0 pin

1: Falling edge active (edge triggered) for INT0 pin

SFR 95h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	_	_	_	ADIF	_	IE2	PXIF	TF3
R/W	_	_	_	R/W	_	R/W	R/W	R/W
Reset	_	_	_	()	_	0	0	()

95h.2 **IE2:** External Interrupt 2 (INT2 pin) edge flag

Set by H/W when a falling edge is detected on the INT2 pin, no matter the EX2 is 0 or 1.

It is cleared automatically when the program performs the interrupt service routine.

S/W can write FBh to INTFLG to clear this bit. (*Note1*)

95h.1 **PXIF:** Port0~Port3 pin change interrupt flag

Set by H/W when Port0~Port3 pin state change is detected and its interrupt enable bit is set (P0WKUP/P1WKUP/P2WKUP/P3WKUP). PXIE does not affect this flag's setting.

It is cleared automatically when the program performs the interrupt service routine.

S/W can write FDh to INTFLG to clear this bit. (*Note1*)

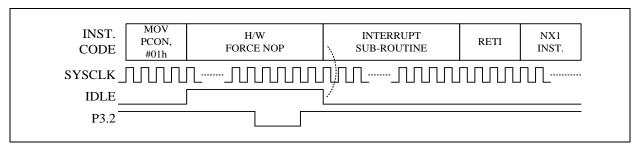
Note1: S/W can write 0 to clear a flag in the INTFLG, but writing 1 has no effect.

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### 5.3 Idle mode Wake up and Interrupt

Idle mode is waked up by enabled Interrupts, which means individual interrupt enable bit (ex: EX0) and EA bit must be both set to 1 to establish Idle mode wake up capability. All enabled Interrupts (Pins, Timers, ADC, TK, SPI and UARTs) can wake up CPU from Idle mode. Upon Idle wake-up, Interrupt service routine is entered immediately. "The first instruction behind IDL (PCON.0) setting" is executed after interrupt service routine return.



EA=EX0=1, Idle mode wake-up and Interrupt by P3.2 (INT0)

SFR 87h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PCON	SMOD		_	_	GF1	GF0	PD	IDL
R/W	R/W		_	_	R/W	R/W	R/W	R/W
Reset	0	_	_	_	0	0	0	0

87h.1 **PD:** Power down control bit, set 1 to enter STOP mode.

87h.0 **IDL:** Idle mode control bit, set 1 to enter IDLE mode.

### 5.4 Stop mode Wake up and Interrupt

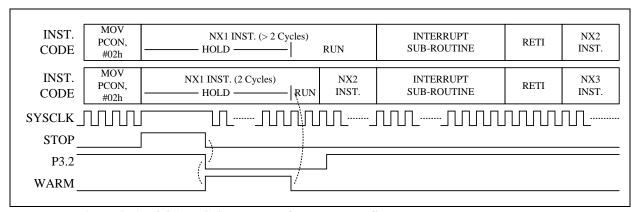
Stop mode wake up is simple, as long as the individual pin interrupt enable bit (ex: EX0) is set, the pin wake up capability is asserted. Set EX0/EX1/EX2 can enable INT0/INT1/INT2 pins' Stop mode wake up capability. Set P0WKUP/P1WKUP/P2WKUP/P3WKUP can enable Port0~Port3 Stop mode wake up capability. Upon Stop wake up, "the first instruction behind PD setting (PCON.1)" is executed immediately before Interrupt service. Interrupt entry requires EA=1 (PxWKUP also needs PXIE=1) and trigger state of the pin staying sufficiently long to be observed by the System clock. This feature allows CPU to enter or not enter Interrupt sub-routine after Stop mode wake up.

*Note:* It is recommended to place the NX1/NX2 with NOP Instruction in figures below.

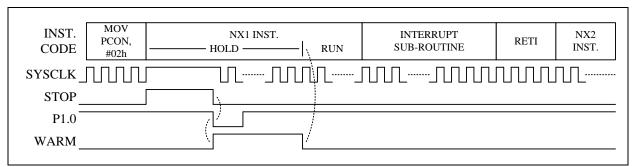
*Note:* Chip cannot enter Stop Mode if INTn pin is low and wakeup is enabled. (INTn=0 and EXn=1, n=0~2)

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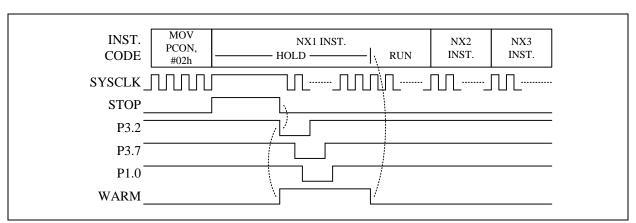




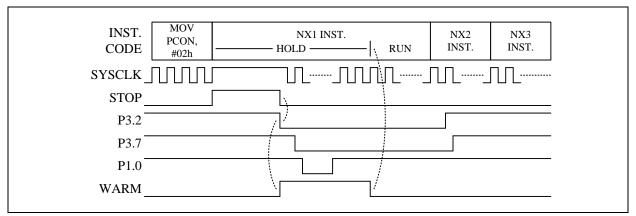
EA=EX0=1, P3.2 (INT0) is sampled after warm-up, Stop mode wake-up and Interrupt



EA=P1IE=P1WKUP=1, P1.0 change (not need clock sample), Stop mode wake-up and Interrupt



EA=EX0=EX2=P1WKUP=1, P1IE=0, Stop mode wake-up but not Interrupt. P3.2/P3.7 pulse too narrow



EX0=EX2=P1WKUP=P1IE=1, EA=0, Stop mode wake-up but not Interrupt

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### 6. I/O Ports

The Chip has total 26 multi-function I/O pins. All I/O pins follow the standard 8051 "Read-Modify-Write" feature. The instructions that read the SFR rather than the Pin State are the ones that read a port or port bit value, possibly change it, and then rewrite it to the SFR (ex: ANL P1, A; INC P2; CPL P3.0).

### Port1 & P2.1~P2.0 & Port 3

These pins can operate in four different modes as below.

Mode	Port1, P2.1~P2.0, Po	ort3 pin function	Px.n SFR	Pin State	Resistor	Digital
Mode	P3.0~P3.2	Others	data	r III State	Pull-up	Input
Mode 0	Pseudo	On on Duoin	0	Drive Low	N	N
Mode 0	Open Drain	Open Drain	1	Pull-up	Y	Y
Mada 1	Pseudo	On on Duoin	0	Drive Low	N	N
Mode 1	Open Drain	Open Drain	1	Hi-Z	N	Y
Mode 2	CMOS O	Autout	0	Drive Low	N	N
Mode 2	CMOS Output		1	Drive High	N	N
Mode 3	Analog input for ADC, digital input		X		N	N
wide 3	buffer is disabled			_	1N	14

I/O Pin Function Table

If a Port1, P2.1~P2.0 or Port3 pin is used for Schmitt-trigger input, S/W must set the I/O pin to Mode0 or Mode1 and set the corresponding Port Data SFR to 1 to disable the pin's output driving circuitry.

Beside I/O port function, each Port1, P2.1~P2.0 and Port3 pin has one or more alternative functions, such as ADC. Most of the functions are activated by setting the individual pin mode control SFR to Mode3. Port1/Port3 pins have standard 8051 auxiliary definition such as INTO/1, T0/1/2, or RXD/TXD. These pin functions need to set the pin mode SFR to Mode0 or Mode1 and keep the P1.n/P3.n SFR at 1.

Pin Name	8051	Wake-up	CKO	ADC	PWM	LCD	others	Mode3
P1.0	T2	Y	T2O	AD2	PWM3			AD2
P1.1	T2EX	Y		AD3	PWM2			AD3
P1.2		Y			PWM1	LCDC0		
P1.3		Y			PWM6	LCDC1	SCL	
P1.4		Y			PWM5	LCDC2		
P1.5		Y			PWM4	LCDC3		
P1.6		Y					SDA/TXD	
P1.7		Y		AD9				AD9
P3.0	RXD	Y		AD6				AD6
P3.1	TXD	Y		AD7				AD7
P3.2	INT0	Y		AD5			VBGO	AD5
P3.3	INT1	Y		AD4				AD4
P3.4	T0	Y	T0O	AD8	PWM3			AD8
P3.5	T1	Y	T10		PWM0P		SDA	
P3.6		Y			PWM0N PWM2 PWM4			
P3.7	INT2	Y					RSTn	
P2.0		Y						
P2.1		Y					_	

Port1, P2.1~P2.0, Port3 multi-function Table

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The necessary SFR setting for Port1/P2.1~P2.0/Port3 pin's alternative function is list below.

Alternative Function	Mode	Px.n SFR data	Pin State	Other necessary SFR setting
T0, T1, T2, T2EX,	0	1	Input with Pull-up	
INT0, INT1, INT2	1	1	Input	
RXD, TXD	0	1	Input with Pull-up / Pseudo Open Drain Output	TXRXSEL
KAD, IAD	1	1	Input / Pseudo Open Drain Output	IAKASEL
SCL	0	X	I <sup>2</sup> C Clock Output (Open Drain Output, Pull-up)	MSCLSEL
(I <sup>2</sup> C Master)	2	X	I <sup>2</sup> C Clock Output (CMOS Push-Pull)	MISCLSEL
SDA (I <sup>2</sup> C Master)	0	1	I <sup>2</sup> C DATA (Pull-up)	MSDASEL
	0	X	Clock Open Drain Output with Pull-up	T0OE
T0O, T1O, T2O	1	X	Clock Open Drain Output	T1OE
	2	X	Clock Output (CMOS Push-Pull)	T2OE
VBGO	X	X	Bandgap Voltage output	VBGOUT
LCDC0~ LCDC3	X	X	1/2 Bias Output	P1LOE
AD0~AD11	3	X	ADC Channel	
	0	X	PWM Open Drain Output with Pull-up	PWMOE0
PWM0~PWM6	1	X	PWM Open Drain Output	PWMOE1
	2	X	PWM Output (CMOS Push-Pull)	PWMOE2

Mode Setting for Port1, P2.1~P2.0, Port3 Alternative Function

For tables above, a "CMOS Output" pin means it can sink and drive at least 4 mA current. It is not recommended to use such pin as input function.

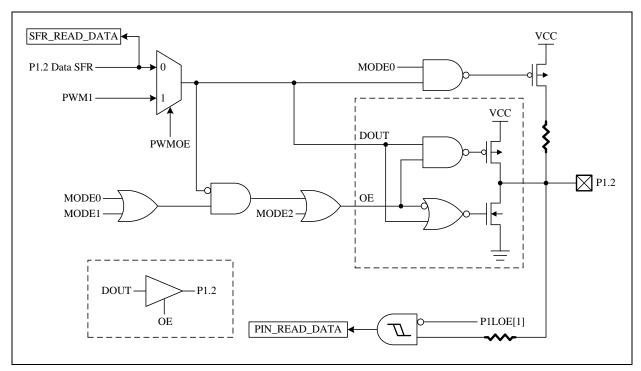
An "**Open Drain**" pin means it can sink at least 4 mA current but only drive a small current ( $<20 \,\mu\text{A}$ ). It can be used as input or output function and typically needs an external pull up resistor.

An 8051 standard pin is a "**Pseudo Open Drain**" pin. It can sink at least 4 mA current when output is at low level, and drives at least 4 mA current for  $1\sim2$  clock cycle when output transits from low to high, then keeps driving a small current ( $<20~\mu A$ ) to maintain the pin at high level. It can be used as input or output function.

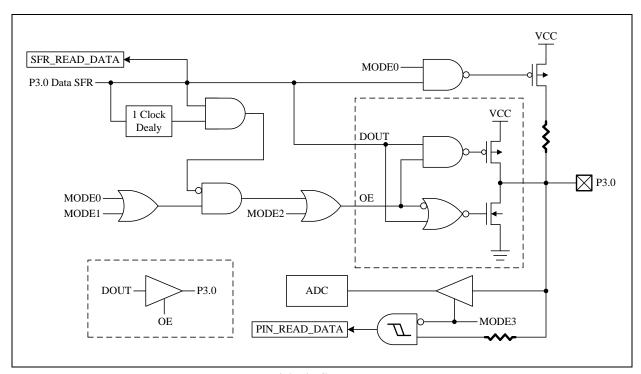
**Note2:** for the necessary SFR setting above, LCD/LED pin has the highest priority. Therefore, if a pin is not used for Segment (ex: pin is I/O, ADC, TK, and SPI...), S/W must disable the LCD/LED function.

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P1.2 Pin Structure



P3.0 Pin Structure

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SFR <b>90h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1	P1.7	P1.6	P1.5	P1.4	P1.3	P1.2	P1.1	P1.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

90h.7~0 **P1:** Port1 data

SFR A0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P2	P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

A0h.1~0 **P2.1~P2.0:** P2.1~P2.0 data

SFR B0h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Р3	P3.7	P3.6	P3.5	P3.4	P3.3	P3.2	P3.1	P3.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

B0h.7~0 **P3:** Port1 data

SFR F7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX2	WD	TE	PWRSAV	VBGOUT	DIV32	IAI	PTE	MULDIV16
R/W	R/W	R/W	R/W	R/W	R/W	R/	W	R/W
Reset	0	0	0	0	0	1	1	0

F7h.4 **VBGOUT:** Bandgap voltage output control

0: Disable

1: Bandgap voltage output to P3.2 pin

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SFR 92h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1LOE	_	_	_	_	P1LOE3	P1LOE2	P1LOE1	P1LOE0
R/W	_	_	_	_	R/W	R/W	R/W	R/W
Reset	_	_	_	_	0	0	0	0

92h.3 **P1LOE3:** LCD 1/2 bais Output

0: Disable

1: P15 as LCD 1/2 bais Output

92h.2 **P1LOE2:** LCD 1/2 bais Output

0: Disable

1: P14 as LCD 1/2 bais Output

92h.1 **P1LOE1:** LCD 1/2 bais Output

0: Disable

1: P13 as LCD 1/2 bais Output

92h.0 **P1LOE0:** LCD 1/2 bais Output

0: Disable

1: P12 as LCD 1/2 bais Output

SFR 93h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	TXRXSEL	T2OE	T1OE	T0OE	P2M	OD1	P2M	OD0
R/W	R/W	R/W	R/W	R/W	R/	W	R/	W
Reset	0	0	0	0	0	1	0	1

93h.7 **TXRXSEL:** UART TXD/RXD pin select

0: P31 as TXD, P30 as RXD

1: P16 as TXD, P02 as RXD

93h.6 **T2OE:** Timer2 signal output (T2O) control

0: Disable "Timer2 overflow divided by 2" output to P1.0 pin

1: Enable "Timer2 overflow divided by 2" output to P1.0 pin

93h.5 **T10E:** Timer1 signal output (T10) control

0: Disable "Timer1 overflow divided by 2" output to P3.5 pin

1: Enable "Timer1 overflow divided by 2" output to P3.5 pin

93h.4 **T0OE:** Timer0 signal output (T0O) control

0: Disable "Timer0 overflow divided by 64" output to P3.4 pin

1: Enable "Timer0 overflow divided by 64" output to P3.4 pin

93h.3~2 **P2MOD1:** P2.1 pin control

00: Mode0

01: Mode1

10: Mode2

11: not defined

93h.1~0 **P2MOD0:** P2.0 pin control

00: Mode0

01: Mode1

10: Mode2

11: not defined



SFR A2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1MODL	P1M	OD3	P1M	OD2	P1MOD1		P1MOD0	
R/W	R/	W	R/	W	R/	W	R/	W
Reset	0	1	0	1	0	1	0	1

A2h.7~6 **P1MOD3:** P1.3 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3

A2h.5~4 **P1MOD2:** P1.2 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3

A2h.3~2 **P1MOD1:** P1.1 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.1 is ADC input

A2h.1~0 **P1MOD0:** P1.0 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.0 is ADC input

SFR A3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
P1MODH	P1M	OD7	P1M	P1MOD6		P1MOD5		P1MOD4	
R/W	R/	W	R/	W	R/	W	R/	W	
Reset	0	1	0	1	0	1	0	1	

### A3h.7~6 **P1MOD7:** P1.7 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P1.7 is ADC input

### A3h.5~4 **P1MOD6:** P1.6 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3,

### A3h.3~2 **P1MOD5:** P1.5 pin control.

00: Mode0

01: Mode1

10: Mode2

11: Mode3

### A3h.1~0 **P1MOD4:** P1.4 pin control.

00: Mode0

01: Mode1

10: Mode2

11: Mode3



SFR A4h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
P3MODL	P3M	OD3	P3M	P3MOD2		P3MOD1		P3MOD0	
R/W	R/	W	R/	W	R/	W	R/	W	
Reset	0	1	0	1	0	1	0	1	

A4h.7~6 **P3MOD3:** P3.3 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.3 is ADC input

A4h.5~4 **P3MOD2:** P3.2 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.2 is ADC input

A4h.3~2 **P3MOD1:** P3.1 pin control.

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.1 is ADC input

A4h.1~0 **P3MOD0:** P3.0 pin control.

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.0 is ADC input

SFR A5h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P3MODH	P3M	OD7	P3M	OD6	P3M	OD5	P3M	OD4
R/W	R/	W	R/	W	R/	W	R/	W
Reset	0	1	0	1	0	1	0	1

A5h.7~6 **P3MOD7:** P3.7 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3

A5h.5~4 **P3MOD6:** P3.6 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3

A5h.3~2 **P3MOD5:** P3.5 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3

A5h.1~0 **P3MOD4:** P3.4 pin control

00: Mode0

01: Mode1

10: Mode2

11: Mode3, P3.4 is ADC input

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SFR A6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE0	PWM1OE3	PWM1OE2	PWM10E1	PWM1OE0	PWM0NOE1	PWM0POE1	PWM0NOE0	PWM0POE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

A6h.7 **PWM10E3:** PWM1 output control

0: Disable 1: PWM1 enable and output to P1.2

A6h.6 **PWM10E2:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.6

A6h.5 **PWM10E1:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.4

A6h.4 **PWM10E0:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.2

A6h.3 **PWM0NOE1:** PWM0N output control

0: Disable 1: PWM0N enable and output to P3.6

A6h.2 **PWM0POE1:** PWM0P output control

0: Disable 1: PWM0P enable and output to P3.5

A6h.1 **PWM0NOE0:** PWM0N output control

0: Disable 1: PWM0N enable and output to P0.4

A6h.0 **PWM0POE0:** PWM0P output control

0: Disable 1: PWM0P enable and output to P0.3

SFR <b>B6h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE1	PWM4OE3	PWM4OE2	PWM4OE1	PWM4OE0	PWM3OE1	PWM3OE0	PWM2OE1	PWM2OE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

B6h.7 **PWM4OE3:** PWM4 output control

0: Disable 1: PWM4 enable and output to P3.6

B6h.6 **PWM4OE2:** PWM4 output control

0: Disable 1: PWM4 enable and output to P1.5

B6h.5 **PWM4OE1:** PWM4 output control

0: Disable 1: PWM4 enable and output to P0.4

B6h.4 **PWM4OE0:** PWM4 output control

0: Disable 1: PWM4 enable and output to P0.0

B6h.3 **PWM3OE1:** PWM3 output control

0: Disable 1: PWM3 enable and output to P3.4

B6h.2 **PWM3OE0:** PWM3 output control

0: Disable 1: PWM3 enable and output to P1.0

B6h.1 **PWM2OE1:** PWM2 output control

0: Disable 1: PWM2 enable and output to P3.6

B6h.0 **PWM2OE0:** PWM2 output control

0: Disable 1: PWM2 enable and output to P1.1



SFR B7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE2	<b>MSDASEL</b>	MSCLSEL	PWM6OE2	PWM6OE1	PWM6OE0	PWM5OE2	PWM5OE1	PWM5OE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

B7h.7 **MSDASEL:** Master I<sup>2</sup>C SDA select

0: P3.5 as Master I<sup>2</sup>C SDA

1: P1.6 as Master I<sup>2</sup>C SDA

B7h.6 **MSCLSEL:** Master I<sup>2</sup>C SCL select

0: P1.3 as Master I<sup>2</sup>C SCL

1: P0.2 as Master I<sup>2</sup>C SCL

B7h.5 **PWM6OE2:** PWM6 output control

0: Disable 1: PWM6 enable and output to P1.3

B7h.4 **PWM6OE1:** PWM6 output control

0: Disable 1: PWM6 enable and output to P0.7

B7h.3 **PWM6OE0:** PWM6 output control

0: Disable 1: PWM6 enable and output to P0.3

B7h.2 **PWM5OE2:** PWM5 output control

0: Disable 1: PWM5 enable and output to P1.4

B7h.1 **PWM5OE1:** PWM5 output control

0: Disable 1: PWM5 enable and output to P0.6

B7h.0 **PWM5OE0:** PWM5 output control

0: Disable 1: PWM5 enable and output to P0.1



# Port0

These pins are shared with ADC, LCD. If a Port0 is defined as I/O pin, it can be used as CMOS push-pull output or Schmitt-trigger input. The pin's pull up function is enable while SFR bit P0OE.n=0 and P0.n=1.

Port0 pin function	P0OE.n	P0.n SFR data	Pin State	Resistor Pull-up	Digital Input
Innut	0	0	Hi-Z	N	Y
Input	0	1	Pull-up	Y	Y
CMOS Output	1	0	Drive Low	N	N
CMOS Output	1	1	Drive High	N	N

**Port0 Pin Function Table** 

Pin Name	Wake-up	ADC	PWM	Others
P0.0	Y		PWM4	
P0.1	Y		PWM5	
P0.2	Y		PWM1	RXD/SCL
P0.3	Y	AD1	PWM0P/PWM6	
P0.4	Y	AD0	PWM0N/PWM1/PWM4	
P0.5	Y	AD11		
P0.6	Y		PWM1/PWM5	
P0.7	Y	AD10	PWM6	

**Port0 multi-function Table** 

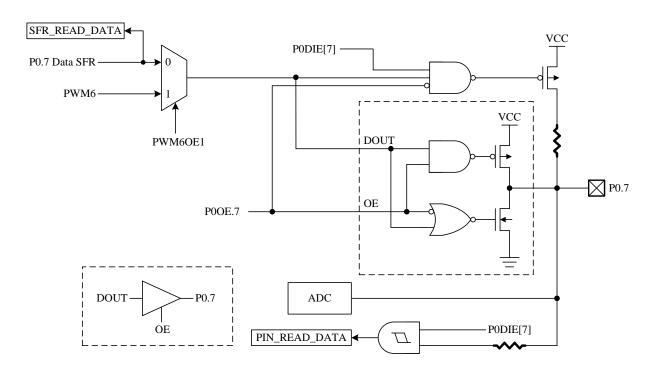
The necessary SFR setting for Port0 pin's alternative function is list below.

Alternative Function	PxOE.n	Px.n SFR data	Pin State	other necessary SFR setting
RXD	RXD 0 1 Input with Pull-up		TXRXSEL	
SCL (I <sup>2</sup> C Master)	0	X	I <sup>2</sup> C Clock Output (Open Drain Output, Pull-up) I <sup>2</sup> C Clock Output (CMOS Push-Pull)	MSCLSEL
AD0/AD1/AD10/AD11	0	0	ADC Channel	PODIE
PWM0~PWM6	0	X	PWM Open Drain Output	PWMOE0 PWMOE1
1 W WIO~F W WIO	1	X	PWM Output (CMOS Push-Pull)	PWMOE2

**Mode Setting for Port0 Alternative Function Table** 

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**P0.7 Pin Structure** 

SFR 80h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P0	P0.7	P0.6	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

80h.7~0 **P0:** Port0 data, also controls the P0.n pin's pull-up function. If the P0.n SFR data is "1" and the corresponding P0OE.n = 0 (input mode), the pull-up is enabled.

SFR 91h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
POOE		POOE								
R/W		R/W								
Reset	0	0 0 0 0 0 0 0								

91h.7~0 **POOE:** Port0 CMOS Push-Pull output enable control

0: Disable 1: Enable

SFR 93h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	TXRXSEL	T2OE	T10E	T00E	P2M	OD1	P2M	OD0
R/W	R/W	R/W	R/W	R/W	R/	W	R/	W
Reset	0	0	0	0	0	1	0	1

93h.7 **TXRXSEL:** UART TXD/RXD pin select

0: P31 as TXD, P30 as RXD

1: P16 as TXD, P02 as RXD

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SFR AFh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PODIE	P0DIE7	P0DIE6	P0DIE5	P0DIE4	P0DIE3	P0DIE2	P0DIE1	P0DIE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

AFh.7 **P0DIE7:** Port digital input enable

0: P0.7 is ADC input and disabledigital input

1: enable P0.7 digital input

AFh.6 **P0DIE6:** Port digital input enable

0: disable P0.6 digital input

1: enable P0.6 digital input

AFh.5 **P0DIE5:** Port digital input enable

0: P0.5 is ADC input and disable digital input

1: enable P0.5 digital input

AFh.4 **P0DIE4:** Port digital input enable

0: P0.4is ADC input and disable digital input

1: enable P0.4 digital input

AFh.3 **P0DIE3:** Port digital input enable

0: P0.3 is ADC input and disable digital input

1: enable P0.3 digital input

AFh.2 **PODIE2:** Port digital input enable

0: disable P0.2 digital input

1: enable P0.2 digital input

AFh.1 **P0DIE1:** Port digital input enable

0: disable P0.1 digital input

1: enable P0.1 digital input

AFh.0 **P0DIE0:** Port digital input enable

0: disable P0.0 digital input

1: enable P0.0 digital input



SFR A6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE0	PWM1OE3	PWM1OE2	PWM10E1	PWM1OE0	PWM0NOE1	PWM0POE1	PWM0NOE0	PWM0POE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

A6h.7 **PWM10E3:** PWM1 output control

0: Disable 1: PWM1 enable and output to P1.2

A6h.6 **PWM10E2:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.6

A6h.5 **PWM10E1:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.4

A6h.4 **PWM10E0:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.2

A6h.3 **PWM0NOE1:** PWM0N output control

0: Disable 1: PWM0N enable and output to P3.6

A6h.2 **PWM0POE1:** PWM0P output control

0: Disable 1: PWM0P enable and output to P3.5

A6h.1 **PWM0NOE0:** PWM0N output control

0: Disable 1: PWM0N enable and output to P0.4

A6h.0 **PWM0POE0:** PWM0P output control

0: Disable 1: PWM0P enable and output to P0.3

SFR <b>B6h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE1	PWM4OE3	PWM4OE2	PWM4OE1	PWM4OE0	PWM3OE1	PWM3OE0	PWM2OE1	PWM2OE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

B6h.7 **PWM4OE3:** PWM4 output control

0: Disable 1: PWM4 enable and output to P3.6

B6h.6 **PWM4OE2:** PWM4 output control

0: Disable 1: PWM4 enable and output to P1.5

B6h.5 **PWM4OE1:** PWM4 output control

0: Disable 1: PWM4 enable and output to P0.4

B6h.4 **PWM4OE0:** PWM4 output control

0: Disable 1: PWM4 enable and output to P0.0

B6h.3 **PWM3OE1:** PWM3 output control

0: Disable 1: PWM3 enable and output to P3.4

B6h.2 **PWM3OE0:** PWM3 output control

0: Disable 1: PWM3 enable and output to P1.0

B6h.1 **PWM2OE1:** PWM2 output control

0: Disable 1: PWM2 enable and output to P3.6

B6h.0 **PWM2OE0:** PWM2 output control

0: Disable 1: PWM2 enable and output to P1.1



SFR B7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE2	<b>MSDASEL</b>	MSCLSEL	PWM6OE2	PWM6OE1	PWM6OE0	PWM5OE2	PWM5OE1	PWM5OE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

B7h.7 **MSDASEL:** Master I<sup>2</sup>C SDA select

0: P3.5 as Master I<sup>2</sup>C SDA

1: P1.6 as Master I<sup>2</sup>C SDA

B7h.6 **MSCLSEL:** Master I<sup>2</sup>C SCL select

0: P1.3 as Master I<sup>2</sup>C SCL

1: P0.2 as Master I<sup>2</sup>C SCL

B7h.5 **PWM6OE2:** PWM6 output control

0: Disable 1: PWM6 enable and output to P1.3

B7h.4 **PWM6OE1:** PWM6 output control

0: Disable 1: PWM6 enable and output to P0.7

B7h.3 **PWM6OE0:** PWM6 output control

0: Disable 1: PWM6 enable and output to P0.3

B7h.2 **PWM5OE2:** PWM5 output control

0: Disable 1: PWM5 enable and output to P1.4

B7h.1 **PWM5OE1:** PWM5 output control

0: Disable 1: PWM5 enable and output to P0.6

B7h.0 **PWM5OE0:** PWM5 output control

0: Disable 1: PWM5 enable and output to P0.1

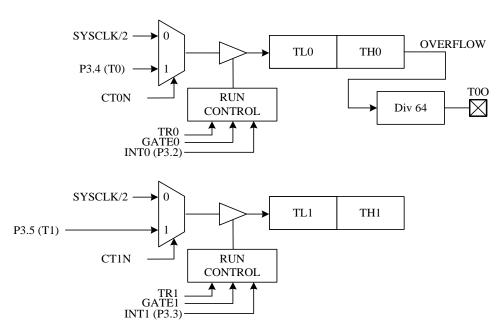


### 7. Timers

Timer0, Timer1 and Timer2 are provided as standard 8051 compatible timer/counter. Compare to the traditional 12T 8051, the Chip's Timer0/1/2 use 2 System clock cycle as the time base unit. That is, in timer mode, these timers increase at every "2 System clock" rate; in counter mode, T0/T1/T2 pin input pulse must be wider than 2 System clock to be seen by this device. In addition to the standard 8051 timers function. The T0O pin can output the "Timer0 overflow divided by 64" signal, and the T2O pin can output the "Timer2 overflow divided by 2" signal.

### Timer0 / Timer1

TCON and TMOD are used to set the mode of operation and to control the running and interrupt generation of the Timer0/1, with the timer/counter values stored in two pairs of 8-bit registers (TL0, TH0, and TL1, TH1).



Timer0 and Timer1 Structure

SFR <b>88h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TCON	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

88h.7 **TF1:** Timer1 overflow flag

Set by H/W when Timer/Counter 1 overflows

Cleared by H/W when CPU vectors into the interrupt service routine.

88h.6 **TR1:** Timer1 run control

0: Timer1 stops1: Timer1 runs

88h.5 **TF0:** Timer0 overflow flag

Set by H/W when Timer/Counter 0 overflows

Cleared by H/W when CPU vectors into the interrupt service routine.

88h.4 **TR0:** Timer0 run control

0: Timer0 stops 1: Timer0 runs

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SFR 89h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
TMOD	GATE1	CT1N	TMOD1		GATE0	CT0N	TM	OD0
R/W	R/W	R/W	R/W		R/W	R/W	R/	W
Reset	0	0	0	0	0	0	0	0

89h.7 **GATE1:** Timer1 gating control bit

0: Timer1 enable when TR1 bit is set

1: Timer1 enable only while the INT1 pin is high and TR1 bit is set

89h.6 **CT1N:** Timer1 Counter/Timer select bit

0: Timer mode, Timer1 data increases at 2 System clock cycle rate

1: Counter mode, Timer1 data increases at T1 pin's negative edge

89h.5~4 **TMOD1:** Timer1 mode select

00: 8-bit timer/counter (TH1) and 5-bit prescaler (TL1)

01: 16-bit timer/counter

10: 8-bit auto-reload timer/counter (TL1). Reloaded from TH1 at overflow.

11: Timer1 stops

89h.3 **GATE0:** Timer0 gating control bit

0: Timer0 enable when TR0 bit is set

1: Timer0 enable only while the INT0 pin is high and TR0 bit is set

89h.2 **CT0N:** Timer0 Counter/Timer select bit

0: Timer mode, Timer0 data increases at 2 System clock cycle rate

1: Counter mode, Timer0 data increases at T0 pin's negative edge

89h.1~0 **TMOD0:** Timer0 mode select

00: 8-bit timer/counter (TH0) and 5-bit prescaler (TL0)

01: 16-bit timer/counter

10: 8-bit auto-reload timer/counter (TL0). Reloaded from TH0 at overflow.

11: TL0 is an 8-bit timer/counter. TH0 is an 8-bit timer/counter using Timer1's TR1 and TF1 bits.

SFR 8Ah	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TL0		TL0							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

8Ah.7~0 **TL0:** Timer0 data low byte

SFR 8Bh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TL1		TL1							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

8Bh.7~0 **TL1:** Timer1 data low byte

SFR 8Ch	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TH0		TH0							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

8Ch.7~0 **TH0:** Timer0 data high byte

SFR <b>8Dh</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
TH1		TH1								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

8Dh.7~0 **TH1:** Timer1 data high byte

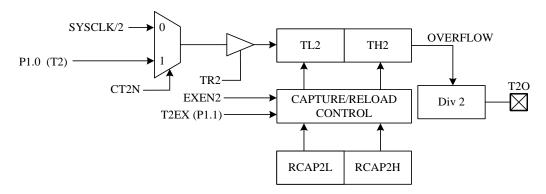
Note: See also Chapter 6 for more information on Timer0/1 interrupt enable and priority.

*Note*: See also Chapter 7 for details on T0O pin output settings.



### Timer2

Timer2 is controlled through the TCON2 register with the low and high bytes of Timer/Counter2 stored in TL2 and TH2 and the low and high bytes of the Timer2 reload/capture registers stored in RCAP2L and RCAP2H.



**Timer2 Structure** 

SFR C8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
T2CON	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	CT2N	CPRL2N
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

C8h.7 **TF2:** Timer2 overflow flag

Set by H/W when Timer/Counter 2 overflows unless RCLK=1 or TCLK=1. This bit must be cleared by S/W.

C8h.6 **EXF2:** T2EX interrupt pin falling edge flag

Set when a capture or a reload is caused by a negative transition on T2EX pin if EXEN2=1. This bit must be cleared by S/W.

C8h.5 **RCLK:** UART receive clock control bit

0: Use Timer1 overflow as receive clock for serial port in mode 1 or 3

1: Use Timer2 overflow as receive clock for serial port in mode 1 or 3

C8h.4 TCLK: UART transmit clock control bit

0: Use Timer1 overflow as transmit clock for serial port in mode 1 or 3

1: Use Timer2 overflow as transmit clock for serial port in mode 1 or 3

C8h.3 **EXEN2:** T2EX pin enable

0: T2EX pin disable

1: T2EX pin enable, it cause a capture or reload when a negative transition on T2EX pin is detected if RCLK=TCLK=0

C8h.2 **TR2:** Timer2 run control

0: Timer2 stops

1: Timer2 runs

C8h.1 CT2N: Timer2 Counter/Timer select bit

0: Timer mode, Timer2 data increases at 2 System clock cycle rate

1: Counter mode, Timer2 data increases at T2 pin's negative edge

C8h.0 CPRL2N: Timer2 Capture/Reload control bit

0: Reload mode, auto-reload on Timer2 overflows or negative transitions on T2EX pin if EXEN2=1.

1: Capture mode, capture on negative transitions on T2EX pin if EXEN2=1.

If RCLK=1 or TCLK=1, CPRL2N is ignored and timer is forced to auto-reload on Timer2 overflow.



SFR CAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
RCP2L		RCP2L							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

CAh.7~0 RCP2L: Timer2 reload/capture data low byte

SFR CBh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
RCP2H		RCP2H							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

CBh.7~0 RCP2H: Timer2 reload/capture data high byte

SFR CCh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TL2		TL2							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

CCh.7~0 **TL2:** Timer2 data low byte

SFR CDh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
TH2		TH2							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

CDh.7~0 **TH2:** Timer2 data high byte

Note: See also Chapter 6 for more information on Timer2 interrupt enable and priority.

Note: See also Chapter 7 for details on T2O pin output settings.

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### Timer3

Timer3 works as a time-base counter, which generates interrupts periodically. It generates an interrupt flag (TF3) with the clock divided by 32768, 16384, 8192, or 128 depending on the TM3PSC SFR.

SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	_	WDTPSC		ADCKS		TM3	PSC
R/W	R/W		R/	R/W		W	R/	W
Reset	0	_	0	0	0	0	0	0

94h.1~0 **TM3PSC:** Timer3 Interrupt rate

00: Timer3 Interrupt rate is 32768 Slow clock cycle 01: Timer3 Interrupt rate is 16384 Slow clock cycle 10: Timer3 Interrupt rate is 8192 Slow clock cycle 11: Timer3 Interrupt rate is 128 Slow clock cycle

SFR <b>95h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	_	_	_	ADIF	_	IE2	PXIF	TF3
R/W	_		_	R/W		R/W	R/W	R/W
Reset	_	_	_	0	_	0	0	0

95h.0 **TF3:** Timer3 Interrupt Flag

Set by H/W when Timer3 reaches TM3PSC setting cycles. Cleared automatically when the program performs the interrupt service routine. S/W can write FEh to INTFLG to clear this bit. (*Note1*)

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	VBGEN	ADSOC	CLRPWM0	CLRPWM1	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	R/W
Reset	0	0	0	0	1	1	_	0

F8h.6 **CLRTM3:** Set 1 to clear Timer3, H/W auto clear it at next clock cycle.

Note: also refer to Section 6 for more information about Timer3 Interrupt enable and priority.

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# T0O, T1O and T2O Output Control

This device can generate various frequency waveform pin output (in CMOS or Open-Drain format) for Buzzer. The T0O and T2O waveform is divided by Timer0/Timer2 overflow signal. The T0O waveform is Timer0 overflow divided by 64, and T2O waveform is Timer2 overflow divided by 2. User can control their frequency by Timers auto reload speed. Set T0OE and T2OE SFRs can output these waveforms.

SFR 93h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	TXRXSEL	T2OE	T1OE	T0OE	P2MOD1		P2MOD0	
R/W	R/W	R/W	R/W	R/W	R/W		R/	W
Reset	0	0	0	0	0	1	0	1

93h.6 **T2OE:** Timer2 signal output (T2O) control

0: Disable "Timer2 overflow divided by 2" output to P1.0 pin

1: Enable "Timer2 overflow divided by 2" output to P1.0 pin

93h.5 **T10E:** Timer1 signal output (T10) control

0: Disable "Timer1 overflow divided by 2" output to P3.5 pin

1: Enable "Timer1 overflow divided by 2" output to P3.5 pin

93h.4 **T0OE:** Timer0 signal output (T0O) control

0: Disable "Timer0 overflow divided by 64" output to P3.4 pin

1: Enable "Timer0 overflow divided by 64" output to P3.4 pin

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### 8. UART

The UART uses SCON and SBUF SFRs. SCON is the control register, SBUF is the data register. Data is written to SBUF for transmission and SBUF is read to obtain received data. The received data and transmitted data registers are completely independent. In addition to standard 8051's full duplex mode, this chip also provides one wire mode. If the UART1W bit is set, both transmit and receive data use P3.1 pin.

SFR <b>87h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PCON	SMOD	_	_	_	GF1	GF0	PD	IDL
R/W	R/W	_	_	_	R/W	R/W	R/W	R/W
Reset	0	_			0	0	0	0

87h.7 **SMOD:** UART double baud rate control bit

0: Disable UART double baud rate1: Enable UART double baud rate

SFR 93h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PINMOD	TXRXSEL	T2OE	T10E	T00E	P2M	OD1	P2M	OD0
R/W	R/W	R/W	R/W	R/W	R/W		R/	W
Reset	0	0	0	0	0	1	0	1

93h.7 **TXRXSEL:** UART TXD/RXD pin select

0: P31 as TXD, P30 as RXD 1: P16 as TXD, P02 as RXD

SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	-	WDTPSC		ADCKS		TM3PSC	
R/W	R/W	-	R/W		R/W		R/	W
Reset	0	-	0	0	0	0	0	0

94h.7 **UART1W:** One wire UART mode enable, both TXD/RXD use P3.1 or p1.6 pin

0: Disable one wire UART mode

1: Enable one wire UART mode

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SFR 98h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
SCON	SM0	SM1	SM2	REN	TB8	RB8	TI	RI
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

98h.7~6 **SM0,SM1:** Serial port mode select bit 0,1

00: Mode0: 8 bit shift register, Baud Rate=F<sub>SYSCLK</sub>/2

01: Mode1: 8 bit UART, Baud Rate is variable

10: Mode2: 9 bit UART, Baud Rate=F<sub>SYSCLK</sub>/32 or/64

11: Mode3: 9 bit UART, Baud Rate is variable

98h.5 **SM2:** Serial port mode select bit 2

SM2 enables multiprocessor communication over a single serial line and modifies the above as follows. In Modes 2 & 3, if SM2 is set then the received interrupt will not be generated if the received ninth data bit is 0. In Mode 1, the received interrupt will not be generated unless a valid stop bit is received. In Mode 0, SM2 should be 0.

98h.4 **REN:** UART reception enable

0: Disable reception

1: Enable reception

98h.3 **TB8:** Transmit Bit 8, the ninth bit to be transmitted in Mode 2 and 3

98h.2 **RB8:** Receive Bit 8, contains the ninth bit that was received in Mode 2 and 3 or the stop bit is Mode 1 if SM2=0

98h.1 **TI:** Transmit interrupt flag

Set by H/W at the end of the eighth bit in Mode 0, or at the beginning of the stop bit in other modes. Must be cleared by S/W.

98h.0 **RI:** Receive interrupt flag

Set by H/W at the end of the eighth bit in Mode 0, or at the sampling point of the stop bit in other modes. Must be cleared by S/W.

SFR <b>99h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
SBUF		SBUF							
R/W		R/W							
Reset	_				_			_	

99h.7~0 **SBUF:** UART transmit and receive data. Transmit data is written to this location and receive data is read from this location, but the paths are independent.

F<sub>SYSCLK</sub> denotes System clock frequency, the UART baud rate is calculated as below.

### • Mode 0:

Baud Rate=F<sub>SYSCLK</sub>/2

• Mode 1, 3: if using Timer1 auto reload mode

Baud Rate=  $(SMOD + 1) \times F_{SYSCLK} / (32 \times 2 \times (256 - TH1))$ 

• Mode 1, 3: if using Timer2

Baud Rate=Timer2 overflow rate/ $16 = F_{SYSCLK}/(32 \times (65536 - RCP2H, RCP2L))$ 

# • Mode 2:

Baud Rate=  $(SMOD + 1) \times F_{SYSCLK}/64$ 

**Note:** also refer to Section 6 for more information about UART Interrupt enable and priority. **Note:** also refer to Section 8 for more information about how Timer2 controls UART clock.

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### 9. PWMs

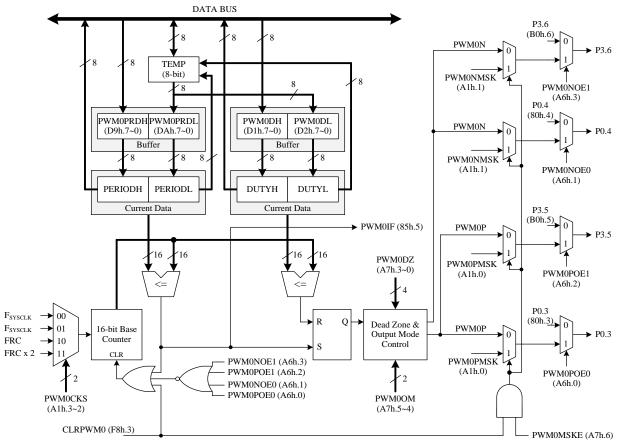
This Chip has seven 16-bit PWM modules, PWM0 to PWM6. The PWM can generate varies frequency waveform with 65536 duty resolution on the basis of the PWM clock. The PWM clock can select FRC double frequency (FRC x 2), FRC or  $F_{SYSCLK}$  as its clock source. Users should pay attention to the setting, the period of PWM must be greater than duty.

The pin mode SFR controls the PWM output waveform format. Mode1 makes the PWM open drain output and Mode2 makes the PWM CMOS push-pull output.

The 16-bit PWM0PRD, PWM1PRD and PWM0D ~ PWM6D registers all have a low and high byte structure. The high bytes can be directly accessed, but as the low bytes can only be accessed via an internal 8-bit buffer, reading or writing to these register pairs must be carried out in a specific way. The important point to notes is that data transfer to and from the 8-bit buffer and its related low byte only takes place when write or read operation to its corresponding high bytes is executed. Briefly speaking, write low byte first and then high byte; read high byte first and then low byte.

#### PWM0

The PWM0POE0 / PWM0POE1 are used to select the output for PWM0P, and the PWM0NOE0 / PWM0NOE1 are used to select the output for PWM0N. These four bits also can be PWM0 control bit. If those four bits are cleared, the PWM0 will be cleared and stopped, otherwise the PWM0 is running. The CLRPWM0 bit has the same function. When CLRPWM0 bit is set, the PWM0 will be cleared and held, otherwise the PWM0 is running. The PWM0 structure is shown as follow.



PWM0 Structure

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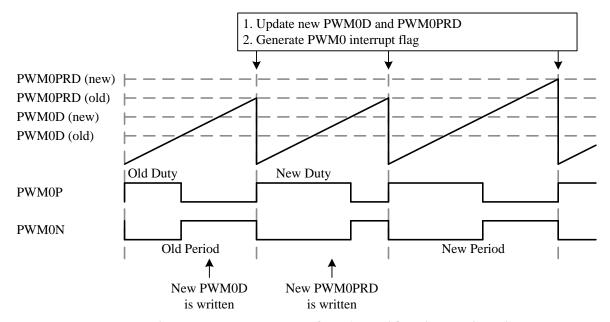


The PWM0 duty cycle can be changed by writing to PWM0DH and PWM0DL. The PWM0 output signal resets to a low level whenever the 16-bit base counter matches the 16-bit PWM0 duty register {PWM0DH, PWM0DL}. The PWM0 period can be set by writing the period value to the PWM0PRDH and PWM0PRDL registers. After writing the PWM0D or PWM0PRD register, the new values will immediately save to their own buffer. H/W will update these values at the end of current period or while PWM0 is cleared. At the end of current period, H/W will set the PWM0IF bit and generate an interrupt if a PWM0 interrupt is enabled.

The PWM0 has two operation modes, normal mode and half-bridge mode. PWM0 output signal can be output via PWM0P and PWM0N with four different modes. These two outputs are non-overlapped with time interval Tnov. Non-overlapping time interval is also named as dead zone or dead band. Tnov is determined by setting PWM0DZ bits. The value 0~15 of PWM0DZ map onto 0~15, 16 PWM0CLK cycles respectively. If PWM0DZ=0, PWM0 outputs is directly passed to PWM0P and PWM0N so that waveforms of them have the same duty cycle. Note that, if high pulse width or low pulse width of PWM0 output is shorter than Tnov, the real waveforms of these two outputs will different from the expected waveforms. If the PWM0MSKE bit is set, the outputs can be masked to force output fix signal while S/W set the CLRPWM0 bit is set by H/W.

### **Normal Mode**

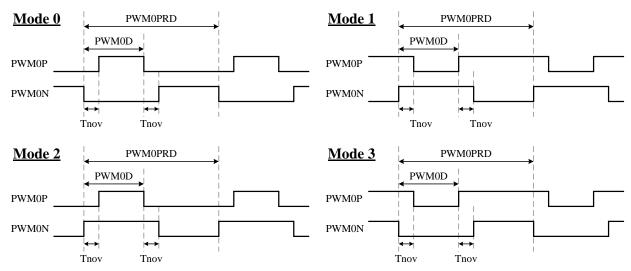
The normal mode PWM is a simple structure, which switches its output high and low at uniform repeatable intervals. The PWM0D is the output duty cycle, and the output period is PWM0PRD+1. The output waveform of PWM0 is shown below.



PWM0 normal mode output waveform (PWM0OM=0, PWM0DZ=0)

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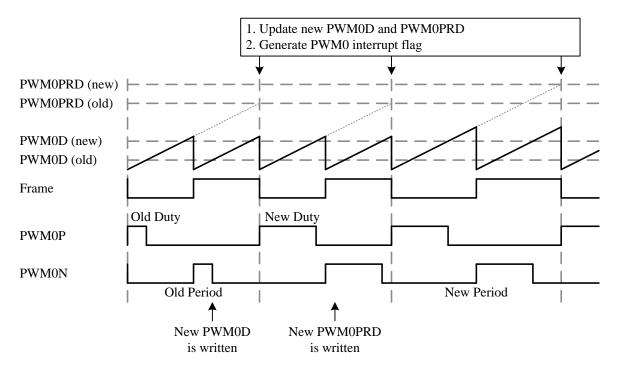




PWM0 normal mode output modes

# Half-Bridge Mode

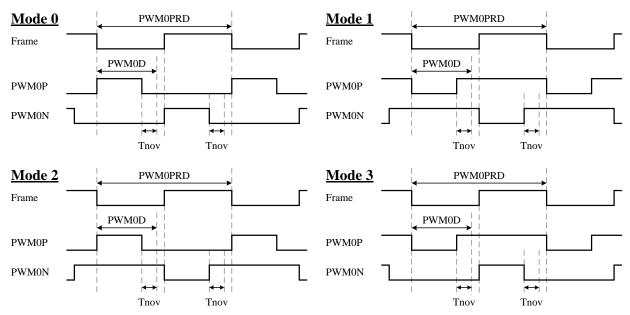
The half-bridge mode PWM is similar to the normal mode but Dead zone is prohibited in half-bridge mode (SFR PWM0DZ must be 0). It has two frames in a period, PWM0P only output in the first frame, PWM0N only output in the second frame. The width of these two frames must be same, so their width is the integer part of PWM0PRD/2. Because each output channel only output in one frame, the maximum duty cycle is same as the width of a frame. If the PWM0D is larger than PWM0PRD/2, H/W will force set the duty cycle to PWM0PRD/2. Following figure shows the output waveform and the output modes.



PWM0 half-bridge mode output waveform (PWM0OM=0, PWM0DZ=0)

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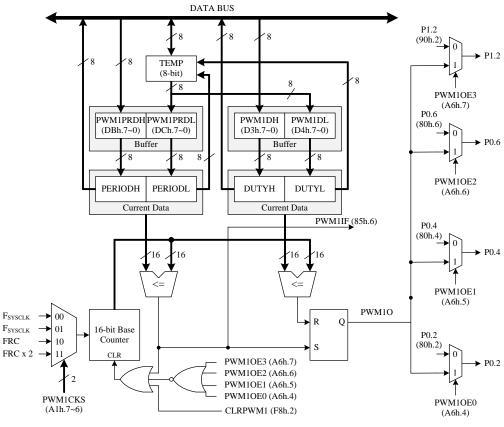




PWM0 half-bridge mode output modes

### PWM1~PWM6

The Chip has six 16-bit PWM modules PWM1~PWM6. PWM1~6 are sharing period, clock source and interrupt (PWM1IF). The following takes PWM1 as an example for description. The PWM can generate varies frequency waveform with 65536 duty resolution on the basis of the PWM clock. The PWM clock can select double frequency (FRC x 2), FRC or F<sub>SYSCLK</sub> as its clock source.



PWM0 Structure

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SFR 84h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTE2	_	PWM1IE	PWM0IE	_	_	_	_	_
R/W	_	R/W	R/W	_	_	_	_	_
Reset	_	0	0	_	_	_	_	_

84h.6 **PWM1IE:** PWM1~PWM6 interrupt enable

0: Disable PWM1~PWM6 interrupt

1: Enable PWM1~PWM6 interrupt

84h.5 **PWM0IE:** PWM0 interrupt enable

0: Disable PWM0 interrupt1: Enable PWM0 interrupt

SFR <b>85h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG2	_	PWM1IF	PWM0IF	_	_	_	_	_
R/W	_	R/W	R/W	_	_	_	_	_
Reset	_	0	0	_	_	_	_	_

85h.6 **PWM1IF:** PWM1~PWM6 interrupt flag

Set by H/W at the end of PWM1 period, S/W writes BFh to INTFLG2 to clear this flag.

85h.5 **PWM0IF:** PWM0 interrupt enable

Set by H/W at the end of PWM0 period, S/W writes DFh to INTFLG2 to clear this flag.

SFR A9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTE1	PWMIE	_	LVDIE	I2CE	ADIE	EX2	PXIE	TM3IE
R/W	R/W	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	_	0	0	0	0	0	0

A9h.7 **PWMIE:** PWM0/PWM1~PWM6 interrupt enable

0: Disable PWM0/PWM1~PWM6 interrupt

1: Enable PWM0/PWM1~PWM6 interrupt

SFR A1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
<b>PWMCON</b>	PWM	1CKS	_	_	PWM	PWM0CKS		<b>PWM0PMSK</b>
R/W	R/	W	_	_	R/W		R/W	R/W
Reset	0	0	_	_	0	0	0	0

A1h.7~6 **PWM1CKS:** PWM1~PWM6 clock source

00: F<sub>SYSCLK</sub> 01: F<sub>SYSCLK</sub>

10: FRC

11: FRCx2 (Vcc>2.7V)

A1h.3~2 **PWM0CKS:** PWM0 clock source

00: F<sub>SYSCLK</sub> 01: F<sub>SYSCLK</sub> 10: FRC

10. TKC

11: FRCx2 (Vcc>2.7V)

A1h.1 **PWM0NMSK:** PWM0N mask data while CLRPWM0=1 A1h.0 **PWM0PMSK:** PWM0P mask data while CLRPWM0=1

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SFR A6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE0	PWM10E3	PWM10E2	PWM10E1	PWM1OE0	PWM0NOE1	PWM0POE1	PWM0NOE0	PWM0POE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

A6h.7 **PWM10E3:** PWM1 output control

0: Disable 1: PWM1 enable and output to P1.2

A6h.6 **PWM10E2:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.6

A6h.5 **PWM10E1:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.4

A6h.4 **PWM10E0:** PWM1 output control

0: Disable 1: PWM1 enable and output to P0.2

A6h.3 **PWM0NOE1:** PWM0N output control

0: Disable 1: PWM0N enable and output to P3.6

A6h.2 **PWM0POE1:** PWM0P output control

0: Disable 1: PWM0P enable and output to P3.5

A6h.1 **PWM0NOE0:** PWM0N output control

0: Disable 1: PWM0N enable and output to P0.4

A6h.0 **PWM0POE0:** PWM0P output control

0: Disable 1: PWM0P enable and output to P0.3

SFR A7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMCON2	PWM0MOD	PWM0MSKE	PWM	IOOM	PWM0DZ			
R/W	R/W	R/W	R/	W	R/W			
Reset	0	0	0	0	0	0	0	0

### A7h.7 **PWM0MOD:** PWM0 mode select

0: Normal mode

1: Half-bridge mode

A7h.6 **PWM0MSKE:** PWM0 mask output enable

0: Disable

1: Enable, PWM0P/PWM0N output data by PWM0PMSK/PWM0NMSK while CLRPWM0=1

A7h.5~4 **PWM0OM:** PWM0 output mode select

00: Mode0

01: Mode1

10: Mode2

11: Mode3

A7h.3~0 **PWM0DZ:** PWM0 dead zone (Dead zone is prohibited in half-bridge mode)

0000: 0 x T<sub>PWMCLK</sub>

0001: 1 x T<sub>PWMCLK</sub>

...

1111: 15 x T<sub>PWMCLK</sub>



SFR <b>B6h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE1	PWM4OE3	PWM4OE2	PWM4OE1	PWM4OE0	PWM3OE1	PWM3OE0	PWM2OE1	PWM2OE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

B6h.7 **PWM4OE3:** PWM4 output control

0: Disable 1: PWM4 enable and output to P3.6

B6h.6 **PWM4OE2:** PWM4 output control

0: Disable 1: PWM4 enable and output to P1.5

B6h.5 **PWM4OE1:** PWM4 output control

0: Disable 1: PWM4 enable and output to P0.4

B6h.4 **PWM4OE0:** PWM4 output control

0: Disable 1: PWM4 enable and output to P0.0

B6h.3 **PWM3OE1:** PWM3 output control

0: Disable 1: PWM3 enable and output to P3.4

B6h.2 **PWM3OE0:** PWM3 output control

0: Disable 1: PWM3 enable and output to P1.0

B6h.1 **PWM2OE1:** PWM2 output control

0: Disable 1: PWM2 enable and output to P3.6

B6h.0 **PWM2OE0:** PWM2 output control

0: Disable 1: PWM2 enable and output to P1.1

SFR <b>B7h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE2	<b>MSDASEL</b>	MSCLSEL	PWM6OE2	PWM6OE1	PWM6OE0	PWM5OE2	PWM5OE1	PWM5OE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

B7h.5 **PWM6OE2:** PWM6 output control

0: Disable 1: PWM6 enable and output to P1.3

B7h.4 **PWM6OE1:** PWM6 output control

0: Disable 1: PWM6 enable and output to P0.7

B7h.3 **PWM6OE0:** PWM6 output control

0: Disable 1: PWM6 enable and output to P0.3

B7h.2 **PWM5OE2:** PWM5 output control

0: Disable 1: PWM5 enable and output to P1.4

B7h.1 **PWM5OE1:** PWM5 output control

0: Disable 1: PWM5 enable and output to P0.6

B7h.0 **PWM5OE0:** PWM5 output control

0: Disable 1: PWM5 enable and output to P0.1

SFR D1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
PWM0DH		PWM0DH							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

D1h.7~0 **PWM0DH:** PWM0 duty high byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL



SFR D2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM0DL		PWM0DL								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

D2h.7~0 **PWM0DL:** PWM0 duty low byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR D3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM1DH		PWM1DH								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

D3h.7~0 **PWM1DH:** PWM1 duty high byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR <b>D4h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM1DL		PWM1DL								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

D4h.7~0 **PWM1DL:** PWM1 duty low byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR <b>D5h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM2DH		PWM2DH								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

D5h.7~0 **PWM2DH:** PWM2 duty high byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR <b>D6h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM2DL		PWM2DL								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

D6h.7~0 **PWM2DL:** PWM2 duty low byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR <b>D9h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM0PRDH		PWM0PRDH								
R/W		R/W								
Reset	1	1	1	1	1	1	1	1		

D9h.7~0 **PWM0PRDH:** PWM0 period high byte

write sequence: PWMxPRDL then PWMxPRDH read sequence: PWMxPRDH then PWMxPRDL

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SFR <b>DAh</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM0PRDL		PWM0PRDL								
R/W		R/W								
Reset	1	1	1	1	1	1	1	1		

DAh.7~0 **PWM0PRDL:** PWM0 period low byte

write sequence: PWMxPRDL then PWMxPRDH read sequence: PWMxPRDH then PWMxPRDL

SFR <b>DBh</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM1PRDH		PWM1PRDH								
R/W		R/W								
Reset	1	1	1	1	1	1	1	1		

DBh.7~0 **PWM1PRDH:** PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 period high byte

write sequence: PWMxPRDL then PWMxPRDH read sequence: PWMxPRDH then PWMxPRDL

SFR DCh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM1PRDL		PWM1PRDL								
R/W		R/W								
Reset	1	1	1	1	1	1	1	1		

DCh.7~0 **PWM1PRDL:** PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 period low byte

write sequence: PWMxPRDL then PWMxPRDH read sequence: PWMxPRDH then PWMxPRDL

SFR <b>DDh</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM3DH		PWM3DH								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

DDh.7~0 **PWM3DH:** PWM3 duty high byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR <b>DEh</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM3DL		PWM3DL								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

DEh.7~0 **PWM3DL:** PWM3 duty low byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR E9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
PWM4DH		PWM4DH								
R/W		R/W								
Reset	0	0	0	0	0	0	0	0		

E9h.7~0 **PWM4DH:** PWM4 duty high byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

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SFR EAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
PWM4DL		PWM4DL							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

EAh.7~0 **PWM4DL:** PWM4 duty low byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR <b>EBh</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
PWM5DH		PWM5DH							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

EBh.7~0 **PWM5DH:** PWM5 duty high byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR ECh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
PWM5DL		PWM5DL							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

ECh.7~0 **PWM5DL:** PWM5 duty low byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR EDh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
PWM6DH		PWM6DH							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

EDh.7~0 **PWM6DH:** PWM6 duty high byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR EEh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
PWM6DL		PWM6DL							
R/W		R/W							
Reset	0	0	0	0	0	0	0	0	

EEh.7~0 **PWM6DL:** PWM6 duty low byte

write sequence: PWMxDL then PWMxDH read sequence: PWMxDH then PWMxDL

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	VBGEN	ADSOC	CLRPWM0	CLRPWM1	_	DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	R/W
Reset	0	0	0	0	1	1	_	0

F8h.3 **CLRPWM0:** PWM0 clear enable

0: PWM0 is running

1: PWM0 is cleared and held

F8h.2 **CLRPWM1:** PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 clear enable

0: PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 is running

1: PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 is cleared and held

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# 10. Low Voltage Detection (LVD)

The Chip provides LVD (low voltage detection) function.

	Description
LVD	15-level LVD can be selected by SFR LVDSEL.

Operation	PWRSAV	LVDSEL	LVD	Function	Note
Mode	(SFR F7.5)	(SFR E4h.3~0)		Tunction	Note
X	X	0000	OFF		
		0001	ON	LVD 2.30V	
		0010	ON	LVD 2.45V	
		0011	ON	LVD 2.55V	
		0100	ON	LVD 2.70V	
		0101	ON	LVD 2.85V	
		0110	ON	LVD 3.00V	
		0111	ON	LVD 3.15V	
Fast or Slow	X	1000	ON	LVD 3.30V	
		1001	ON	LVD 3.45V	
		1010	ON	LVD 3.60V	
		1011	ON	LVD 3.75V	
		1100	ON	LVD 3.90V	
		1101	ON	LVD 4.05V	
		1110	ON	LVD 4.20V	
		1111	ON	LVD 4.35V	
		0001	ON	LVD 2.30V	
		0010	ON	LVD 2.45V	
		0011	ON	LVD 2.55V	
		0100	ON	LVD 2.70V	
		0101	ON	LVD 2.85V	
		0110	ON	LVD 3.00V	
		0111	ON	LVD 3.15V	
Idle or Stop	0	1000	ON	LVD 3.30V	
1		1001	ON	LVD 3.45V	
		1010	ON	LVD 3.60V	
		1011	ON	LVD 3.75V	
		1100	ON	LVD 3.90V	
		1101	ON	LVD 4.05V	
		1110	ON	LVD 4.20V	
		1111	ON	LVD 4.35V	
Idle or Stop	1	xxxx	OFF	LVD disable	Minimum current consumption About 0.1uA

Low voltage detect table

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SFR E4h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
LVDCON	_	_	_	LVDIF		LVD	SEL	
R/W	_	_	_	R/W	R/W	R/W	R/W	R/W
Reset	_	_	_	_	0	0	0	0

E4h.4 **LVDIF**: LVD interrupt flag, write 0 to clear this bit

E4h.3~0 LVDSEL: Low Voltage detect select

0000: LVD disable
0001: Set LVD at 2.30V
0010: Set LVD at 2.45V
0011: Set LVD at 2.55V
0100: Set LVD at 2.70V
0101: Set LVD at 2.85V
0110: Set LVD at 3.00V
0111: Set LVD at 3.15V
1000: Set LVD at 3.30V
1001: Set LVD at 3.45V
1010: Set LVD at 3.60V
1011: Set LVD at 3.75V
1100: Set LVD at 3.90V
1101: Set LVD at 4.05V
1110: Set LVD at 4.20V

1111: Set LVD at 4.35V

SFR F7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX2	WI	OTE	PWRSAV	VBGOUT	DIV32	IAI	PTE	MULDIV16
R/W	R/W	R/W	R/W	R/W	R/W	R/	W	R/W
Reset	0	0	0	0	0	1	1	0

F7h.5 Set 1 to reduce the chip's power consumption at Idle and Stop Mode

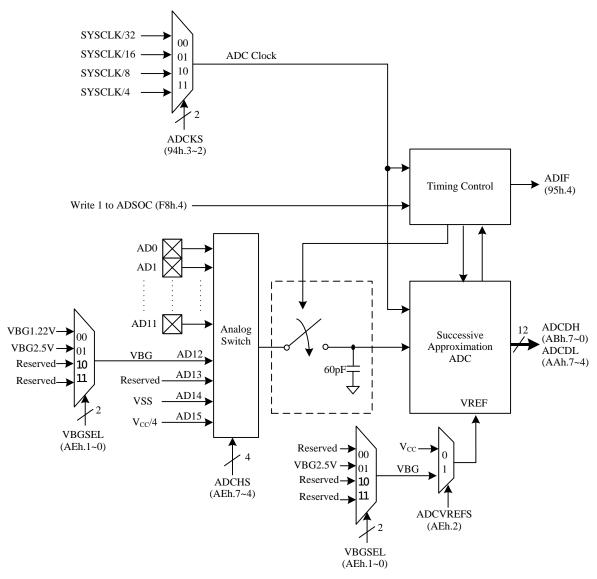
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### 11. ADC

The Chip offers a 12-bit ADC consisting of a 16-channel analog input multiplexer, control register, clock generator, 12-bit successive approximation register, and output data register. To use the ADC, set the ADCKS bits first to choose a proper ADC clock frequency, which must be less than 1 MHz. Then, launch the ADC conversion by setting the ADSOC bit, and H/W will automatic clear it at the end of the conversion. After the end of the conversion, H/W will set the ADIF bit and generate an interrupt if an ADC interrupt is enabled. The ADIF bit can be cleared by writing 0 to this bit or 1 to the ADSOC bit. The analog input level must remain within the range from  $V_{SS}$  to  $V_{CC}$ .

Using the ADCVREFS option, the ADC internal reference voltage source (VREF) can be selected as Vcc or VBG 2.5V. When ADCVREFS=1, VBGSEL must be set to 2'b01.

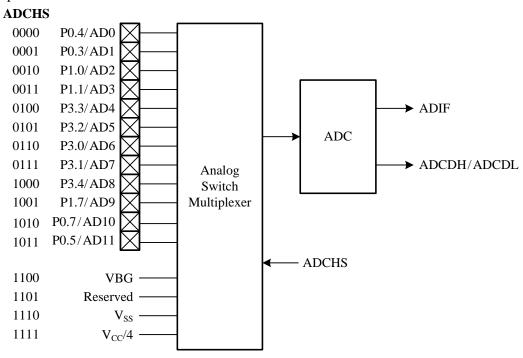


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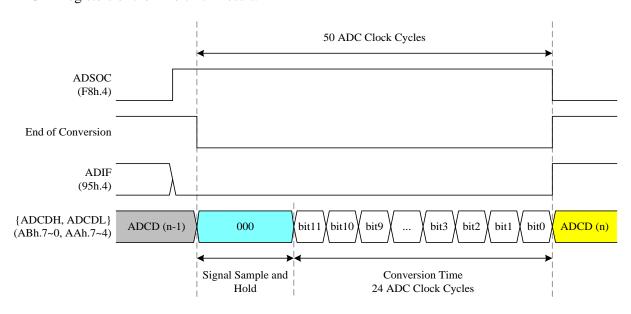
#### **ADC Channels**

The 12-bit ADC has a total of 16 channels, designated AD0~AD11, VBG,  $V_{SS}$ , and  $V_{CC}/4$ . The ADC channels are connected to the analog input pins via the analog switch multiplexer. The analog switch multiplexer is controlled by the ADCHS register. The Chip offers up to 12 IO input pins, designated AD0~AD11. In addition, there are four analog input pins for voltage reference connections. When ADCHS is set to 1110b, the analog input will connect to  $V_{SS}$ , and when ADCHS is set to 1100b, the analog input will connect to VBG.



#### **ADC Conversion Time**

The conversion time is the time required for the ADC to convert the voltage. The ADC requires two ADC clock cycles to convert each bit and several clock cycles to sample and hold the input voltage. A total of 50 ADC clock cycles are required to perform the complete conversion. When the conversion time is complete, the ADIF interrupt flag is set by H/W, and the result is loaded into the ADCDH and ADCDL registers of the 12-bit A/D result.



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SFR 94h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
OPTION	UART1W	-	WDTPSC		ADCKS		TM3PSC	
R/W	R/W	-	R/W		R/	W	R/	W
Reset	0	-	0	0	0	0	0	0

94h.3~2 **ADCKS:** ADC clock rate select

 $00: F_{SYSCLK}/32 \\ 01: F_{SYSCLK}/16 \\ 10: F_{SYSCLK}/8 \\ 11: F_{SYSCLK}/4$ 

SFR <b>95h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTFLG	_	_	_	ADIF	_	IE2	PXIF	TF3
R/W	_	_	_	R/W	_	R/W	R/W	R/W
Reset	_	_	_	0	_	0	0	0

95h.4 **ADIF:** ADC interrupt flag

Set by H/W at the end of ADC conversion. S/W writes EFh to INTFLG or sets the ADSOC bit to clear this flag. (*Note1*)

SFR AAh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ADCDL		ADO	CDL		_		_	_
R/W		F	₹		_	_	_	_
Reset	_	_	_	-	_	_	_	_

AAh.7~4 **ADCDL:** ADC data bit 3~0

SFR ABh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
ADCDH		ADCDH							
R/W		R							
Reset	-	_		ı	_	-	_	_	

ABh.7~0 **ADCDH:** ADC data bit 11~4



SFR AEh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
CHSEL		ADO	CHS		_	ADCVREFS	VBG	SEL
R/W		R/	W		_	R/W	R/	W
Reset	1	1	1	1	_	0	0	0

AEh.7~4 ADCHS: ADC channel select

0000: AD0 (P0.4)

0001: AD1 (P0.3)

0010: AD2 (P1.0)

0011: AD3 (P1.1)

0100: AD4 (P3.3)

0101: AD5 (P3.2)

0110: AD6 (P3.0)

0111: AD7 (P3.1)

1000: AD8 (P3.4)

1001: AD9 (P1.7)

1010: AD10 (P0.7)

1011: AD11 (P0.5)

1100: VBG

1101: Reserved

1110: V<sub>SS</sub>

1111:  $V_{CC}/4$ 

AEh.2 ADCVREFS: ADC reference voltage select

 $0:V_{CC}$ 

1: VBG

AEh.1~0 VBGSEL: VBG voltage select

When ADCVREF is selected as VBG, VBGSEL is prohibited from using 1.22V.

00: 1.22V 01: 2.5V 10: Reserved

11: Reserved

SFR F8h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX1	CLRWDT	CLRTM3	VBGEN	ADSOC	CLRPWM0	CLRPWM1		DPSEL
R/W	R/W	R/W	R/W	R/W	R/W	R/W	_	R/W
Reset	0	0	0	0	1	1	_	0

F8h.5 **VBGEN**: force VBG generator enable

0: VBG generator is automatically enable and disable

1: Force VBG generator enable except in IDLE and STOP mode.

F8h.4 **ADSOC:** Start ADC conversion

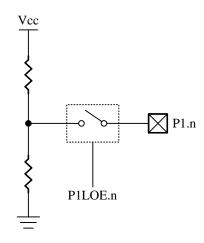
Set the ADSOC bit to start ADC conversion, and the ADSOC bit will be cleared by H/W at the end of conversion. S/W can also write 0 to clear this flag.

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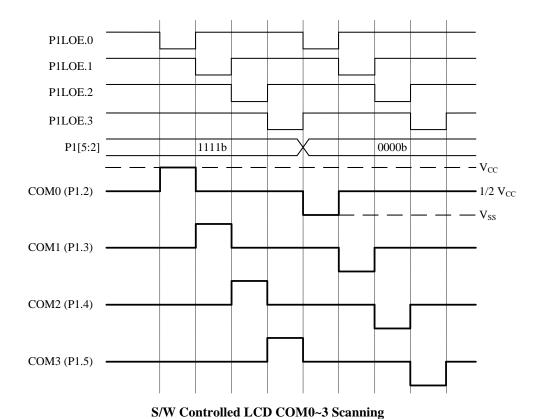
#### 12. S/W Controller LCD Driver

The chip supports an S/W controlled method to driving LCD. It is capable of driving the LCD panel with 88 dots (Max.) by 4 Commons (COM) and 22 Segments (SEG). The P1.2~P1.5 are used for Common pins COM0~COM3 and others pins can be used for Segment pins. COM0~COM3 are capable of driving 1/2 bias when P1.2~P1.5's P1LOE=1. Refer to the following figures.



LCD COM0~3 Circuit

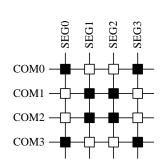
The frequency of any repeating waveform output on the COM pin can be used to represent the LCD frame rate. The figure below shows an LCD frame.

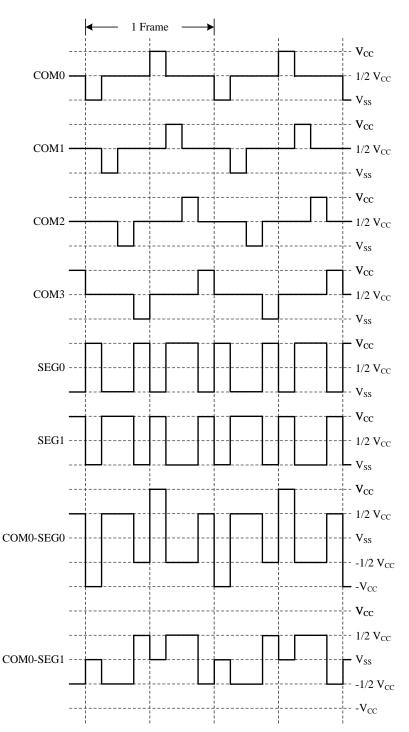


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## 1/4 Duty, 1/2 Bias Output Waveform







SFR 92h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
P1LOE	_	_	_	_	P1LOE3	P1LOE2	P1LOE1	P1LOE0
R/W	_	_	_	_	R/W	R/W	R/W	R/W
Reset	_	_	_	_	0	0	0	0

92h.3 **P1LOE3:** LCD 1/2 bais Output

0: Disable

1: P15 as LCD 1/2 bais Output

92h.2 **P1LOE2:** LCD 1/2 bais Output

0: Disable

1: P14 as LCD 1/2 bais Output

92h.1 **P1LOE1:** LCD 1/2 bais Output

0: Disable

1: P13 as LCD 1/2 bais Output

92h.0 **P1LOE0:** LCD 1/2 bais Output

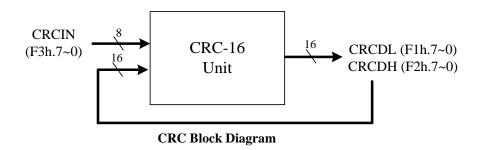
0: Disable

1: P12 as LCD 1/2 bais Output



## 13. Cyclic Redundancy Check (CRC)

The chip supports an integrated 16-bit Cyclic Redundancy Check function. The Cyclic Redundancy Check (CRC) calculation unit is an error detection technique test algorithm and uses to verify data transmission or storage data correctness. The CRC calculation takes a 8-bit data stream or a block of data as input and generates a 16-bit output remainder. The data stream is calculated by the same generator polynomial.



The CRC generator provides the 16-bit CRC result calculation based on the CRC-16-IBM polynomial. In this CRC generator, there are only one polynomial available for the numeric values calculation. It can't support the 16-bit CRC calculations based on any other polynomials. Each write operation to the CRCIN register creates a combination of the previous CRC value stored in the CRCDH and CRCDL registers. It will take one MCU instruction cycle to calculate.

CRC-16-IBM (Modbus) Polynomial representation:  $X^{16} + X^{15} + X^2 + 1$ 

SFR F1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
CRCDL		CRCDL							
R/W		R/W							
Reset	1	1	1	1	1	1	1	1	

F1h.7~0 **CRCDL:** 16-bit CRC checksum data bit 7~0

SFR F2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
CRCDH		CRCDH								
R/W		R/W								
Reset	1	1	1	1	1	1	1	1		

F2h.7~0 **CRCDL:** 16-bit CRC checksum data bit 15~8

SFR F3h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
CRCIN		CRCIN								
W		W								
Reset	_	_	_	_	_	_	_	_		

F3h.7~0 **CRCIN:** CRC input data register

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## 14. Multiplier and divider

The chip provide multiplier and divider have the following functions. The 8 bit operation is fully compatible with industry standard 8051.

- $8 \text{ bits} \times 8 \text{ bits} = 16 \text{ bit (standard } 8051)$
- 8 bits  $\div$  8 bits = 8 bits, 8 bits remainder (standard 8051)
- $16 \text{ bits} \times 16 \text{ bits} = 32 \text{ bit}$
- 16 bits  $\div$  16 bits = 16 bits, 16 bits remainder
- 32 bits  $\div$  16 bits = 32 bits, 16 bits remainder

No matter 8bit / 16bit / 32bit operation, it's easy to execute by MUL AB and DIV AB instruction. There is extra SFR EXA/EXA2/EXA3/EXB for 16bit / 32bit multiply and divide operation.

For 8 bit multiplier/divider operation, be sure SFR bit muldiv16=0 and div32=0.

For 16 bit multiplier operation, multiplier and product as follows. 16 bit multiplier takes 16 System clock cycles to execute.

Condition	S	SFR bit muldiv16=1 and div32=0							
Multiplication	Byte3	Byte2	Byte1	Byte0					
Multiplicand	-	-	EXA	A					
Multiplier	-	-	EXB	В					
Product	EXB	В	A	EXA					
OV	Product (EX	(B or B) !=0	-	-					

For 16 bit divider operation, dividend, divisor, quotient, remainder read as follows. 16 bit divider takes 16 System clock cycles to execute.

Condition	SFR bit muldiv16=1 and div32=0								
Division	Byte3	Byte2	Byte1	Byte0					
Dividend	ı	-	EXA	A					
Divisor	-	-	EXB	В					
Quotient	-	-	A	EXA					
Remainder	-	-	В	EXB					
OV		Divisor EXB = B =0							

For 32 bits ÷ 16 bits operation, dividend, divisor, quotient, remainder read as follows. 32 bit divider takes 32 System clock cycles to execute.

Condition	S	SFR bit muldiv16=1 and div32=1								
Division	Byte3	Byte2	Byte1	Byte0						
Dividend	EXA3	EXA2	EXA	A						
Divisor	-	-	EXB	В						
Quotient	A	EXA	EXA2	EXA3						
Remainder	-	-	В	EXB						
OV	Divisor EXB=B =0									

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SFR CEh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
EXA2		EXA2							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0	

CEh.7~0 **EXA2:** Expansion accumulator 2

SFR CFh	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
EXA3				EX	A3			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

CFh.7~0 **EXA3:** Expansion accumulator 3

SFR E6h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
EXA		EXA						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

E6h.7~0 **EXA:** Expansion accumulator

SFR E7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
EXB		EXB						
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

E7h.7~0 **EXB:** Expansion B register

SFR F7h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
AUX2	WDTE		PWRSAV	VBGOUT	DIV32	IAI	PTE	MULDIV16
R/W	R/W	R/W	R/W	R/W	R/W	R/W		R/W
Reset	0	0	0	0	0	0	0	0

## F7h.3 **DIV32:**

only active when MULDVI16 =1

0: instruction DIV as 16/16 bit division operation1: instruction DIV as 32/16 bit division operation

### F7h.0 **MULDIV16:**

0: instruction MUL/DIV as 8\*8, 8/8 operation

1: instruction MUL/DIV as 16\*16, 16/16 or 32/16 operation

	ARITHMETIC			
Mnemonic	Description	byte	cycle	opcode
MUL AB	Multiply A by B	1	8/16	A4
DIV AB	Divide A by B	1	8/16/32	84

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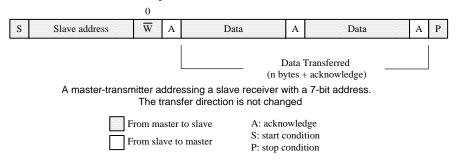


#### 15. Master I<sup>2</sup>C Interface

#### Master I<sup>2</sup>C interface Transmitter mode:

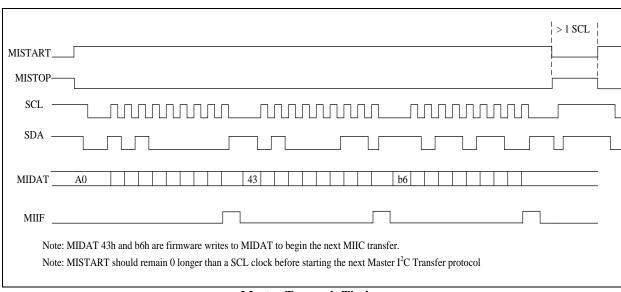
At the beginning write slave address and direction bit to MIDAT and set MISTART. After the START condition (MISTART), the 7 bits slave address and one bit direction bit are sent. When MIIF convert to 1, address and direction bit transmission was complete. After sending the address and direction bit, user should clear MIIF and write MIDAT to start first data transmission. When MIIF convert to 1, data transfer to slave was complete. User can write MIDAT again to transfer next data to slave. Set MISTOP to finish transmitter mode.

MISTART must remain at 1 for the next transfer. After final data transmit/receive, set MISTOP to finish transmit/receive protocol. MISTART should remain 0 longer than a SCL clock before starting the next Master I<sup>2</sup>C protocol. SCL clock can be adjusted via MICR.



#### Master I2C Transmit flow:

- (1) Write slave address and direction bit to MIDAT
- (2) Clear MISTOP and set MISTART to start I<sup>2</sup>C transmission
- (3) Wait until MIIF converter to 1 (interrupt will be issued according to the user's request) and Clear MIIF
- (4) Write data to MIDAT to start next transfer (MISTART must remain at 1)
- (5) Wait until MIIF converter to 1 (interrupt will be issued according to the user's request) and Clear MIIF, Loop (3) ~(4) for next transfer.
- (6) Clear MISTART and set MISTOP to stop the I<sup>2</sup>C transfer



**Master Transmit Timing** 

Note: MISTART should remain 0 longer than a SCL period before starting the next Master  $I^2C$  protocol.

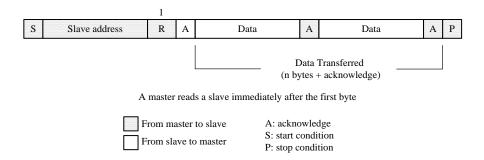
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#### Master I2C interface Receive mode:

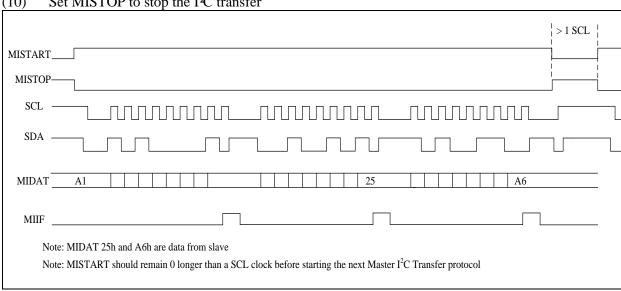
At the beginning write slave address and direction bit to MIDAT and set MISTART. After the START condition (MISTART), the 7 bits slave address and one bit direction bit are sent. When MIIF convert to 1, address and direction bit transmission was complete. After sending the address and direction bit, user should clear MIIF and read MIDAT to start first receive data (The first reading of MIDAT does not represent the data returned by the slave). When MIIF convert to 1, data receive from slave was complete. User can read MIDAT to get data from slave, and start next receive. Set MISTOP to finish receive mode.

MISTART must remain at 1 for the next transfer. After final data transmit/receive, set MISTOP to finish transmit/receive protocol. MISTART should remain 0 longer than a SCL clock before starting the next Master I<sup>2</sup>C protocol. SCL clock can be adjusted via MICR.



#### Master I2C Receive flow:

- Write slave address and direction bit to MIDAT (1)
- Clear MISTOP and set MISTART to start I<sup>2</sup>C transmission (2)
- (3)Wait until MIIF converter to 1 (interrupt will be issued according to the user's request)
- Clear MIIF (4)
- Read data from MIDAT to start first receive data (5)(The first reading of MIDAT does not represent the data returned by the slave)
- Wait until MIIF converter to 1 (6)
- Clear MIIF (7)
- Read slave data from MIDAT and receive next data (8)
- Loop (6) ~(8) (9)
- (10)Set MISTOP to stop the I<sup>2</sup>C transfer



**Master Receive Timing** 

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Alternative Function	Mode	P1/P3 SFR data	Pin State	Other necessary SFR setting
SCL			I <sup>2</sup> C Clock Output (Open Drain Output, Pull-up)	MSCLSEL
(I <sup>2</sup> C Master)	2	X	I <sup>2</sup> C Clock Output (CMOS Push-Pull)	MISCLSEL
SDA (I <sup>2</sup> C Master)	0	1	I <sup>2</sup> C DATA (Pull-up)	MSDASEL

Alternative Function	POOE.n	P0 SFR data	Pin State	other necessary SFR setting	
SCL (I <sup>2</sup> C Master)	0 X		I <sup>2</sup> C Clock Output (Open Drain Output, Pull-up)	MSCLSEL	
(I C Master)	1	X	I <sup>2</sup> C Clock Output (CMOS Push-Pull)		

## Pin Mode Setting for Master I<sup>2</sup>C

SFR A9h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTE1	PWMIE	_	LVDIE	I2CE	ADIE	EX2	PXIE	TM3IE
R/W	R/W	_	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	_	0	0	0	0	0	0

A9h.4 **I2CE:** I\*C interrupt enable

0: Disable I℃ interrupt 1: Enable I℃ interrupt

SFR <b>B7h</b>	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PWMOE2	MSDASEL	MSCLSEL	PWM6OE2	PWM6OE1	PWM6OE0	PWM50E2	PWM50E1	PWM5OE0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

B7h.7 **MSDASEL:** Master I<sup>2</sup>C SDA select

0: P3.5 as Master I<sup>2</sup>C SDA 1: P1.6 as Master I<sup>2</sup>C SDA

B7h.6 **MSCLSEL:** Master I<sup>2</sup>C SCL select

0: P1.3 as Master I<sup>2</sup>C SCL 1: P0.2 as Master I<sup>2</sup>C SCL

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SFR E1h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
MICON	MIEN	MIACKO	MIIF	MIACKI	MISTART	MISTOP	MI	CR
R/W	R/W	R/W	R/W	R	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	1	0	0

E1h.7 **MIEN**:Master I<sup>2</sup>C enable

0: disable 1: enable

E1h.6 **MIACKO**: When Master I<sup>2</sup>C receive data, send acknowledge to I<sup>2</sup>C Bus

0: ACK to slave device 1: NACK to slave device

E1h.5 MIIF: Master I<sup>2</sup>C Interrupt flag

0: write 0 to clear it

1: Master I<sup>2</sup>C transfer one byte complete

E1h.4 **MIACKI**: When Master I<sup>2</sup>C transfer, acknowledgement form I<sup>2</sup>C bus (read only)

0: ACK received 1: NACK received

E1h.3 **MISTART**: Master I<sup>2</sup>C Start bit

1: start I<sup>2</sup>C bus transfer

E1h.2 **MISTOP**: Master I<sup>2</sup>C Stop bit

1: send STOP signal to stop I<sup>2</sup>C bus

E1h.1~0 MICR: Master  $I^2C$  (SCL) clock frequency selection

00: Fsys/4 (ex. If Fsys=16MHz, I<sup>2</sup>C clock is 4M Hz) 01: Fsys/16 (ex. If Fsys=16MHz, I<sup>2</sup>C clock is 1M Hz) 10: Fsys/64 (ex. If Fsys=16MHz, I<sup>2</sup>C clock is 250K Hz) 11: Fsys/256 (ex. If Fsys=16MHz, I<sup>2</sup>C clock is 62.5K Hz)

SFR E2h	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
MIDAT				MID	PAT			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

E2h.7~0 **MIDAT**: Master I<sup>2</sup>C data shift register

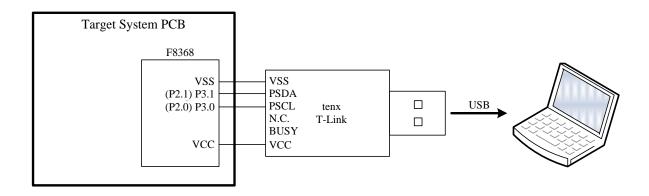
(W):After Start and before Stop condition, write this register will resume transmission to I<sup>2</sup>C bus (R): After Start and before Stop condition, read this register will resume receiving from I<sup>2</sup>C bus



### 16. In Circuit Emulation (ICE) Mode

This device can support the In Circuit Emulation Mode. To use the ICE Mode, user just needs to connect P3.0 and P3.1 pin to the tenx proprietary EV Module. The benefit is that user can emulate the whole system without changing the on board target device. But there are some limits for the ICE mode as below.

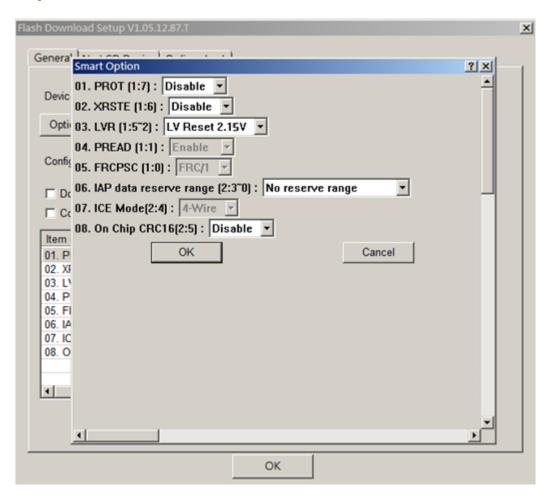
- 1. The device must be un-protect.
- 2. The device's P3.0 and P3.1 pins must work in input Mode (P3MOD0 = 0/1 and P3MOD1=0/1).
- 3. The Program Memory's addressing space 0D00h~0FFFh and 0033h~003Ah are occupied by tenx EV module. So user Program cannot access these spaces.
- 4. The T-Link communication pin's function cannot be emulated.
- 5. The P3.0 and P3.1 pin's can be replaced by P2.0 and P2.1.



_	8K Bytes program memory
0000h	
	Reset / Interrupt Vector
007Fh	
0080h	
	User Code area
0CFFh	
0D00h	
	ICE mode reserve area
0FFFh	
1000h	II C I IAD
1 DDD1-	User Code or IAP area
1FEFh	CDC1CI
1FF0h	CRC16L
1FF1h	CRC16H
1FF2h	tany rasarya aras
1FFAh	tenx reserve area
	CECDC
1FFBh	CFGBG
1FFDh	CFGWL (FRC)
1FFFh	CFGWH
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No.	Item	Description							
01	PROT	Enable: Flash code is protect, Writer cannot access the ROM code							
		<b>Disable:</b> Flash code is not protect, Writer can access the ROM code (default)							
02	XRSTE	Enable: P3.7 is external reset pin							
02	ARSTE	<b>Disable:</b> P3.7 is normal I/O pin (default)							
		16-level Low Voltage Reset select							
		0000: Set LVR at 2.15V 1000: Set LVR at 3.30V							
		0001: Set LVR at 2.30V 1001: Set LVR at 3.45V							
		0010: Set LVR at 2.45V 1010: Set LVR at 3.60V							
03	LVRE	0011: Set LVR at 2.55V 1011: Set LVR at 3.75V							
03	LVKL	0100: Set LVR at 2.70V 1100: Set LVR at 3.90V							
		0101: Set LVR at 2.85V 1101: Set LVR at 4.05V							
		0110: Set LVR at 3.00V 1110: Set LVR at 4.20V							
		0111: Set LVR at 3.15V 1111: Set LVR at 4.35V							
04	PREAD	Reserved							
05	FRCPSC	Reserved							
06	IAP data	IAD allow one garage allot							
06	reserve range	IAP-allow area range select							
07	ICE Mode	Reserved							
06	On Chin CDC16	Enable: On chip CRC-16 function enable							
08	On Chip CRC16	<b>Disable:</b> On chip CRC-16 function disable (default)							



# **SFR & CFGW MAP**

Adr	RST	NAME	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
80h	0000-0000	P0	P0.7	P0.6	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0			
81h	0000-0111	SP					P						
	0000-0000	DPL					PL						
	0000-0000	DPH		,		Dl	PH		,				
84h	x00x-xxxx	INTE2	_	PWM1IE	PWM0IE	_	-	_	-	_			
	x00x-xxxx	INTFLG2	_	PWM1IF	PWM0IF	_	_	_	_	_			
	0xxx-0000	PCON	SMOD	-	-	_	GF1	GF0	PD	IDL			
	0000-0000	TCON	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0			
	0000-0000	TMOD	GATE1	CT1N	TM		GATE0	CT0N	TM	OD0			
	0000-0000	TL0					LO						
	0000-0000	TL1					L1 H0						
	0000-0000	TH0 TH1					H1						
	0000-0000 1111-1111	P1	P1.7	P1.6	P1.5	P1.4	P1.3	P1.2	P1.1	P1.0			
	0000-0000	POOE	F1./	F1.0	F1.3		OE	F1.2	F1.1	F1.0			
	xxxx-0000	P1LOE	_	_	_		OL	D11	LOE				
	0000-0101	PINMOD	TXRXSEL	T2OE	T10E	T0OE	P2M			IOD0			
	0000-0101	OPTION	UART1W	- 120E	_	TPSC		CKS		BPSC			
	xxx0-x000	INTFLG	-	-	-	ADIF	-	IE2	PXIF	TF3			
	0000-0000	P1WKUP			l		KUP	122	11111	110			
	xxxx-xx00	SWCMD			]	APALL / SW		Э					
	0000-0000	SCON	SM0	SM1	SM2	REN	TB8	RB8	TI	RI			
99h	xxxx-xxxx	SBUF		l		SB	UF	I	l	I.			
A0h	1111-1111	P2	P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0			
A1h	00xx-0000	PWMCON	PWM	1CKS	_	_	PWM	0CKS	PWMONMSK	PWM0PMSK			
A2h	0101-0101	P1MODL	P1M	OD3	P1M	OD2	P1M	IOD1	P1MOD0				
A3h	0101-0101	P1MODH	P1M	OD7	P1MOD6 P1MOD5 P1MC								
A4h	0101-0101	P3MODL	P3M	OD3	P3M	OD2	P3M	IOD1	P3M	IOD0			
A5h	0101-0101	P3MODH	P3M			OD6	P3M			IOD4			
A6h	0000-0000	PWMOE0	PWM10E3	PWM10E2	PWM10E1	PWM10E0	PWM0N0E1	PWM0POE1	PWM0NOE0	PWM0POE0			
	0000-0000	PWMCON2	PWM0M0D	PWM0MSKE		10OM		PWN	MODZ				
	0x00-0000	IE	EA	_	ET2	ES	ET1	EX1	ET0	EX0			
	xx00-0000	INTE1	PWMIE	_	LVDIE	I2CE	ADIE	EX2	PXIE	TM3IE			
	XXXX-XXXX	ADCDL		AD	CDL		_	_	-	_			
	XXXX-XXXX	ADCDH		1.0	CIIC	ADO	CDH	A DOT TOUTO	T/D/	napr.			
	1111-x000	CHSEL P0DIE		AD	CHS	DO	-	ADCVREFS	VBC	SSEL			
-	0000-0000 1111-1111	PODIE P3	P3.7	P3.6	P3.5	P3.4	DIE P3.3	P3.2	P3.1	P3.0			
					PWM4OE1								
					PWM6OE2								
	xx00-0000	IP	- WISDASEL	- WISCESEE	PT2	PS	PT1	PX1	PT0	PX0			
	xx00-0000	IPH	_	_	PT2H	PSH	PT1H	PX1H	PT0H	PX0H			
	0x00-0000	IP1	PPWM	_	PLVD	PI2C	PADI	PX2	PPX	PT3			
	0x00-0000	IP1H	PPWMH	-	PLVDH	PI2CH	PADIH	PX2H	PPXH	PT3H			
	0000-0000						KUP						
C6h	0000-0000	P2WKUP					KUP						
C7h	0000-0000	P3WKUP				P3W	'KUP						
C8h	0000-0000	T2CON	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	CT2N	CPRL2N			
C9h	000x-xxxx	IAPWE	IAPWE / IAPTO										
	0000-0000	RCP2L		RCP2L									
	0000-0000	RCP2H	RCP2H										
	0000-0000	TL2	TL2										
	0000-0000	TH2		TH2									
_	0000-0000	EXA2		EXA2									
	0000-0000	EXA3					A3						
	0000-0000	PSW	CY	AC	F0	RS1 RS0 OV			F1	P			
_		PWM0DH					MODH						
	10000-0000	PWM0DL	1			PWN	10DL						



Adr	RST	NAME	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
D3h	0000-0000	PWM1DH				PWM	11DH						
D4h	0000-0000	PWM1DL				PWN	/IIDL						
D5h	0000-0000	PWM2DH				PWM	12DH						
D6h	0000-0000	PWM2DL				PWN	12DL						
D8h	xxx0-0011	CLKCON	-	STPPCK STPFCK SELFCK CLKPSC									
D9h	1111-1111	PWM0PRDH				PWM	)PRDH						
DAh	1111-1111	PWM0PRDL				PWM	)PRDL						
DBh	1111-1111	PWM1PRDH				PWM	IPRDH						
DCh	1111-1111	PWMIPRDL					IPRDL						
		PWM3DH				PWM	13DH						
		PWM3DL					13DL						
	0000-0000	ACC	ACC.7	ACC.6	ACC.5	ACC.4	ACC.3	ACC.2	ACC.1	ACC.0			
	000x-0100		MIEN	MIACKO	MIIF	MIACKI	MISTART	MISTOP	M	ICR			
	0000-0000			•	T		DAT						
	xxx0-0000		-	_	_	LVDIF		LVE	DSEL				
	0000-0000	LVRPD					RPD						
	0000-0000	EXA					ΧA						
	0000-0000	EXB					XB						
		PWM4DH					14DH						
		PWM4DL					/I4DL						
		PWM5DH					15DH						
		PWM5DL					15DL						
		PWM6DH					16DH						
	0000-0000		D.7	D.C.	D.5		M6DL	D 2	D 1	D.0			
	0000-0000	В	B.7	B.6	B.5	B.4	B.3	B.2	B.1	B.0			
	1111-1111	CRCDL					CDL						
F2h	1111-1111	CRCDH					CDH						
	0000-0000	CECEC		1			CIN	рет	TRIM				
	XXXX-XXXX	CFGBG	_	_	_	_	FRCF	ROI	KIN				
	0000-1110	CFGWL AUX2	- WI	L DTE	PWRSAV	VBGOUT	DIV32	IAF	TE	MULDIV16			
	0000-1110		CLRWDT	CLRTM3		ADSOC		CLRPWM1		DPSEL			
ron	0000-1100	AUX1	CLKWDI	CLK I WI3	VBGEN	ADSUC	CLKPWMU	CLKPWMI	_	DESEL			

Flash Address	NAME	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1FFBh	CFGBG	-	-	-	-		BGT	RIM	
1FFDh	CFGWL	=	FRCF						
1FFFh	CFGWH	PROT	XRSTE	TE LVRE PREAD F					FRCPSC



# **SFR & CFGW DESCRIPTION**

Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
80h	P0	7~0	P0	R/W	00h	Port0 has no pin out, so P0 is used as general purpose register
81h	SP	7~0	SP	R/W	07h	Stack Point
82h	DPL	7~0	DPL	R/W	00h	Data Point low byte
83h	DPH	7~0	DPH	R/W	00h	Data Point high byte
84h	INTE2	6	PWM1IE	R/W	0	PWM1~PWM6 interrupt enable 0: Disable PWM1~PWM6 interrupt 1: Enable PWM1~PWM6 interrupt
0411	84n INTE2	5	PWM0IE	R/W	0	PWM0 interrupt enable 0: Disable PWM0 interrupt 1: Enable PWM0 interrupt
85h INTFLG2	6	PWM1IF	R/W	0	PWM1~PWM6 interrupt flag Set by H/W at the end of PWM1 period, S/W writes BFh to INTFLG2 to clear this flag.	
0311	85h INTFLG2	5	PWM0IF	R/W	0	PWM0 interrupt enable Set by H/W at the end of PWM0 period, S/W writes DFh to INTFLG2 to clear this flag.
		7	SMOD	R/W	0	Set 1 to enable UART double baud rate
		3	GF1	R/W	0	General purpose flag bit
87h	PCON	2	GF0	R/W	0	General purpose flag bit
		1	PD	R/W	0	Power down control bit, set 1 to enter STOP mode
		0	IDL	R/W	0	Idle control bit, set 1 to enter IDLE mode
		7	TF1	R/W	0	Timer1 overflow flag Set by H/W when Timer/Counter 1 overflows. Cleared by H/W when CPU vectors into the interrupt service routine.
		6	TR1	R/W	0	Timer1 run control. 1: timer runs; 0: timer stops
		5	TF0	R/W	0	Timer0 overflow flag Set by H/W when Timer/Counter 0 overflows. Cleared by H/W when CPU vectors into the interrupt service routine.
		4	TR0	R/W	0	Timer0 run control. 1:timer runs; 0:timer stops
88h	TCON	3	IE1	R/W	0	External Interrupt 1 (INT1 pin) edge flag Set by H/W when an INT1 pin falling edge is detected. Cleared by H/W when CPU vectors into the interrupt service routine.
		2	IT1	R/W	0	External Interrupt 1 control bit  0: Low level active (level triggered) for INT1 pin  1: Falling edge active (edge triggered) for INT1 pin
		1	IE0	R/W	0	External Interrupt 0 (INT0 pin) edge flag Set by H/W when an INT0 pin falling edge is detected. Cleared by H/W when CPU vectors into the interrupt service routine.
		0	IT0	R/W	0	External Interrupt 0 control bit  0: Low level active (level triggered) for INT0 pin  1: Falling edge active (edge triggered) for INT0 pin



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
						Timer1 gating control bit
		7	GATE1	R/W	0	0: Timer1 enable when TR1 bit is set
						1: Timer1 enable only while the INT1 pin is high and TR1 bit is set
			CTT13.I	D 411		Timer1 Counter/Timer select bit
		6	CT1N	R/W	0	0: Timer mode, Timer 1 data increases at 2 System clock cycle rate
		-				1: Counter mode, Timer1 data increases at T1 pin's negative edge Timer1 mode select
						00: 8-bit timer/counter (TH1) and 5-bit prescaler (TL1)
						01: 16-bit timer/counter
		5~4	-4 TMOD1	R/W	00	10: 8-bit auto-reload timer/counter (TL1). Reloaded from TH1 at
						overflow.
						11: Timer1 stops
89h	TMOD					Timer0 gating control bit
		3	GATE0	R/W	0	0: Timer0 enable when TR0 bit is set
						1: Timer0 enable only while the INT0 pin is high and TR0 bit is set
			CTON	D/XX	0	Timer0 Counter/Timer select bit
		2	CT0N	R/W	0	0: Timer mode, Timer0 data increases at 2 System clock cycle rate 1: Counter mode, Timer0 data increases at T0 pin's negative edge
						Timer0 mode select
						00: 8-bit timer/counter (TH0) and 5-bit prescaler (TL0)
						01: 16-bit timer/counter
	1~0	1~0 TMOD0	R/W	00	10: 8-bit auto-reload timer/counter (TL0). Reloaded from TH0 at	
						overflow.
						11: TL0 is an 8-bit timer/counter.
						TH0 is an 8-bit timer/counter using Timer1's TR1 and TF1 bits.
8Ah	TL0	7~0	TL0	R/W	00h	Timer0 data low byte
8Bh	TL1	7~0	TL1	R/W	00h	Timer1 data low byte
8Ch	TH0	7~0	TH0	R/W	00h	Timer0 data high byte
8Dh	TH1	7~0	TH1	R/W	00h	Timer1 data high byte
90h	P1	7~0	P1	R/W	FFh	Port1 data
91h	POOE	7~0	P0OE	R/W	00h	Port0 CMOS Push-Pull output enable control 0: Disable
9111	FUCE	7~0	TOOL	IX/ VV	OOH	1: Enable
		$\dagger$				LCD 1/2 bais Output
		3	P1LOE3	R/W	0	0: Disable
						1: P15 as LCD 1/2 bais Output
		-				LCD 1/2 bais Output
		2	P1LOE2	R/W	0	0: Disable
	h P1LOE		TILOLZ	10/11	U	1: P14 as LCD 1/2 bais Output
92h		$\vdash$				LCD 1/2 bais Output
		1	P1LOE1	R/W	0	0: Disable
		1	TILOLI	IX/ VV	U	1: P13 as LCD 1/2 bais Output
			D1LOE0	D/W	0	LCD 1/2 bais Output
		0	P1LOE0	R/W	0	0: Disable
						1: P12 as LCD 1/2 bais Output



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
						UART TXD/RXD pin select
		7	TXRXSEL	R/W	0	0: P31 as TXD, P30 as RXD
						1: P16 as TXD, P02 as RXD
						Timer2 signal output (T2O) control
		6	T2OE	R/W	0	0: Disable "Timer2 overflow divided by 2" output to P1.0 pin
						1: Enable "Timer2 overflow divided by 2" output to P1.0 pin
		_	TIOE	D/W	0	Timer1 signal output (T10) control
93h	PINMOD	5	T1OE	R/W	0	0: Disable "Timer1 overflow divided by 2" output to P3.5 pin 1: Enable "Timer1 overflow divided by 2" output to P3.5 pin
		4	T0OE	R/W	0	Timer0 signal output (T0O) control 0: Disable "Timer0 overflow divided by 64" output to P3.4 pin
		4	TOOL	IX/ VV	U	1: Enable "Timer0 overflow divided by 64" output to P3.4 pin
						P2.1 Pin Control
		3~2	P2MOD1	R/W	01	00: Mode0; 01: Mode1; 10: Mode2; 11: not defined
		1~0	P2MOD0	R/W	01	P2.0 Pin Control
		1 0	12111000	10/11	01	00: Mode0; 01: Mode1; 10: Mode2; 11: not defined
		7	UART1W	R/W	0	Set 1 to enable one wire UART mode, both TXD/RXD use P3.1 pin or P1.6.
						Watchdog Timer pre-scalar time select
		<i>-</i> 1	WDTDGG	D/W	00	00: 400ms WDT overflow rate
		5~4	WDTPSC	R/W	00	01: 200ms WDT overflow rate 10: 100ms WDT overflow rate
						11: 50ms WDT overflow rate
						ADC clock rate select
94h	OPTION		ADCKS	R/W		00: F <sub>SYSCLK</sub> /32
		3~2			00	01: F <sub>SYSCLK</sub> /16
						10: F <sub>SYSCLK</sub> /8 11: F <sub>SYSCLK</sub> /4
						Timer3 Interrupt rate
						00: Timer3 Interrupt rate is 32768 Slow clock cycle
		1~0	TM3PSC	R/W	00	01: Timer3 Interrupt rate is 16384 Slow clock cycle
						10: Timer3 Interrupt rate is 8192 Slow clock cycle
						11: Timer3 Interrupt rate is 128 Slow clock cycle ADC interrupt flag
		4	ADIF	R/W	0	Set by H/W at the end of ADC conversion. S/W writes EFh to
						INTFLG or sets the ADSOC bit to clear this flag.
						External Interrupt 2 (INT2 pin) edge flag
		2	IE2	R/W	0	Set by H/W when a falling edge is detected on the INT2 pin, no matter the EX2 is 0 or 1. It is cleared automatically when the
		_	122	10 11	O	program performs the interrupt service routine. S/W can write FBh
						to INTFLG to clear this bit.
95h	INTFLG					Port1 pin change Interrupt flag
						Set by H/W when a Port1 pin state change is detected and its interrupt enable bit is set (P0WKUP/P1WKUP/P2WKUP/P3WKUP). PXIE
		1	PXIF	R/W	0	does not affect this flag's setting. It is cleared automatically when the
						program performs the interrupt service routine. S/W can write FDh to
						INTFLG to clear this bit.
						Timer3 Interrupt Flag Set by H/W when Timer3 reaches TM3PSC setting cycles. It is
		0	TF3	R/W	0	cleared automatically when the program performs the interrupt
						service routine. S/W can write FEh to INTFLG to clear this bit.
						P1.7~P1.0 pin individual Wake-up/Interrupt enable control
96h	P1WKUP	7~0	P1WKUP	R/W	00h	0: Disable;
		7~0	SWRST	W		1: Enable. Write 56h to generate S/W Reset
		/~0	2 M V2 I	٧٧		Write 65h, the available range of flash memory IAP is 0000h~1FEFh
071	CHICLE	7.0	IADATI	***		(IAPALL read back value is 1)
97h	SWCMD	7~0	IAPALL	W		Write 00h, the available range of flash memory IAP is 1F00h~1EFFh
					_	(IAPALL read back value is 0)
		1	WDTO	R	0	WatchDog Time-Out flag



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
		٥	TABATT	J	•	0: Flash memory 0000h~1EFFh cannot use IAP, only 1F00h~1EFFh
		0	IAPALL	R	0	can use IAP 1: Flash memory 0000h~1EFFh and 1F00h~1EFFh can use IAP.
		7	SM0	R/W	0	UART Serial port mode select bit 0, 1 (SM0, SM1) =
						00: Mode0: 8 bit shift register, Baud Rate=F <sub>SYSCLK</sub> /2
		6	SM1	R/W	0	01: Mode1: 8 bit UART, Baud Rate is variable
						10: Mode2: 9 bit UART, Baud Rate=F <sub>SYSCLK</sub> /32 or /64 11: Mode3: 9 bit UART, Baud Rate is variable
						Serial port mode select bit 2
						SM2 enables multiprocessor communication over a single serial line
		5	SM2	R/W	0	and modifies the above as follows. In Modes 2 & 3, if SM2 is set
						then the received interrupt will not be generated if the received ninth data bit is 0. In Mode 1, the received interrupt will not be generated
0.01						unless a valid stop bit is received. In Mode 0, SM2 should be 0.
98h	SCON	4	REN	R/W	0	Set 1 to enable UART Reception
		3	TB8	R/W	0	Transmitter bit 8, ninth bit to transmit in Modes 2 and 3
		2	RB8	R/W	0	Receive Bit 8, contains the ninth bit that was received in Mode 2 and 3 or the stop bit is Mode 1 if SM2=0
						Transmit Interrupt flag
		1	TI	R/W	0	Set by H/W at the end of the eighth bit in Mode 0, or at the
						beginning of the stop bit in other modes. Must be cleared by S/W
						Receive Interrupt flag  Set by H/W at the end of the eighth bit in Mode 0, or at the
		0	RI	R/W	0	sampling point of the stop bit in other modes. Must be cleared by
						S/W.
99h	CDITE	7~0	SBUF	R/W		UART transmit and receive data. Transmit data is written to this
9911	SBUF	/~0	SBUF	K/W	-	location and receive data is read from this location, but the paths are independent.
		7~2	P2.7~P2.2	R/W	FFh	P2.7~P2.2 have no pin out, so these bits are used as general purpose
A0h	P2					register
		1~0	P2.1~P2.0	R/W	11	P2.1~P2.0 data PWM1 clock source
						00: F <sub>SYSCLK</sub>
		7~6	PWM1CKS	R/W	00	01: F <sub>SYSCLK</sub>
						10: FRC
						11: FRCx2 (V <sub>CC</sub> >2.7V) PWM0 clock source
A1h	PWMCON					00: F <sub>SYSCLK</sub>
		3~2	PWM0CKS	R/W	00	01: F <sub>SYSCLK</sub>
						10: FRC 11: FRCx2 (V <sub>CC</sub> >2.7V)
		1	PWM0NMSK	R/W	0	PWM0N mask data while CLRPWM0=1
			PWM0PMSK	R/W	0	PWM0N mask data while CLRPWM0=1
		7~6	P1MOD3	R/W	01	P1.3 Pin Control
		, 3	1111000	10 11	01	00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3
<u>, .</u> .		5~4	P1MOD2	R/W	01	P1.2 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3
A2h	P1MODL	3~2	P1MOD1	R/W	01	P1.1 Pin Control
		ے~∠	TIMODI	IX/ VV	01	00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P1.1 is ADC input
		1~0	P1MOD0	R/W	01	P1.0 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P1.0 is ADC input
		7 (	DIMODZ	D /557	0.1	P1.7 Pin Control
		7~6	P1MOD7	R/W	01	00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P1.7 is ADC input
		5~4	P1MOD6	R/W	01	P1.6 Pin Control
A3h	h <b>P1MODH</b> 3		D12.505.5	D /777	0.1	00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3 P1.5 Pin Control
		3~2	P1MOD5	R/W	01	00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3
		1~0	P1MOD4	R/W	01	P1.4 Pin Control
						00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3 P3.3 Pin Control
A4h	P3MODL	7~6	P3MOD3	R/W	01	00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P3.3 is ADC input
		5~4	P3MOD2	R/W	01	P3.2 Pin Control



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
	222					00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P3.2 is ADC input
		3~2	P3MOD1	R/W	01	P3.1 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P3.1 is ADC input
		1~0	P3MOD0	R/W	01	P3.0 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P3.0 is ADC input
		7~6	P3MOD7	R/W	01	P3.7 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3
A5h	РЗМОДН	5~4	P3MOD6	R/W	01	P3.6 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3
		3~2	P3MOD5	R/W	01	P3.5 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3
		1~0	P3MOD4	R/W	01	P3.4 Pin Control 00: Mode0; 01: Mode1; 10: Mode2; 11: Mode3, P3.4 is ADC input
		7	PWM1OE3	R/W	0	PWM1 output control 0: Disable 1: PWM1 enable and output to P1.2
		6	PWM1OE2	R/W	0	PWM1 output control 0: Disable 1: PWM1 enable and output to P0.6
	6h <b>PWMOE0</b>	5	PWM1OE1	R/W	0	PWM1 output control 0: Disable 1: PWM1 enable and output to P0.4
A C1		4	PWM1OE0	R/W	0	PWM1 output control 0: Disable 1: PWM1 enable and output to P0.2
A6h		3	PWM0NOE1	R/W	0	PWM0N output control 0: Disable 1: PWM0N enable and output to P3.6
		2	PWM0POE1	R/W	0	PWM0P output control 0: Disable 1: PWM0P enable and output to P3.5
		1	PWM0NOE0	R/W	0	PWM0N output control 0: Disable 1: PWM0N enable and output to P0.4
		0	PWM0POE0	R/W	0	PWM0P output control 0: Disable 1: PWM0P enable and output to P0.3
		7	PWM0MOD	R/W	0	PWM0 mode select 0: Normal mode 1: Half-bridge mode
		6	PWM0MSKE	R/W	0	PWM0 mask output enable 0: Disable 1: Enable, PWM0P/PWM0N output data by PWM0PMSK/PWM0NMSK while CLRPWM0=1
A7h	PWMCON2	5~4	PWM0OM	R/W	00	PWM0 output mode select 00: Mode0 01: Mode1 10: Mode2 11: Mode3
		3~0	PWM0DZ	R/W	0000	PWM0 dead zone (Dead zone is prohibited in half-bridge mode) 0000: 0 x T <sub>PWMCLK</sub> 0001: 1 x T <sub>PWMCLK</sub>
		7	EA	R/W	0	1111: 15 x T <sub>PWMCLK</sub> Global interrupt enable control.  0: Disable all Interrupts.  1: Each interrupt is enabled or disabled by its own interrupt control bit.
		5	ET2	R/W	0	Set 1 to enable Timer2 interrupt
A8h	IE	4	ES	R/W	0	Set 1 to enable Serial Port (UART) Interrupt
		2	ET1 EX1	R/W R/W	0	Set 1 to enable Timer1 Interrupt  Set 1 to enable external INT1 pin Interrupt & Stop mode wake up
		1	ET0	R/W	0	Set 1 to enable Timer0 Interrupt
		0	EX0	R/W	0	Set 1 to enable external INTO pin Interrupt & Stop mode wake up capability
A9h	INTE1	7	PWMIE	R/W	0	Set 1 to enable PWM0/PWM1~PWM6 interrupt



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
	2-2-	5	LVDIE	R/W	0	Set 1 to enable LVD interrupt
		4	I2CE	R/W	0	Set 1 to enable I <sup>2</sup> C interrupt
		3	ADIE	R/W	0	Set 1 to enable ADC Interrupt
		2	EX2	R/W	0	Set 1 to enable external INT2 pin Interrupt & Stop mode wake up capability
		1	PXIE	R/W	0	Set 1 to enable Port0/Port1/Port2/Port3 Pin Change Interrupt
		0	TM3IE	R/W	0	Set 1 to enable Timer3 Interrupt
AAh	ADCDL	7~4	ADCDL	R	_	ADC data bit 3~0
ABh	ADCDH	7~0	ADCDH	R	_	ADC data bit 11~4
AEh CHSEL	7~4	ADCHS	R/W	1111	ADC channel select 0000: AD0 (P0.4) 0001: AD1 (P0.3) 0010: AD2 (P1.0) 0011: AD3 (P1.1) 0100: AD4 (P3.3) 0101: AD5 (P3.2) 0110: AD6 (P3.0) 0111: AD7 (P3.1) 1000: AD8 (P3.4) 1001: AD9 (P1.7) 1010: AD10 (P0.7) 1011: AD11 (P0.5) 1100: VBG 1101: Reserved 1110: V <sub>SS</sub> 1111: V <sub>CC</sub> /4	
		2	ADCVREFS	R/W	0	ADC reference voltage 0: V <sub>CC</sub> 1: VBG VBG voltage select, When ADCVREF is selected as VBG, VBGSEL
		1~0	VBGSEL	R/W	00	is prohibited from using 1.22V. 00: 1.22V 01: 2.5V 10: Reserved 11:Reserved
		7	P0DIE7	R/W	0	Port digital input enable 0: P0.7 is ADC input and disable digital input 1: enable P0.7 digital input
		6	P0DIE6	R/W	0	Port digital input enable 0: disable P0.6 digital input 1: enable P0.6 digital input
		5	P0DIE5	R/W	0	Port digital input enable 0: P0.5 is ADC input and disable digital input 1: enable P0.5 digital input
AFh	P0DIE	4	P0DIE4	R/W	0	Port digital input enable 0: P0.4is ADC input and disable digital input 1: enable P0.4 digital input
		3	P0DIE3	R/W	0	Port digital input enable 0: P0.3 is ADC input and disable digital input 1: enable P0.3 digital input
		2	P0DIE2	R/W	0	Port digital input enable 0: disable P0.2 digital input 1: enable P0.2 digital input
		1	P0DIE1	R/W	0	Port digital input enable 0: disable P0.1 digital input 1: enable P0.1 digital input



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
						Port digital input enable
		0	P0DIE0	R/W	0	0: disable P0.0 digital input
						1: enable P0.0 digital input
B0h	Р3	7~0	Р3	R/W	FFh	Port3 data
		7	PWM4OE3	R/W	0	PWM4 output control
		,	1 11111110113	10 11	0	0: Disable 1: PWM4 enable and output to P3.6
		6	PWM4OE2	R/W	0	PWM4 output control
			1 11111110112	10/11	Ü	0: Disable 1: PWM4 enable and output to P1.5
		5	PWM4OE1	R/W	0	PWM4 output control
			TVINITOEI	10 11		0: Disable 1: PWM4 enable and output to P0.4
		4	PWM4OE0	R/W	0	PWM4 output control
B6h	PWMOE1					0: Disable 1: PWM4 enable and output to P0.0
		3	PWM3OE1	R/W	0	PWM3 output control
						0: Disable 1: PWM3 enable and output to P3.4
		2	PWM3OE0	R/W	0	PWM3 output control
						0: Disable 1: PWM3 enable and output to P1.0
		1	PWM2OE1	R/W	0	PWM2 output control
						0: Disable 1: PWM2 enable and output to P3.6
		0	PWM2OE0	R/W	0	PWM2 output control 0: Disable 1: PWM2 enable and output to P1.1
						Master I <sup>2</sup> C SDA select
		7	MSDASEL	R/W	0	0: P3.5 as Master I <sup>2</sup> C SDA
		,	1110211022	10 11	0	1: P1.6 as Master I <sup>2</sup> C SDA
						Master I <sup>2</sup> C SCL select
		6	MSCLSEL	R/W	0	0: P1.3 as Master I <sup>2</sup> C SCL
	<u> </u>					1: P0.2 as Master I <sup>2</sup> C SCL
		5	DWMGOEO	R/W	0	PWM6 output control
		3	PWM6OE2	IX/ VV	U	0: Disable 1: PWM6 enable and output to P1.3
B7h	PWMOE2	4	PWM6OE1	R/W	0	PWM6 output control
D/II	1 WMOE2		1 WIMOOLI	10 11		0: Disable 1: PWM6 enable and output to P0.7
		3	PWM6OE0	R/W	0	PWM6 output control
						0: Disable 1: PWM6 enable and output to P0.3
		2	PWM5OE2	R/W	0	PWM5 output control
						0: Disable 1: PWM5 enable and output to P1.4
		1	PWM5OE1	R/W	0	PWM5 output control 0: Disable 1: PWM5 enable and output to P0.6
						PWM5 output control
		0	PWM5OE0	R/W	0	0: Disable 1: PWM5 enable and output to P0.1
		5	PT2	R/W	0	Timer2 Interrupt Priority Low bit
		4	PS	R/W	0	Serial Port (UART) Interrupt Priority Low bit
D.O.		3	PT1	R/W	0	Timer1 Interrupt Priority Low bit
B8h	IP	2	PX1	R/W	0	External INT1 Pin Interrupt Priority Low bit
		1	PT0	R/W	0	Timer0 Interrupt Priority Low bit
		0	PX0	R/W	0	External INTO Pin Interrupt Priority Low bit
		5	PT2H	R/W	0	Timer2 Interrupt Priority High bit
		4	PSH	R/W	0	Serial Port (UART) Interrupt Priority High bit
B9h	Трш	3	PT1H	R/W	0	Timer1 Interrupt Priority High bit
וולט	ı IPH	2	PX1H	R/W	0	External INT1 Pin Interrupt Priority High bit
		1	PT0H	R/W	0	Timer0 Interrupt Priority High bit
		0	PX0H	R/W	0	External INTO Pin Interrupt Priority High bit
		7	PPWM	R/W	0	PWM0/PWM1 Interrupt Priority Low bit
BAh	IP1	5	PLVD	R/W	0	LVD Interrupt Priority Low bit
		4	PI2C	R/W	0	I <sup>2</sup> C Interrupt Priority Low bit



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
		3	PADI	R/W	0	ADC Interrupt Priority Low bit
		2	PX2	R/W	0	External INT2 Pin Interrupt Priority Low bit
		1	PPX	R/W	0	Port0~Port3 pin change Interrupt Priority Low bit
		0	PT3	R/W	0	Timer3 Interrupt Priority Low bit
		7	PPWMH	R/W	0	PWM0/PWM1 Interrupt Priority High bit
		5	PLVDH	R/W	0	LVD Interrupt Priority High bit
		4	PI2CH	R/W	0	I <sup>2</sup> C Interrupt Priority High bit
BBh	IP1H	3	PADIH	R/W	0	ADC Interrupt Priority High bit
		2	PX2H	R/W	0	External INT2 Pin Interrupt Priority High bit
		1	PPXH	R/W	0	Port0~Port3 Interrupt Priority High bit
		0	PT3H	R/W	0	Timer3 Interrupt Priority High bit
						P0.7~P0.0 pin individual Wake-up/Interrupt enable control
C5h	P0WKUP	7~0	P0WKUP	R/W	00h	0: Disable; 1: Enable.
						P2.7~P2.0 pin individual Wake-up/Interrupt enable control
C6h	P2WKUP	7~0	P2WKUP	R/W	00h	0: Disable;
						1: Enable.
g=:			DAIL!	D ~~~	001	P3.7~P3.0 pin individual Wake-up/Interrupt enable control
C7h	P3WKUP	7~0	P3WKUP	R/W	00h	0: Disable;
						1: Enable. Timer2 overflow flag
		7	TF2	R/W	0	Set by H/W when Timer/Counter 2 overflows unless RCLK=1 or
						TCLK=1. This bit must be cleared by S/W.
			EVE	D 411		T2EX interrupt pin falling edge flag
		6	EXF2	R/W	0	Set when a capture or a reload is caused by a negative transition on T2EX pin if EXEN2=1. This bit must be cleared by S/W.
						UART receive clock control bit
		5	RCLK	R/W	0	0: Use Timer1 overflow as receive clock for serial port in mode 1 or 3
						1: Use Timer2 overflow as receive clock for serial port in mode 1 or 3
						UART transmit clock control bit
		4	TCLK	R/W	0	0: Use Timer1 overflow as transmit clock for serial port in mode 1 or 3
			TCLIK	10 11		1: Use Timer2 overflow as transmit clock for serial port in mode 1 or
						3
C01	TACON					T2EX pin enable
C8h	T2CON	3	EXEN2	R/W	0	0: T2EX pin disable 1: T2EX pin enable, it cause a capture or reload when a negative
						transition on T2EX pin is detected if RCLK=TCLK=0
						Timer2 run control
		2	TR2	R/W	0	0:timer stops
		$\vdash$				1:timer runs Timer2 Counter/Timer select bit
		1	CT2N	R/W	0	0: Timer mode, Timer2 data increases at 2 System clock cycle rate
						1: Counter mode, Timer2 data increases at T2 pin's negative edge
						Timer2 Capture/Reload control bit
						0: Reload mode, auto-reload on Timer2 overflows or negative transitions on T2EX pin if EXEN2=1.
		0	CPRL2N	R/W	0	transitions on 12EX pin if EXENZ=1.  1: Capture mode, capture on negative transitions on T2EX pin if
				''		EXEN2=1.
						If RCLK=1 or TCLK=1, CPRL2N is ignored and timer is forced
						to auto-reload on Timer2 overflow.
		7~0	IAPWE	W		Write 47h to set IAPWE control flag; Write other value to clear IAPWE flag. It is recommended to clear it immediately after IAP
		,~0	IMI WE	**	_	write.
						Flag indicates Flash memory can be written by IAP or not
C9h	IAPWE	7	IAPWE	R	0	0: IAP Write disable
						1: IAP Write enable
			I A DTO	D		IAP Time-Out flag
		6	IAPTO	R	0	Set by H/W when IAP Time-out occurs. Cleared by H/W when IAPWE=0.
				1		Cleared by 11/ W WHOLI IAI WE-U.



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
CAh	RCP2L	7~0	RCP2L	R/W	00h	Timer2 reload/capture data low byte
CBh	RCP2H	7~0	RCP2H	R/W	00h	Timer2 reload/capture data high byte
CCh	TL2	7~0	TL2	R/W	00h	Timer2 data low byte
CDh	TH2	7~0	TH2	R/W	00h	Timer2 data high byte
CEh	EXA2	7~0	EXA2	R/W	00h	Expansion accumulator 2
CFh	EXA3	7~0	EXA3	R/W	00h	Expansion accumulator 3
		7	CY	R/W	0	ALU carry flag
		6	AC	R/W	0	ALU auxiliary carry flag
		5	F0	R/W	0	General purpose user-definable flag
		4	RS1	R/W	0	Register Bank Select bit 1
D0h	PSW	3	RS0	R/W	0	Register Bank Select bit 0
		2	OV	R/W	0	ALU overflow flag
		1	F1	R/W	0	General purpose user-definable flag
		0	P	R/W	0	Parity flag
D1h	PWM0DH	7~0	PWM0DH	R/W	00h	PWM0 duty high byte
D2h	PWM0DL	7~0	PWM0DL	R/W	00h	PWM0 duty low byte
D3h	PWM1DH	7~0	PWM1DH	R/W	00h	PWM1 duty high byte
D4h	PWM1DL	7~0	PWM1DL	R/W	00h	PWM1 duty low byte
D5h	PWM2DH	7~0	PWM2DH	R/W	00h	PWM2 duty high byte
D6h	PWM2DL	7~0	PWM2DL	R/W	00h	PWM2 duty low byte
		4		R/W	0	Set 1 to stop UART/Timer0/1/2 clock in Idle mode for current
		4	STPPCK	K/W	0	reducing.
	CLKCON	3	STPFCK	R/W	0	Set 1 to stop Fast clock for power saving in Slow/Idle mode. This bit
			BITTER	10 11		can be changed only in Slow mode.
		2	SELFCK	R/W	0	System clock select. This bit can be changed only when STPFCK=0.
D8h						0: Slow clock 1: Fast clock
						System clock prescaler. Effective after 16 clock cycles (Max.) delay.
						00: System clock is Fast/Slow clock divided by 16
		1~0	CLKPSC	R/W	11	01: System clock is Fast/Slow clock divided by 4
						10: System clock is Fast/Slow clock divided by 2
						11: System clock is Fast/Slow clock divided by 1
	PWM0PRDH				FFh	PWM0 period high byte
DAh	PWM0PRDL		PWM0PRDL	R/W	FFh	PWM0 period low byte
	PWM1PRDH			R/W	FFh	PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 period high byte
DCh	PWM1PRDL			R/W	FFh	PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 period low byte
DDh	PWM3DH	7~0		R/W	00h	PWM3 duty high byte
DEh	PWM3DL		PWM3DL	R/W		PWM3 duty low byte
E0h	ACC	7~0	ACC	R/W	00h	Accumulator
		7	MIEN	R/W	0	Master I <sup>2</sup> C enable 0: disable
		/	MIEN	IN/ W	0	1: enable
						When Master I <sup>2</sup> C receive data, send acknowledge to I <sup>2</sup> C Bus
		6	MIACKO	R/W	0	0: ACK to slave device
						1: NACK to slave device
						Master I <sup>2</sup> C Interrupt flag
		5	MIIF	R/W	0	0: write 0 to clear it
						1: Master I <sup>2</sup> C transfer one byte complete  When Master I <sup>2</sup> C transfer, acknowledgement form I <sup>2</sup> C bus (read
E1h	MICON					when Master I <sup>*</sup> C transfer, acknowledgement form I <sup>*</sup> C bus (read only)
		4	MIACKI	R	_	0: ACK received
						1: NACK received
		2	MICTARE	D /117	^	Master I <sup>2</sup> C Start bit
		3	MISTART	R/W	0	1: start I <sup>2</sup> C bus transfer
		2	MISTOP	R/W	1	Master I <sup>2</sup> C Stop bit
				17 11	•	1: send STOP signal to stop I <sup>2</sup> C bus
			MICD	D/W	00	Master I <sup>2</sup> C (SCL) clock frequency selection
		1~0	MICR	R/W	00	00: Fsys/4 (ex. If Fsys=16MHz, I <sup>2</sup> C clock is 4M Hz) 01: Fsys/16 (ex. If Fsys=16MHz, I <sup>2</sup> C clock is 1M Hz)
	l					01. 15ys/10 (ex. 11 fsys=10Mmz, 1 C clock is 1M mz)



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
						10: Fsys/64 (ex. If Fsys=16MHz, I <sup>2</sup> C clock is 250K Hz)
						11: Fsys/256 (ex. If Fsys=16MHz, 1 <sup>2</sup> C clock is 62.5K Hz)
						Master I <sup>2</sup> C data shift register
						(W): After Start and before Stop condition, write this register will
E2h	MIDAT	7~0	MIDAT	R/W	00	resume transmission to I <sup>2</sup> C bus
						(R): After Start and before Stop condition, read this register will
			LUBIE	D /III		resume receiving from I <sup>2</sup> C bus
		4	LVDIF	R/W	0	LVD interrupt flag, write 0 to clear this bit
						LVDSEL: Low Voltage detect select
						0000: LVD disable
						0001: Set LVD at 2.30V
						0010: Set LVD at 2.45V
						0011: Set LVD at 2.55V
						0100: Set LVD at 2.70V
						0101: Set LVD at 2.85V
E4h	LVDCON					0110: Set LVD at 3.00V
		3~0	LVDSEL	R/W	0h	0111: Set LVD at 3.15V
						1000: Set LVD at 3.30V
						1001: Set LVD at 3.45V
						1010: Set LVD at 3.60V
						1011: Set LVD at 3.75V
						1100: Set LVD at 3.90V
						1101: Set LVD at 4.05V
						1110: Set LVD at 4.20V
	1111: Set LVD at 4.35V					
F.51	******	7.0	LUDDD	***	0.01	LVRPD: LVR and POR power down option
E5h	LVRPD	7~0	LVRPD	W	00h	Write 0x37 to force LVR disable, POR disable
Ect.	ESZ A	7.0	EVA	D/W	001-	Write 0x38 to force LVR disable, POR enable
E6h E7h	EXA EXB	7~0 7~0	EXA EXB	R/W R/W	00h 00h	Expansion accumulator Expansion B register
E9h	PWM4DH	7~0	PWM4DH	R/W	00h	PWM4 duty high byte
EAh	PWM4DL	7~0	PWM4DL	R/W	00h	PWM4 duty low byte
EBh	PWM5DH	7~0	PWM5DH	R/W	00h	PWM5 duty high byte
ECh	PWM5DL	7~0	PWM5DL	R/W	00h	PWM5 duty low byte
EDh	PWM6DH	7~0	PWM6DH	R/W	00h	PWM6 duty high byte
EEh	PWM6DL	7~0	PWM6DL	R/W	00h	PWM6 duty low byte
F0h	В	7~0	В	R/W	00h	B register
F1h	CRCDL	7~0	CRCDL	R/W	FFh	16-bit CRC data bit 7~0
F2h	CRCDH	7~0	CRCDH	R/W	FFh	16-bit CRC data bit 15~8
F3h	CRCIN	7~0	CRCIN	W	-	CRC input data
F5h	CFGBG	3~0	BGTRIM	R/W	_	VBG trimming value
				l		FRC frequency adjustment
F6h	CFGWL	6~0	FRCF	R/W	_	00h: lowest frequency
<u> </u>						7Fh: highest frequency
						Watchdog Timer Reset control 0x: WDT disable
		7~6	WDTE	R/W	_	10: WDT disable 10: WDT enable in Fast/Slow mode, disable in Idle/Stop mode
						11: WDT always enable
		5	PWRSAV	R/W	-	Set 1 to reduce the chip's power consumption at Idle and Stop Mode.
						Bandgap voltage output control
F7h	AUX2	4	VBGOUT	R/W	0	0: P3.2 as normal I/O
r/n	AUAZ					1: Bandgap voltage output to P3.2 pin, when ADCHS = 4'b1100
						only active when MULDVI16 =1
		3	DIV32	R/W	0	0: instruction DIV as 16/16 bit division operation
						1: instruction DIV as 32/16 bit division operation
		2 1	IADOD	D /137	1 1	IAP (or EEPROM write) watchdog timer enable
		2~1	IAPTE	R/W	11	00: Disable
						01: wait 0.9mS trigger watchdog time-out flag



Adr	SFR	Bit#	Bit Name	R/W	Rst	Description
						10: wait 3.6mS trigger watchdog time-out flag
						11: wait 7.2mS trigger watchdog time-out flag
		0	MULDIV16	R/W	0	0: instruction MUL/DIV as 8*8, 8/8 operation
		U	WICEDIVIO	IX/ VV	U	1: instruction MUL/DIV as 16*16, 16/16 or 32/16 operation
		7	CLRWDT	R/W	0	Set 1 to clear WDT, H/W auto clear it at next clock cycle
		6	CLRTM3	R/W	0	Set 1 to clear Timer3, HW auto clear it at next clock cycle.
	AUX1					force VBG generator enable
		5	VBGEN	R/W	0	0: VBG generator is automatically enable and disable
						1: Force VBG generator enable except in IDLE and STOP mode.
			ADSOC	R/W		ADC Start of Conversion
<b>T</b> 01					1	Set 1 to start ADC conversion. Cleared by H/W at the end of
F8h						conversion. S/W can also write 0 to clear this flag.
			CLRPWM0			PWM0 clear enable
		3				0: PWM0 is running
						1: PWM0 is cleared and held
		2	2 CLRPWM1	R/W		PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 clear enable
					1	0: PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 is running
						1: PWM1/PWM2/PWM3/PWM4/PWM5/PWM6 is cleared and held
		0	DPSEL	R/W	0	Active DPTR Select

Adr	Flash	Bit#	Bit Name	Description
1FFBh	CFGBG	3~0	BGTRIM	FRC frequency adjustment. VBG is trimmed to 1.22V in chip manufacturing. BGTRIM records the adjustment data.
1FFDh	CFGWL	6~0	FRCF	FRC frequency adjustment. FRC is trimmed to 16.588 MHz in chip manufacturing. FRCF records the adjustment data.
		7	PROT	Flash Code Protect, 1=Protect
		6	XRSTE	External Pin Reset enable, 1=enable.
1FFFh	CFGWH	5~2	LVRE	Low Voltage Reset function select 0000: Set LVR at 2.15V 0001: Set LVR at 2.30V 0010: Set LVR at 2.45V 0011: Set LVR at 2.55V 0100: Set LVR at 2.70V 0101: Set LVR at 2.85V 0110: Set LVR at 3.00V 0111: Set LVR at 3.15V 1000: Set LVR at 3.30V 1001: Set LVR at 3.45V 1010: Set LVR at 3.45V 1010: Set LVR at 3.60V 1011: Set LVR at 3.75V 1100: Set LVR at 3.90V 1101: Set LVR at 4.05V 1110: Set LVR at 4.20V 1111: Set LVR at 4.35V Reserved
		0	FRCPSC	Reserved

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# **INSTRUCTION SET**

Instructions are 1, 2 or 3 bytes long as listed in the 'byte' column below. Each instruction takes  $1\sim8$  System clock cycles to execute as listed in the 'cycle' column below.

ARITHMETIC						
Mnemonic	Description	byte	cycle	opcode		
ADD A,Rn	Add register to A	1	2	28-2F		
ADD A,dir	Add direct byte to A	2	2	25		
ADD A,@Ri	Add indirect memory to A	1	2	26-27		
ADD A,#data	Add immediate to A	2	2	24		
ADDC A,Rn	Add register to A with carry	1	2	38-3F		
ADDC A,dir	Add direct byte to A with carry	2	2	35		
ADDC A,@Ri	Add indirect memory to A with carry	1	2	36-37		
ADDC A,#data	Add immediate to A with carry	2	2	34		
SUBB A,Rn	Subtract register from A with borrow	1	2	98-9F		
SUBB A,dir	Subtract direct byte from A with borrow	2	2	95		
SUBB A,@Ri	Subtract indirect memory from A with borrow	1	2	96-97		
SUBB A,#data	Subtract immediate from A with borrow	2	2	94		
INC A	Increment A	1	2	04		
INC Rn	Increment register	1	2	08-0F		
INC dir	Increment direct byte	2	2	05		
INC @Ri	Increment indirect memory	1	2	06-07		
DEC A	Decrement A	1	2	14		
DEC Rn	Decrement register	1	2	18-1F		
DEC dir	Decrement direct byte	2	2	15		
DEC @Ri	Decrement indirect memory	1	2	16-17		
INC DPTR	Increment data pointer	1	4	A3		
MUL AB	Multiply A by B	1	8	A4		
DIV AB	Divide A by B	1	8	84		
DA A	Decimal Adjust A	1	2	D4		

LOGICAL						
Mnemonic	Description	byte	cycle	opcode		
ANL A,Rn	AND register to A	1	2	58-5F		
ANL A,dir	AND direct byte to A	2	2	55		
ANL A,@Ri	AND indirect memory to A	1	2	56-57		
ANL A,#data	AND immediate to A	2	2	54		
ANL dir,A	AND A to direct byte	2	2	52		
ANL dir,#data	AND immediate to direct byte	3	4	53		
ORL A,Rn	OR register to A	1	2	48-4F		
ORL A,dir	OR direct byte to A	2	2	45		
ORL A,@Ri	OR indirect memory to A	1	2	46-47		
ORL A,#data	OR immediate to A	2	2	44		
ORL dir,A	OR A to direct byte	2	2	42		
ORL dir,#data	OR immediate to direct byte	3	4	43		
XRL A,Rn	Exclusive-OR register to A	1	2	68-6F		
XRL A,dir	Exclusive-OR direct byte to A	2	2	65		
XRL A, @Ri	Exclusive-OR indirect memory to A	1	2	66-67		
XRL A,#data	Exclusive-OR immediate to A	2	2	64		
XRL dir,A	Exclusive-OR A to direct byte	2	2	62		
XRL dir,#data	Exclusive-OR immediate to direct byte	3	4	63		
CLR A	Clear A	1	2	E4		
CPL A	Complement A	1	2	F4		
SWAP A	Swap Nibbles of A	1	2	C4		

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	LOGICAL			
Mnemonic	Description	byte	cycle	opcode
RL A	Rotate A left	1	2	23
RLC A	Rotate A left through carry	1	2	33
RR A	Rotate A right	1	2	03
RRC A	Rotate A right through carry	1	2	13

DATA TRANSFER							
Mnemonic	Description	byte	cycle	opcode			
MOV A,Rn	Move register to A	1	2	E8-EF			
MOV A,dir	Move direct byte to A	2	2	E5			
MOV A,@Ri	Move indirect memory to A	1	2	E6-E7			
MOV A,#data	Move immediate to A	2	2	74			
MOV Rn,A	Move A to register	1	2	F8-FF			
MOV Rn,dir	Move direct byte to register	2	4	A8-AF			
MOV Rn,#data	Move immediate to register	2 2	2	78-7F			
MOV dir,A	Move A to direct byte		2	F5			
MOV dir,Rn	Move register to direct byte	2	4	88-8F			
MOV dir,dir	Move direct byte to direct byte	3	4	85			
MOV dir,@Ri	Move indirect memory to direct byte	2	4	86-87			
MOV dir,#data	Move immediate to direct byte	3	4	75			
MOV @Ri,A	Move A to indirect memory	1	2	F6-F7			
MOV @Ri,dir	Move direct byte to indirect memory	2	4	A6-A7			
MOV @Ri,#data	Move immediate to indirect memory	2	2	76-77			
MOV DPTR,#data	Move immediate to data pointer	3	4	90			
MOVC A,@A+DPTR	Move code byte relative DPTR to A	1	4	93			
MOVC A,@A+PC	Move code byte relative PC to A	1	4	83			
MOVX A,@Ri	Move external data(A8) to A	1	4	E2-E3			
MOVX A,@DPTR	Move external data(A16) to A	1	4	E0			
MOVX @Ri,A	Move A to external data(A8)	1	4	F2-F3			
MOVX @DPTR,A	Move A to external data(A16)	1	4	F0			
PUSH dir	Push direct byte onto stack	2	4	C0			
POP dir	Pop direct byte from stack	2	4	D0			
XCH A,Rn	Exchange A and register	1	2	C8-CF			
XCH A,dir	Exchange A and direct byte	2	2	C5			
XCH A,@Ri	Exchange A and indirect memory	1	2	C6-C7			
XCHD A,@Ri	Exchange A and indirect memory nibble	1	2	D6-D7			

BOOLEAN						
Mnemonic	Description	byte	cycle	opcode		
CLR C	Clear carry	1	2	C3		
CLR bit	Clear direct bit	2	2	C2		
SETB C	Set carry	1	2	D3		
SETB bit	Set direct bit	2	2	D2		
CPL C	Complement carry	1	2	В3		
CPL bit	Complement direct bit	2	2	B2		
ANL C,bit	AND direct bit to carry	2	4	82		
ANL C,/bit	AND direct bit inverse to carry	2	4	В0		
ORL C,bit	OR direct bit to carry	2	4	72		
ORL C,/bit	OR direct bit inverse to carry	2	4	A0		
MOV C,bit	Move direct bit to carry	2	2	A2		
MOV bit,C	Move carry to direct bit	2	4	92		



	BRANCHING							
Mnemonic								
ACALL addr 11	Absolute jump to subroutine	2	4 (+2)	11-F1				
LCALL addr 16	Long jump to subroutine	3	4 (+2)	12				
RET	Return from subroutine	1	4 (+2)	22				
RETI	Return from interrupt	1	4 (+2)	32				
AJMP addr 11	Absolute jump unconditional	2	4 (+2)	01-E1				
LJMP addr 16	Long jump unconditional	3	4 (+2)	02				
SJMP rel	Short jump (relative address)	2	4 (+2)	80				
JC rel	Jump on carry = 1	2	4 (or 6)	40				
JNC rel	Jump on carry = 0	2	4 (or 6)	50				
JB bit,rel	Jump on direct bit = 1	3	4 (or 6)	20				
JNB bit,rel	Jump on direct bit = $0$	3	4 (or 6)	30				
JBC bit,rel	Jump on direct bit = 1 and clear	3	4 (or 6)	10				
JMP @A+DPTR	Jump indirect relative DPTR	1	4 (+2)	73				
JZ rel	Jump on accumulator = 0	2	4 (or 6)	60				
JNZ rel	Jump on accumulator 0	2	4 (or 6)	70				
CJNE A,dir,rel	Compare A, direct, jump not equal relative	3	4 (or 6)	B5				
CJNE A,#data,rel	Compare A,immediate, jump not equal relative	3	4 (or 6)	B4				
CJNE Rn,#data,rel	Compare register, immediate, jump not equal relative	3	4 (or 6)	B8-BF				
CJNE @Ri,#data,rel	Compare indirect, immediate, jump not equal relative	3	4 (or 6)	B6-B7				
DJNZ Rn,rel	Decrement register, jump not zero relative	2	4 (or 6)	D8-DF				
DJNZ dir,rel	Decrement direct byte, jump not zero relative	3	4 (or 6)	D5				

MISCELLANEOUS							
Mnemonic	Description	byte	cycle	opcode			
NOP	No operation	1	2	00			

In the above table, an entry such as E8-EF indicates a continuous block of hex opcodes used for 8 different registers, the register numbers of which are defined by the lowest three bits of the corresponding code. Non-continuous blocks of codes, shown as 11-F1 (for example), are used for absolute jumps and calls with the top 3 bits of the code being used to store the top three bits of the destination address.

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# **ELECTRICAL CHARACTERISTICS**

# 1. Absolute Maximum Ratings (T<sub>A</sub>=25°C)

Parameter	Rating	Unit	
Supply voltage	$V_{SS} - 0.3 \sim V_{SS} + 5.5$		
Input voltage	$V_{SS} - 0.3 \sim V_{CC} + 0.3$	V	
Output voltage	$V_{SS} - 0.3 \sim V_{CC} + 0.3$		
Output current high per all PIN	-80	A	
Output current low per all PIN	+150	mA	
Maximum Operating Voltage	5.5	V	
Operating temperature	<b>−</b> 40 ~ +85	°C	
Storage temperature	−65 ~ +150		

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# **2. DC** Characteristics ( $T_A=25$ °C, $V_{CC}=2.3V \sim 5.5V$ )

Parameter	Symbol	Conditions		Min	Тур	Max	Unit	
		F <sub>SYSCLK</sub>	=16.588 MHz	3.00	_	5.5		
Operating Voltage	$V_{CC}$	F <sub>SYSCLE</sub>	<sub>K</sub> =8.694 MHz	2.15	_	5.5	V	
		F <sub>SYSCLE</sub>	<sub>K</sub> =4.147 MHz	2.15	_	5.5		
Input High	V	All Input	V <sub>CC</sub> =5V	0.6V <sub>CC</sub>	_	_	V	
Voltage	$V_{IH}$	An Input	$V_{CC}=3V$	$0.6V_{CC}$	_	-	V	
Input I ov. Voltage	V	All Input	$V_{CC}=5V$	_		$0.2V_{CC}$	V	
Input Low Voltage	$V_{\mathrm{IL}}$	All Input	$V_{CC}=3V$	_	_	$0.2V_{CC}$	V	
I/O Port Source	$I_{OH}$	All Output	$V_{\rm CC}$ =5V, $V_{\rm OH}$ =0.9 $V_{\rm CC}$	7	14	_	mA	
Current	TOH	An Output	$V_{CC}=3V$ , $V_{OH}=0.9V_{CC}$	3.2	6.4	_	ША	
I/O Port Sink	$ m I_{OL}$	All Output,	$V_{CC}=5V,$ $V_{OL}=0.1V_{CC}$	19	38	_	mA	
Current	TOL	7 III Output,	$V_{CC}=3V$ , $V_{OL}=0.1V_{CC}$	9	18	_	1111 1	
		EAST	FRC=16.588 MHz		9.7			
		FAST mode $V_{CC}=5V$ FAST mode $V_{CC}=3V$ SLOW mode	FRC=8.694 MHz	_	6.4	_	mA	
			FRC=4.147 MHz		4.5			
			FRC=16.588 MHz	_	5.4	_		
			FRC=8.694 MHz		3.7			
			FRC=4.147 MHz	_	2.8	_		
			SRC, $V_{CC}=5V$	_	2.8	_		
g 1 G	τ.	SLOW mode	SRC, $V_{CC}=3V$	_	2	_		
Supply Current	$I_{DD}$	IDLE mode	SRC, $V_{CC}=5V$		12			
		(LVRPD=0x37)	SRC, $V_{CC}=3V$		5			
		IDLE mode	SRC, V <sub>CC</sub> =5V	_	24	_		
		(LVRPD=0x38)	SRC, $V_{CC}=3V$		10			
		IDLE mode	SRC, $V_{CC}=5V$		70		μA	
		+ LVR	SRC, $V_{CC}=3V$	_	50	_		
		IDLE mode	SRC, $V_{CC}=5V$		95			
		+ LVR + LVD	SRC, $V_{CC}=3V$		72			
		STOP mode	$V_{CC}=5V$	_	0.1	_		
		5101 mode	$V_{CC}=3V$	_	0.1	_		
g , G' 1			$V_{CC}=3.00V$	_	_	16.588		
System Clock Frequency	F <sub>SYSCLK</sub>	$V_{CC} > LVR_{TH}$	$V_{CC}=2.45V$	_		8.294	MHz	
requency			V <sub>CC</sub> =2.30V	_		4.147		

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-							
				_	4.35	_	
				_	4.20	_	
					4.05		
					3.90		
					3.75		
					3.60		
					3.45		
LVR Reference	***	<b>T</b> 250C			3.30		<b>X</b> 7
Voltage	$V_{LVR}$	$T_A=25$ °C			3.15		V
					3.00		
					2.85		
					2.70		
					2.55		
					2.45		
					2.30		
					2.15		
LVR Hysteresis Voltage	V <sub>HYST</sub>	T <sub>A</sub> =25°C		_	±0.1	_	V
			_	4.35	_		
					4.20		
					4.05		
					3.90		
					3.75		
					3.60		
					3.45		
LVD Reference Voltage	$V_{LVD}$	$T_A=25$ °C			3.30		V
Voltage					3.15		
					3.00		
					2.85		
					2.70		
					2.55		
					2.45		
					2.30		
Low Voltage Detection time	$t_{LVR}$	$T_A=25$ °C		100	1	_	μs
Pull Up Posistor	D		CC=5V		30		ΚO
Pull-Up Resistor	$R_P$		CC=3V		55	_	ΚΩ
	·	L	L				



# 3. Clock Timing $(T_A = -40^{\circ}C \sim +85^{\circ}C)$

Parameter	Condition	Min	Тур	Max	Unit
	25°C, V <sub>CC</sub> =5.0V	-1%	16.588	+1%	
FRC Frequency	$-20$ °C ~ $50$ °C, $V_{CC}$ = $5.0$ V	-1.5%	16.588	+1.5%	MHz
	$-40$ °C ~ 85°C, $V_{CC}$ =3.0 ~ 5.5V	-6%	16.588	+3%	

# 4. Reset Timing Characteristics $(T_A = -40^{\circ}C \sim +85^{\circ}C)$

Parameter	Conditions	Min	Тур	Max	Unit
RESET Input Low width	Input $V_{CC}$ =5V ± 10 %	30	_	_	μs
WDT walsom time	V <sub>CC</sub> =5V, WDTPSC=11	_	51	_	
WDT wakeup time	V <sub>CC</sub> =3V, WDTPSC=11	_	58	_	ms

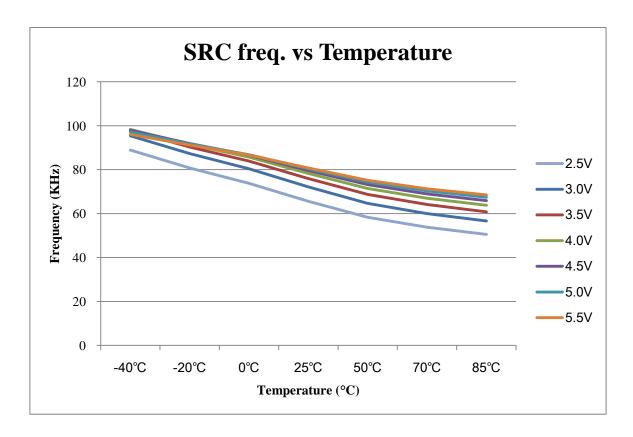
# **5.** ADC Electrical Characteristics ( $T_A$ = 25°C, $V_{CC}$ = 3.0V ~ 5.5V, $V_{SS}$ = 0V)

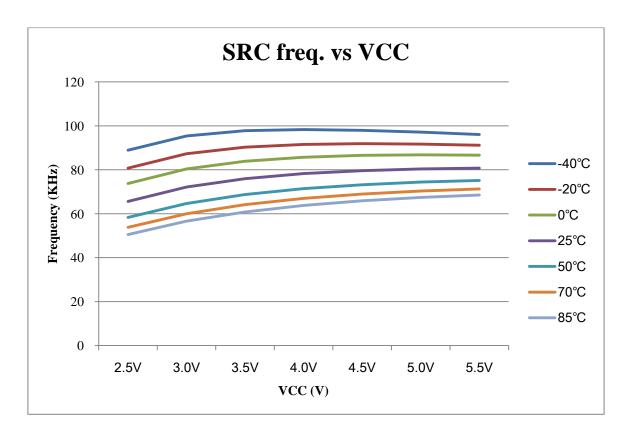
Parameter	Conditions			Тур	Max	Unit	
Total Accuracy	V -	_	±2.5	±4	LSB		
Integral Non-Linearity	V <sub>CC</sub> -	=5.12 V, V <sub>SS</sub> =0V	_	±3.2	±5	LSD	
	Source impe	edance (Rs < 10K omh)	_	_	2		
Max Input Clock (f <sub>ADC</sub> )	Source impe	edance (Rs < 20K omh)	_	_	1	MHz	
Max Input Clock (I <sub>ADC</sub> )	Source impe	edance (Rs < 50K omh)	_	_	0.5	MITIZ	
	Source is V	BG (ADCHS=1100b)	-	_	1.2		
Conversion Time	F	$T_{ADC} = 1 MHz$	_	50	_	μs	
Bandgap Reference	-		V <sub>CC</sub> =2.5V~5.5V 25°C	-1.5%	1.22	+1.5%	
Voltage (V <sub>BG</sub> )		V <sub>CC</sub> =2.5V~5.5V -40°C~85°C	-1.8%	1.22	+1.8%		
ADC Reference	ADCVREFS=1	$V_{\text{CC}}=3V\sim5.5V$ $25^{\circ}\text{C}$	-1.7%	2.5	+1.7%	V	
Voltage (V <sub>ADC</sub> )	ADC V KEFS=1	V <sub>CC</sub> =2.5V~5.5V -40°C~85°C	-2.3%	2.5	+2.3%		
Vcc/4 Reference		V <sub>CC</sub> =5V, 25°C	-0.8%	1.252	+0.8%		
Voltage (V <sub>1/4</sub> )		V <sub>CC</sub> =3.6V, 25°C	-0.8%	0.902	+0.8%		
Input Voltage			$V_{SS}$	_	$V_{CC}$	V	

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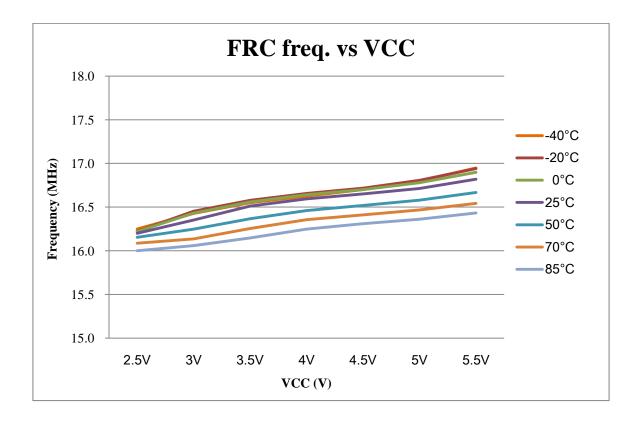
#### 6. Characteristic Graphs

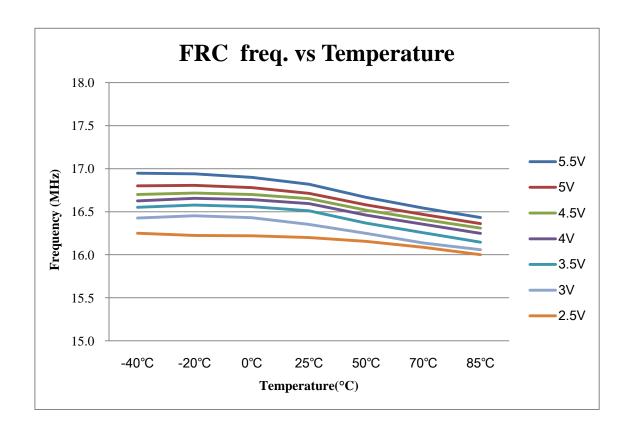




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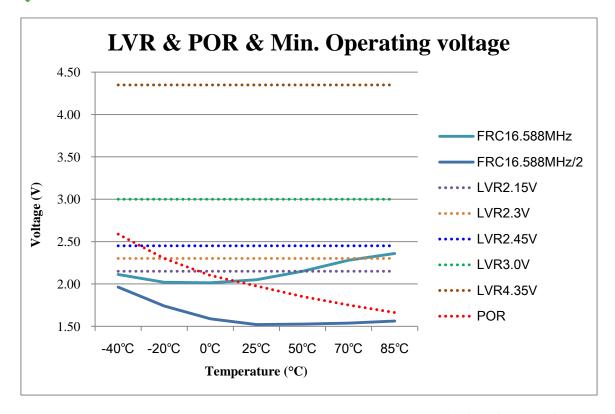




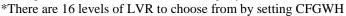


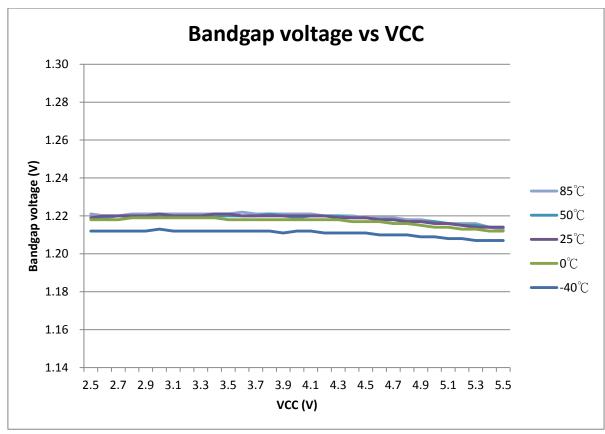
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\*POR: Power on reset. VCC should greater than POR when power on. Due to the variation of the manufacturing process, the POR value will be slightly different between different chips.







# **Package and Dice Information**

Please note that the package information provided is for reference only. Since this information is frequently updated, users can contact Sales to consult the latest package information and stocks.

# **Ordering information**

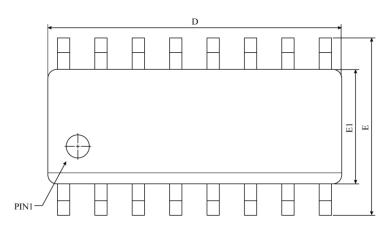
Ordering number	Package
TM52F8368-MTP	Wafer/Dice blank chip
TM52F8368-COD	Wafer/Dice with code
TM52F8368-MTP-16	SOP-16 (150mil)
TM52F8368-MTP-46	TSSOP-20 ( 173mil )
TM52F8368-MTP-21	SOP-20 ( 300mil )
TM52F8368-MTP-28	SSOP-24 ( 150mil )
TM52F8368-MTP-23	SOP-28 (300mil)
TM52F8368-MTP-29	SSOP-28 ( 150mil )
TM52F8368-MTP-B6	QFN 20 (3*3*0.75-0.4mm)
TM52F8368-MTP-D1	QFN-20 (3*3*0.75-0.4mm)(L=0.25mm)
TM52F8368-MTP-C3	QFN-28 (4x4x0.75-0.4mm)

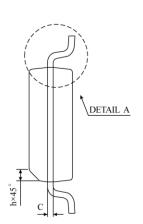
DS-TM52F8368\_E 117 Rev 1.3, 2022/11/11

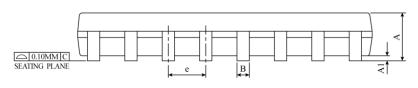


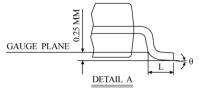
#### **Package Information**

# SOP-16 (150mil) Package Dimension









SYMBOL	DI	MENSION IN M	IM	DIN	IСН	
STMBOL	MIN	NOM	MAX	MIN	NOM	MAX
A	1.35	1.55	1.75	0.0532	0.0610	0.0688
A1	0.10	0.18	0.25	0.0040	0.0069	0.0098
В	0.33	0.42	0.51	0.0130	0.0165	0.0200
С	0.19	0.22	0.25	0.0075	0.0087	0.0098
D	9.80	9.90	10.00	0.3859	0.3898	0.3937
Е	5.80	6.00	6.20	0.2284	0.2362	0.2440
E1	3.80	3.90	4.00	0.1497	0.1536	0.1574
e		1.27 BSC			0.050 BSC	
h	0.25	0.38	0.50	0.0099	0.0148	0.0196
L	0.40	0.84	1.27	0.0160	0.0330	0.0500
θ	0°	4°	8°	0°	4°	8°
JEDEC			MS-01	2 (AC)		

\*NOTES: DIMENSION "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

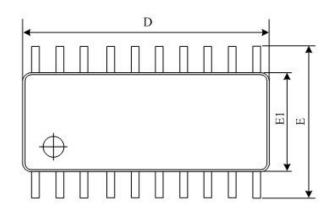
MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL

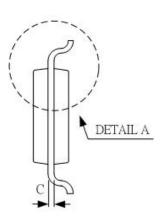
NOT EXCEED 0.15 MM (0.006 INCH) PER SIDE.

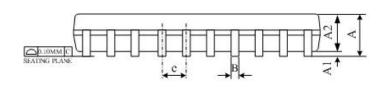
DS-TM52F8368\_E 118 Rev 1.3, 2022/11/11

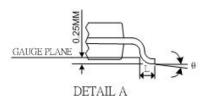


#### TSSOP-20 (173mil) Package Dimension









es a spor	D	IMENSION IN M	IM	DII	MENSION IN	NCH
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
A			1.2	141	*	0.047
Al	0,05	0.10	0.15	0.002	0.004	0,006
A2	0.8	0.93	1.05	0.031	0.036	0.041
В	0.19	-	0.3	0.007	19	0.012
D	6.4	6.5	6.6	0.252	0.256	0.260
E	6.25	6.4	6.55	0.246	0.252	0.258
EI	4.3	4.4	4.5	0.169	0.173	0.177
e		0.65 BSC			0.026 BSC	
L	0.45	0,60	0.75	0.018	0.024	0.030
θ	0 °		8 °	0 °		8 "
JEDEC			MO-153 /	AC REV.F	7.7	

 $DS\text{-}TM52F8368\_E$ 119 Rev 1.3, 2022/11/11

Notes:

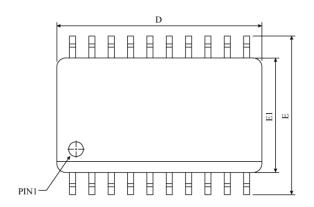
1.DIMENSION "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

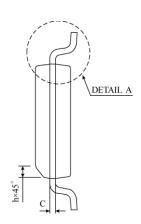
2.DIMENSION "E1" DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 PER SIDE.

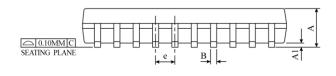
3.DIMENSION "B" DOES NOT INCLUDE DAMBAR PROTRUSION.ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08MM TOTAL IN EXCESS OF THE "B" DIMENSION AT MAXIMUM METERIAL CONDITION, DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT, MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD IS 0.07MM.

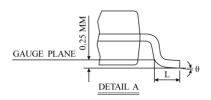


#### SOP-20 (300mil) Package Dimension









CVMDOL	DI	MENSION IN M	ſМ	DIMENSION IN INCH		
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
A	2.35	2.50	2.65	0.0926	0.0985	0.1043
A1	0.10	0.20	0.30	0.0040	0.0079	0.0118
В	0.33	0.42	0.51	0.0130	0.0165	0.0200
С	0.23	0.28	0.32	0.0091	0.0108	0.0125
D	12.60	12.80	13.00	0.4961	0.5040	0.5118
Е	10.00	10.33	10.65	0.3940	0.4425	0.4910
E1	7.40	7.50	7.60	0.2914	0.2953	0.2992
e		1.27 BSC			0.050 BSC	
h	0.25	0.50	0.75	0.0100	0.0195	0.0290
L	0.40	0.84	1.27	0.0160	0.0330	0.0500
θ	0°	4°	8°	0°	4°	8°
JEDEC			MS-01	3 (AC)		

\*NOTES: DIMENSION "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

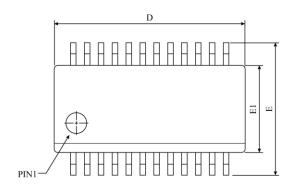
MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL

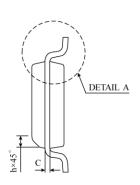
NOT EXCEED 0.15 MM (0.006 INCH) PER SIDE.

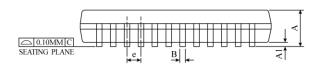
DS-TM52F8368\_E 120 Rev 1.3, 2022/11/11

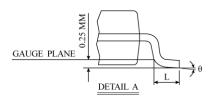


#### SSOP-24 (150mil) Package Dimension









SYMBOL	DIMENSION IN MM			DIMENSION IN INCH			
	MIN	NOM	MAX	MIN	NOM	MAX	
A	1.35	1.55	1.75	0.053	0.061	0.069	
A1	0.10	0.18	0.25	0.004	0.007	0.010	
A2	-	-	1.50	-	-	0.059	
В	0.20	0.25	0.30	0.008	0.010	0.012	
C	0.18	0.22	0.25	0.007	0.009	0.010	
D	8.56	8.65	8.74	0.337	0.341	0.344	
Е	5.79	6.00	6.20	0.228	0.236	0.244	
E1	3.81	3.90	3.99	0.150	0.154	0.157	
e		0.635 BSC			0.025 BSC		
L	0.41	0.84	1.27	0.016	0.033	0.050	
θ	0°	4°	8°	0°	4°	8°	
JEDEC			M0-13	7 (AE)			

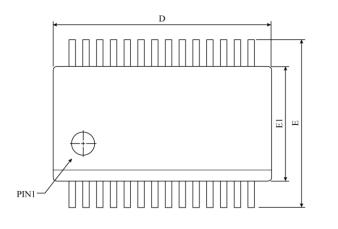
 $\underline{\mathring{\mathbb{A}}}$  \* Notes : dimension " d " does not include mold protrusions or gat burns.

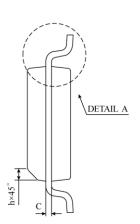
MOLD PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.006 INCH PER SIDE.

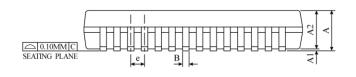
DS-TM52F8368\_E 121 Rev 1.3, 2022/11/11

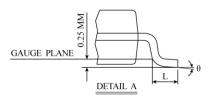


# SSOP-28 (150mil) Package Dimension









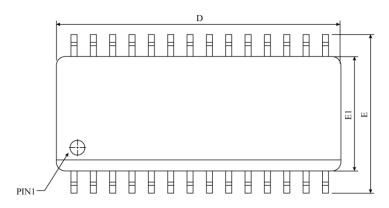
SYMBOL	DIM	MENSION IN	MM	DIMENSION IN INCH			
MIN	MIN	NOM	MAX	MIN	NOM	MAX	
А	1.50	1.65	1.80	0.06	0.06	0.07	
A1	0.102	0.176	0.249	0.004	0.007	0.010	
A2	1.40	1.475	1.55	0.06	0.06	0.06	
В	0.20	0.25	0.30	0.01	0.01	0.01	
С	0.2TYP			0.008TYP			
е	0.635TYP			0.025TYP			
D	9.804	9.881	9.957	0.386	0.389	0.392	
E	5.842	6.020	6.198	0.230	0.237	0.244	
E1	3.86	3.929	3.998	0.152	0.155	0.157	
L	0.406	0.648	0.889	0.016	0.026	0.035	
θ	0°	4°	8°	0°	4°	8°	
JEDEC	M0-137(AF)						

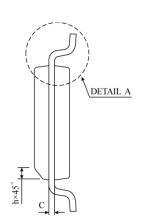
⚠\*NOTES: DIMENSION "D" DOES NOT INCLUDE MOLD PROTRUSIONS OR GATE BURRS. MOLD PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.006 INCH PER SIDE.

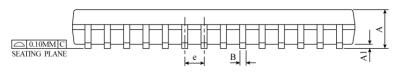
DS-TM52F8368\_E 122 Rev 1.3, 2022/11/11

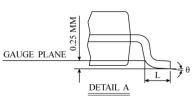


#### SOP-28 (300mil) Package Dimension









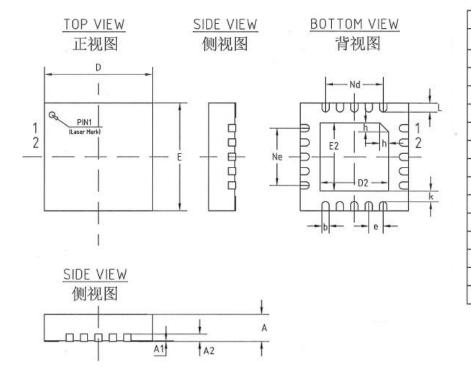
SYMBOL	DIMENSION IN MM			DIMENSION IN INCH			
	MIN	NOM	MAX	MIN	NOM	MAX	
A	2.35	2.50	2.65	0.0926	0.0985	0.1043	
A1	0.10	0.20	0.30	0.0040	0.0079	0.0118	
В	0.33	0.42	0.51	0.0130	0.0165	0.0200	
С	0.23	0.28	0.32	0.0091	0.0108	0.0125	
D	17.70	17.90	18.10	0.6969	0.7047	0.7125	
Е	10.00	10.33	10.65	0.3940	0.4425	0.4910	
E1	7.40	7.50	7.60	0.2914	0.2953	0.2992	
e	1.27 BSC			0.050 BSC			
h	0.25	0.50	0.75	0.0100	0.0195	0.0290	
L	0.40	0.84	1.27	0.0160	0.0330	0.0500	
θ	0°	4°	8°	0°	4°	8°	
JEDEC		MS-013 (AE)					

 $\triangle$  \* NOTES : DIMENSION " D " DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.15 MM ( 0.006 INCH ) PER SIDE.

DS-TM52F8368\_E 123 Rev 1.3, 2022/11/11



# QFN 20 (3\*3\*0.75-0.4mm) (L=0.25mm) Package Dimension

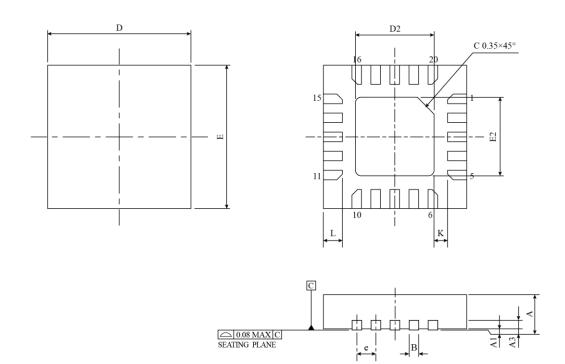


	机械厂	マサノmm				
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX			
Α	0.70	0.75	0.80			
A1	1	20.0	0.05			
A2		0.203 RE	F			
b	0.15	0.20	0.25			
D	2.90	3.00	3.10			
DS	1.80	1.90	2.00 3.10			
E	2.90	3.00				
ES	1.80	1.90	2.00			
6	0.40 BSC					
K	0.20	0.30	0.40			
L	0.20	0.25	0.30			
h	0.20	0.25	0.30			
Ne	1.60 BSC					
Nd	1.60 BSC					

DS-TM52F8368\_E 124 Rev 1.3, 2022/11/11



#### QFN 20 (3\*3\*0.75-0.4mm) Package Dimension



SYMBOL	DIMENSION IN MM			DIMENSION IN INCH			
	MIN	NOM	MAX	MIN	NOM	MAX	
A	0.70	0.75	0.80	0.028	0.030	0.031	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
A3	0.203 REF.			0.008 REF.			
В	0.15	0.20	0.25	0.006	0.008	0.010	
D	3.00 BSC			0.118 BSC			
Е	3.00 BSC			0.118 BSC			
e	0.40 BSC			0.016 BSC			
K	0.20	-	-	0.008	-	-	
E2	1.60	1.65	1.70	0.063	0.065	0.067	
D2	1.60	1.65	1.70	0.063	0.065	0.067	
L	0.30	0.40	0.50	0.012	0.016	0.020	
JEDEC							

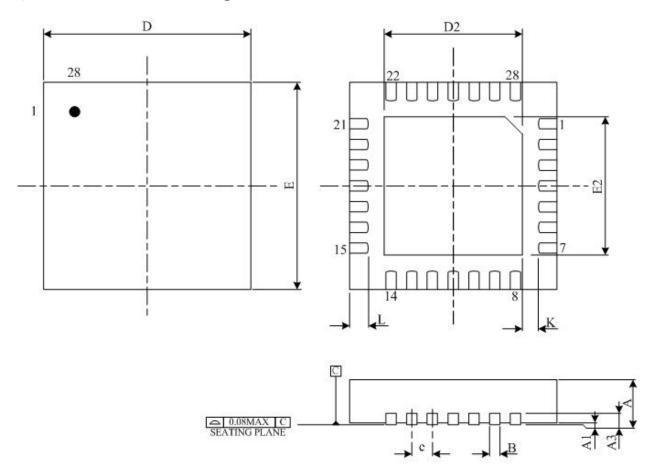
A \* NOTES : 1. ALL DIMENSION ARE IN MILLIMETRS.

- 2. DIMENSION B APPLIES TO METALLLIZED TERMINAL AND IS MEASURED BETWEEN 0.15mm AND 0.30mm FROM THE TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION B SHOULD NOT BE MEASURED IN THAT RADIUS AREA.
- 3. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

DS-TM52F8368\_E 125 Rev 1.3, 2022/11/11



# QFN-28 (4x4x0.75-0.4mm) Package Dimension



SYMBOL	DIMENSION IN MM			DIMENSION IN INCH			
	MIN	NOM	MAX	MIN	NOM	MAX	
A	0.7	0.75	0.8	0.028	0.030	0.031	
Al	0	0.02	0.05	0	0.001	0.002	
A3	0.203 REF			0.008 REF			
В	0.15	0.2	0.25	0.006	0.008	0.010	
D	4 BSC			0.157			
Е		4 BSC			0.157		
D2	2.2	2.3	2.4	0.087	0.091	0.094	
E2	2.2	2.3	2.4	0.087	0.091	0.094	
e e		0.4 BSC			0.016	åe.	
L)	0.3	0.4	0.5	0.012	0.016	0.020	
K	0.45 REF			0.018			
JEDEC	MO-220						

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